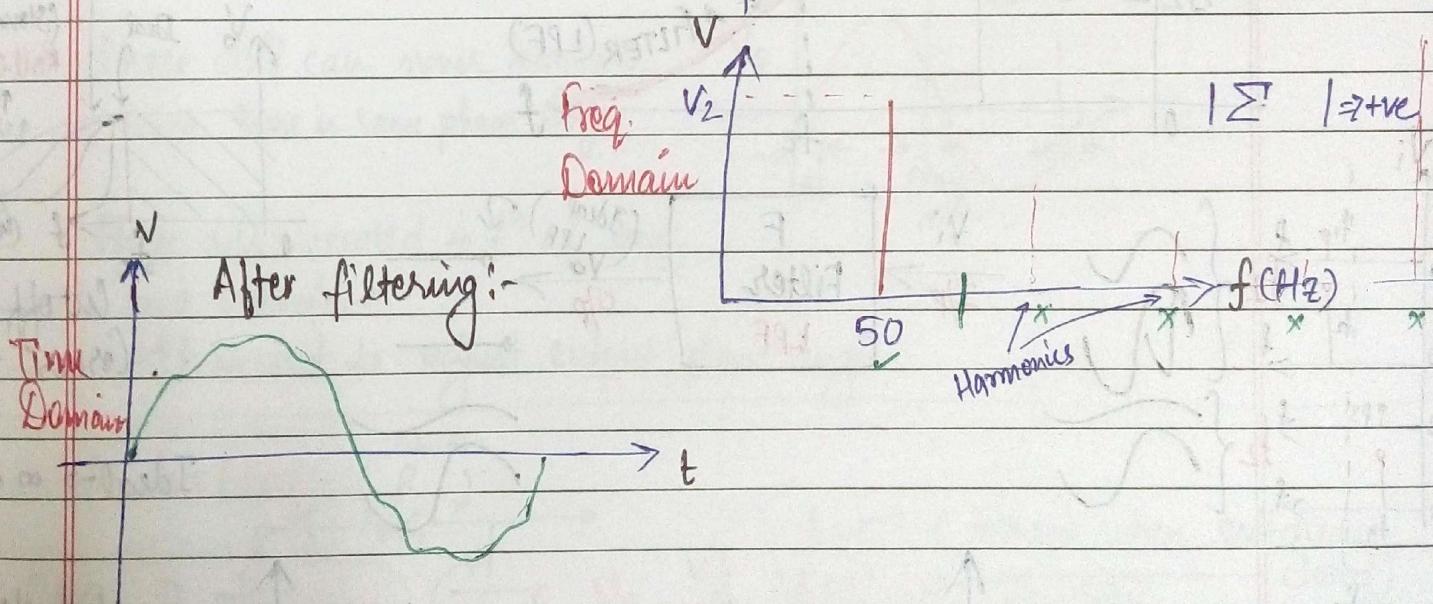
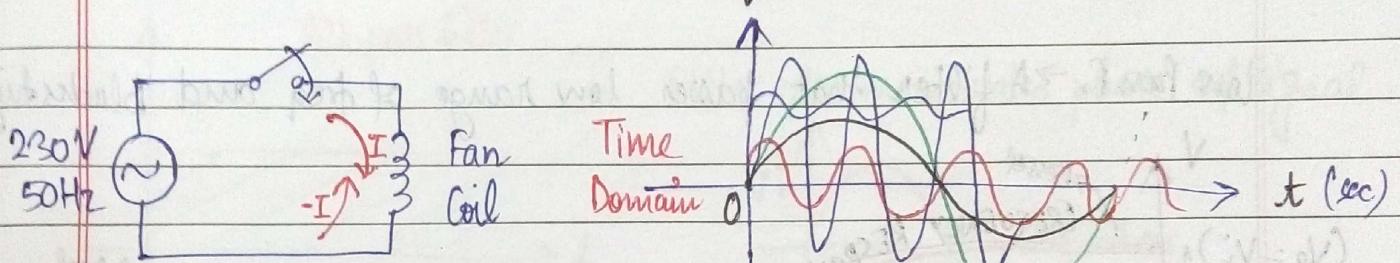
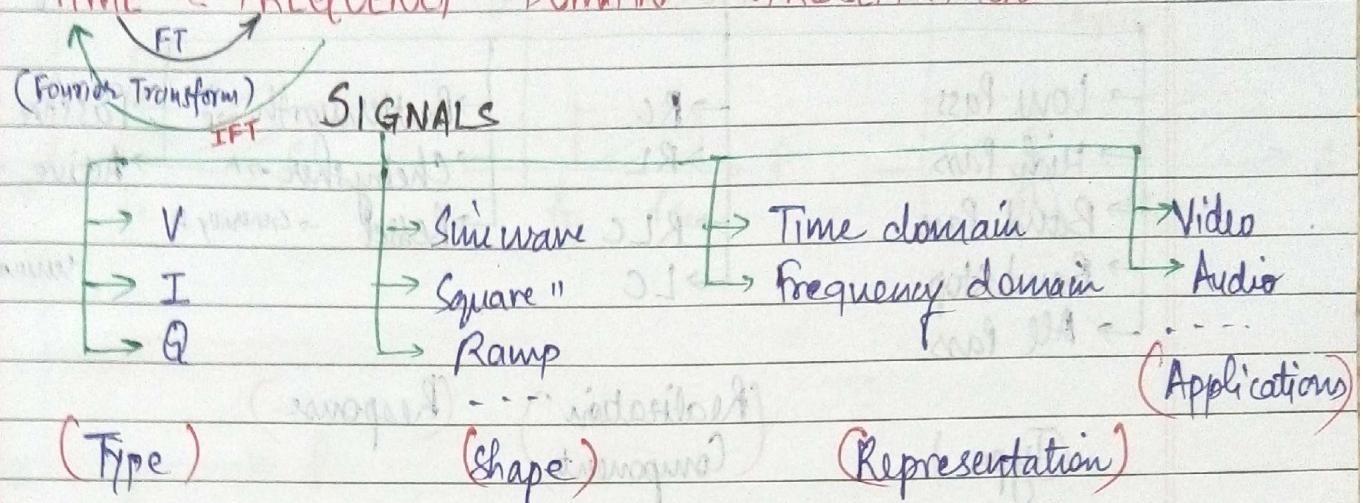


TIME & FREQUENCY DOMAIN REPRESENTATIONS



FILTERS

Group of Electronic circuits that accept certain band & ~~reject~~ reject certain other bands.
(also, bands of frequency)

FILTERS

- Low Pass
- High Pass
- Band Pass
- Band Stop
- All Pass

- RL
- RL
- RLC
- LC

- Butterworth \rightarrow P
- Chebyshev \rightarrow A
- Bessel \rightarrow G

(If only R, L, C are used)

Passive

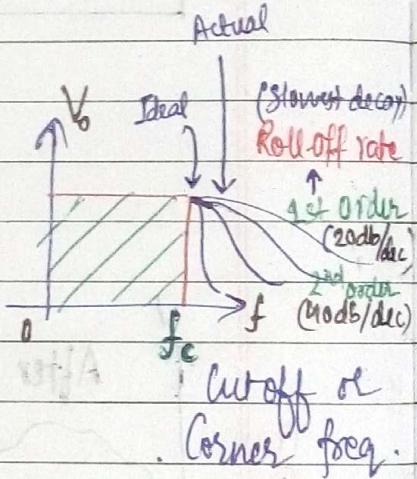
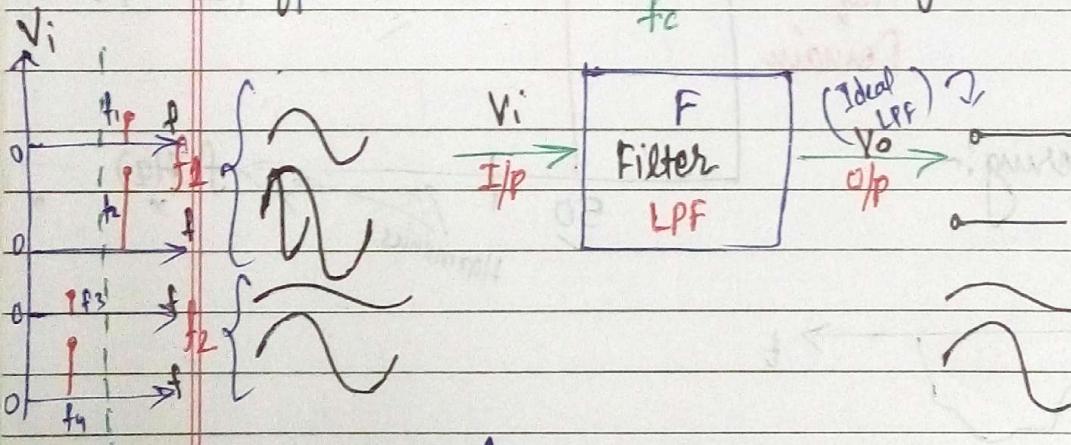
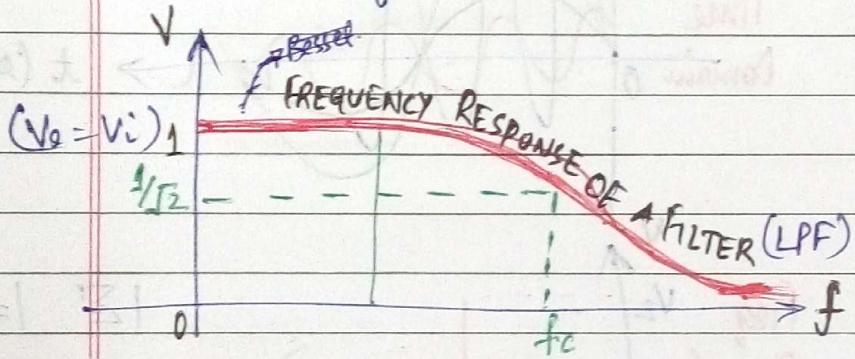
Active

Generally A

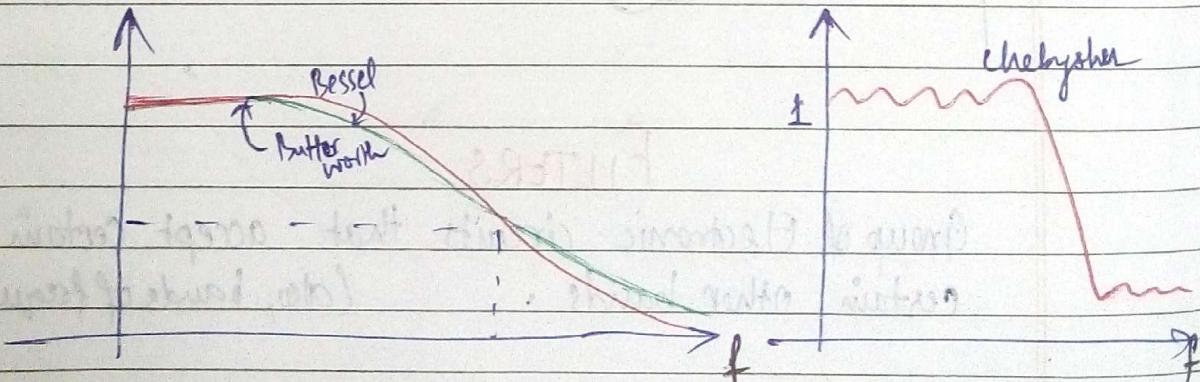
Semiconductor devices

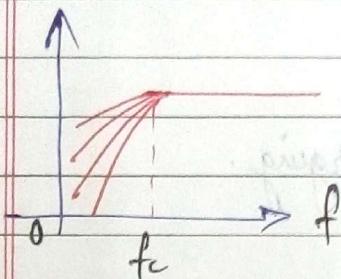
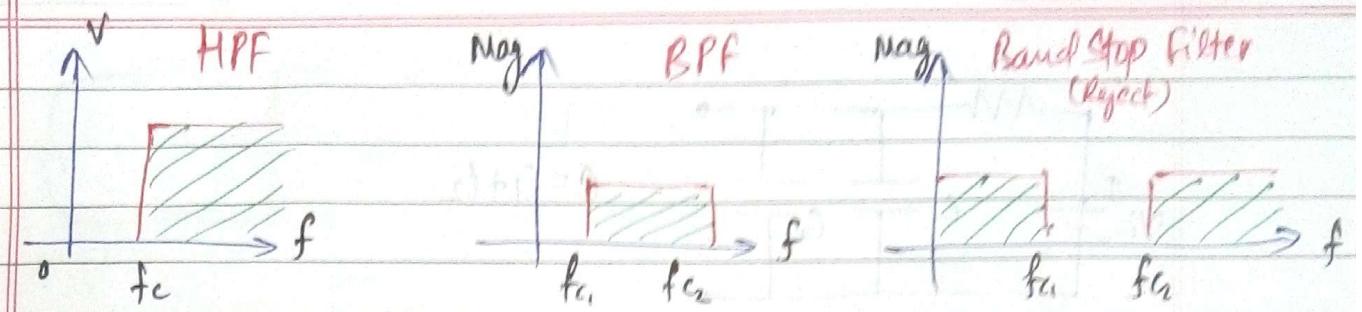
(Type) (Realization Components) (Response)

Low Pass F. → A filter that passes low range of freq and blocks high freq.



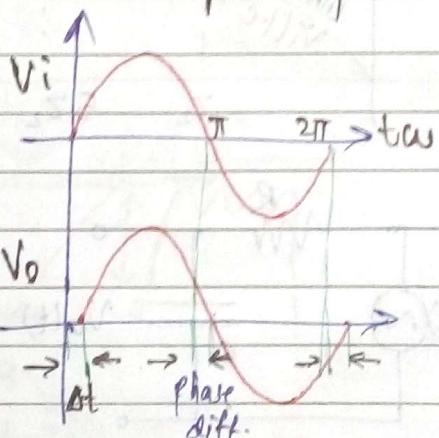
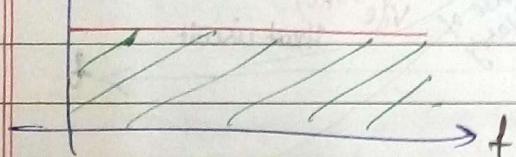
Ideal $\rightarrow \infty$ db/dec





All pass filter

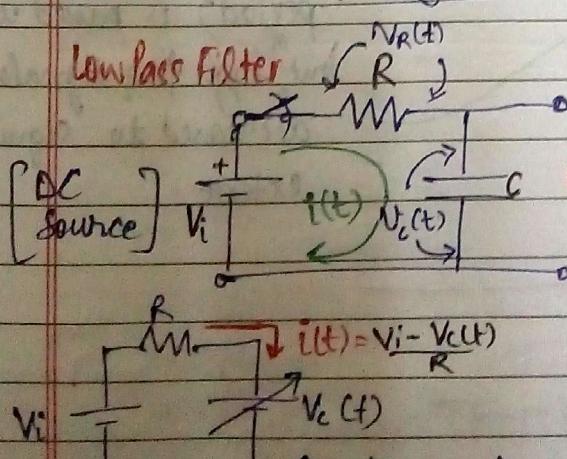
Filter also manipulates phase of signal



Phase diff can never become 0,
hence, there is some phase shift.

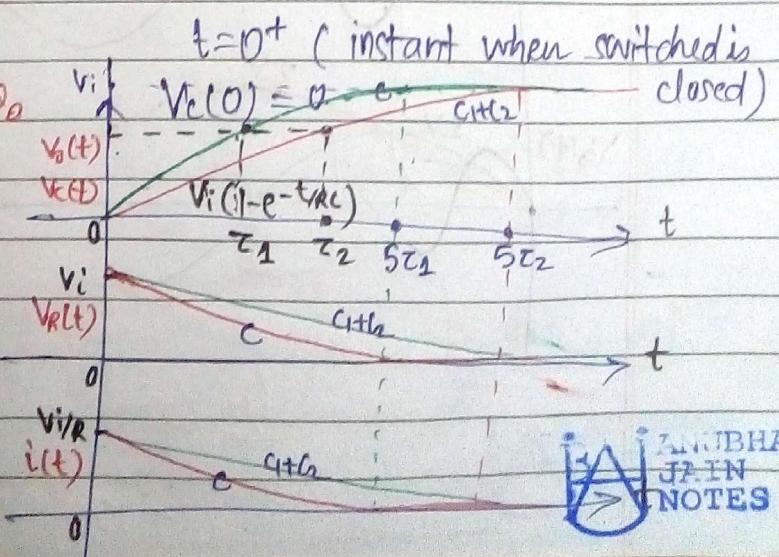
Phase diff created is f^n of freq
and waveform.

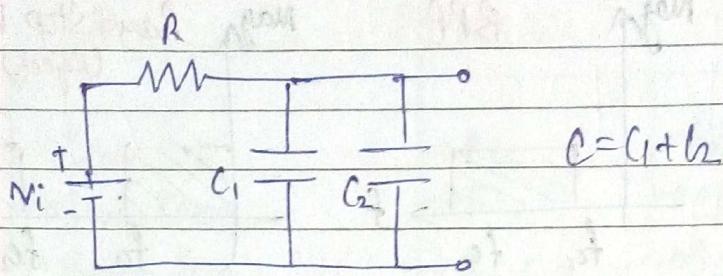
APF is used to adjust output phase angle.



Capacitor can be
assumed to be a
battery.

* Super Capacitor

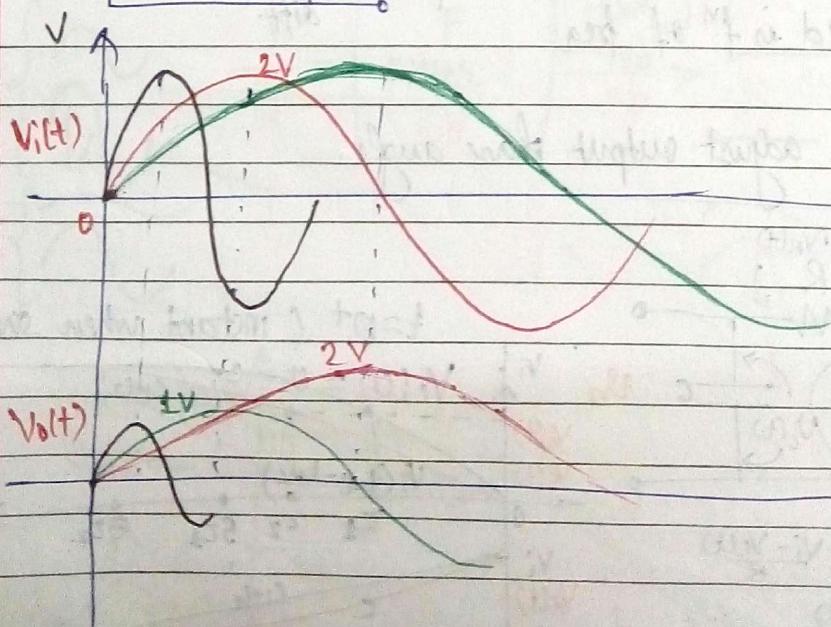
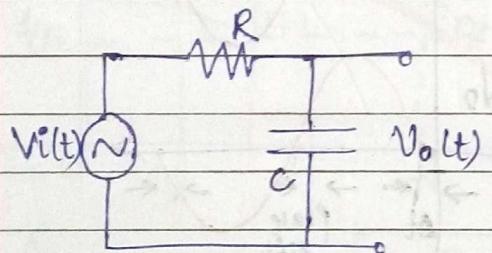
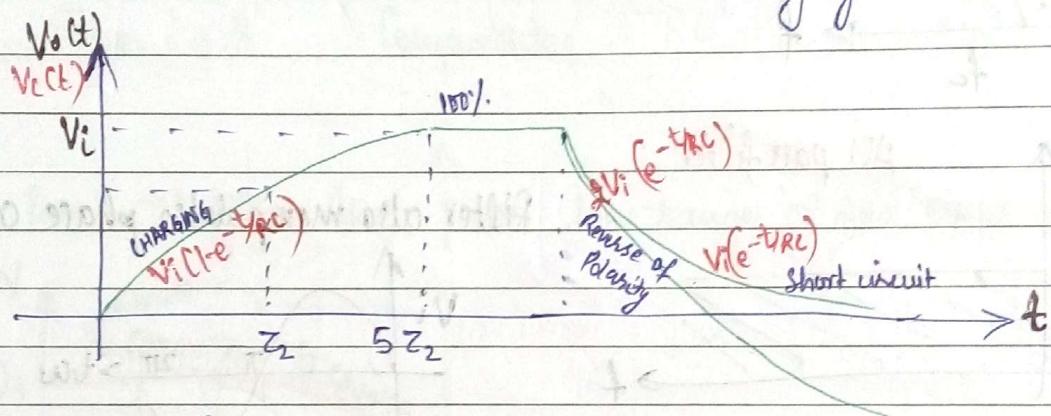




$\tau = \text{Time Const.}$

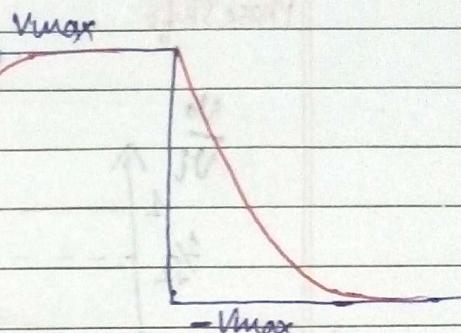
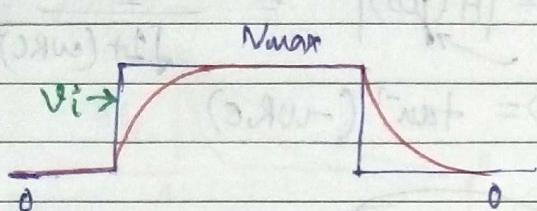
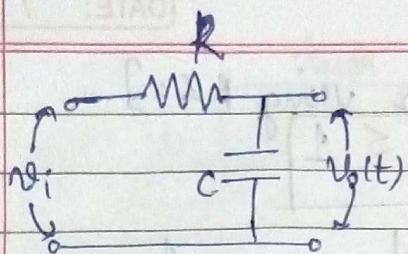
$$\tau = R.C \text{ (sec)}$$

$5\tau \rightarrow 99.7\% \approx 100\% \text{ charging.}$



Working of LPF:-

Amplitude of signals with low freq (high time period) is passed unchanged but high freq signals is decreased to significant extent.



- $\text{TF} = \frac{\text{O/P Parameter}}{\text{I/P Param.}}$
- ↓
Transfer function

$$(\text{Impedance of Resistor}) \quad Z_R = R$$

$$(\text{Imp. of Capacitor}) \quad Z_C = \frac{1}{sC}$$

Complex freq

This decay is exponential

decay time

$$s = \sigma + j\omega$$

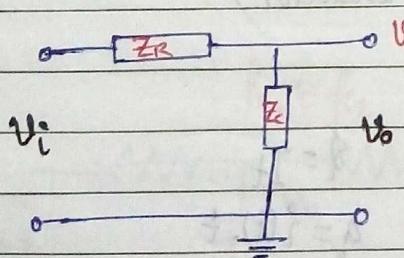
$j = F_1$

Angular freq

Exponential decay

t_1

* For a steady state sine wave, $\sigma = 0 \Rightarrow s = j\omega$



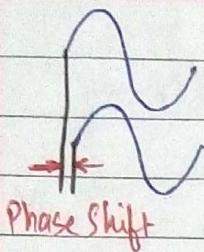
$$V_o = \frac{Z_C}{Z_R + Z_C} V_i$$

$$= \frac{\frac{1}{sC}}{R + \frac{1}{sC}} V_i = \left(\frac{1}{sRC + 1} \right) V_i$$

$$\text{TF} \rightarrow H(s) = \frac{V_o}{V_i} = \frac{1}{sRC + 1}$$

$$\Rightarrow V_o \leq V_i$$

($\sigma = -\omega$ in case of active filters)



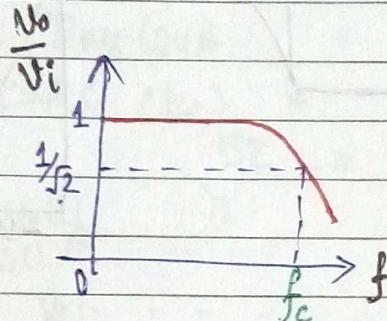
[Passive low pass filter using R & C]

$$|Gain| = G = |H_c(s)| \leq 1$$

$$= |H(j\omega)| = \frac{1}{\sqrt{1 + (\omega RC)^2}}$$

Pure sinusoidal signal

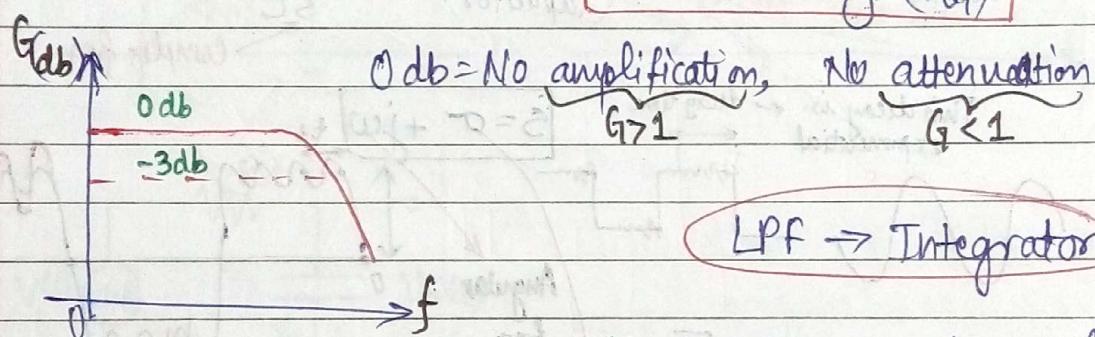
$$\phi = \tan^{-1}(-\omega RC)$$



$$f_c = \frac{1}{2\pi RC}$$

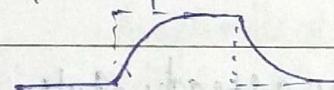
* Gain is expressed in db

$$G_{db} = 20 \log_{10} \left(\frac{V_o}{V_i} \right)$$

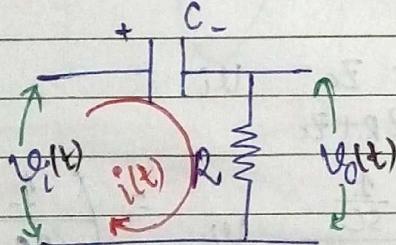


LPF \rightarrow Integrator

\therefore It integrates charge, holds that charge for a period

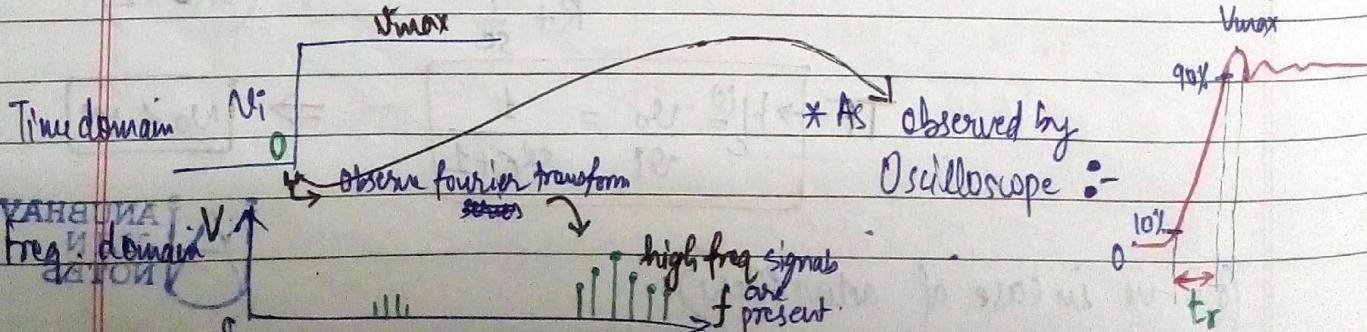


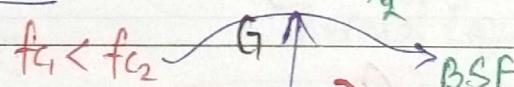
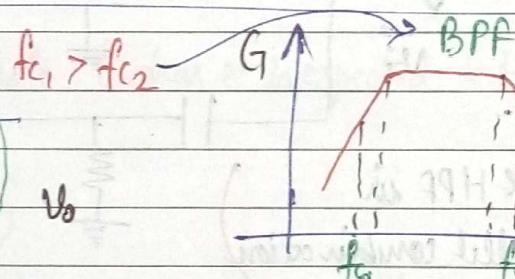
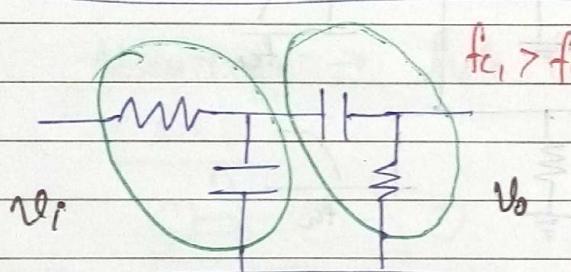
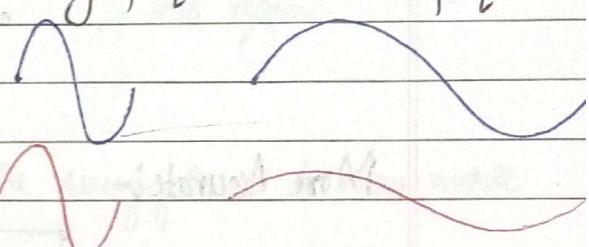
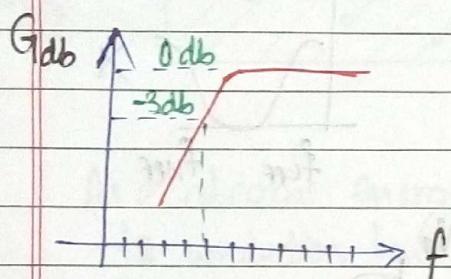
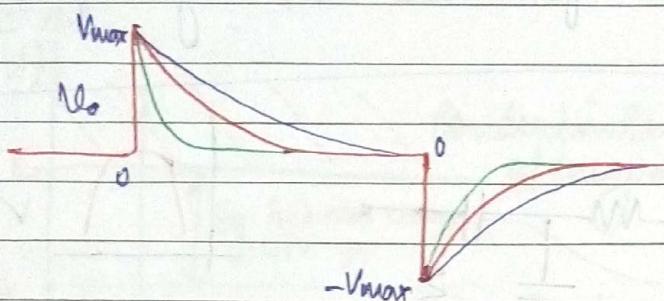
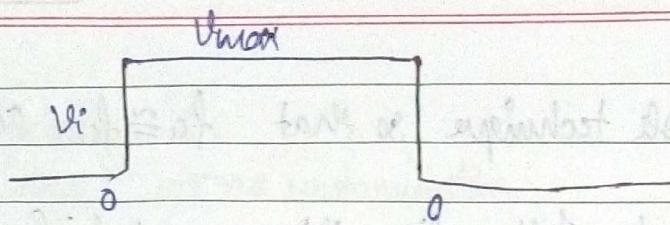
HIGH PASS FILTER (HPF \rightarrow Differentiator)



$$Q = It$$

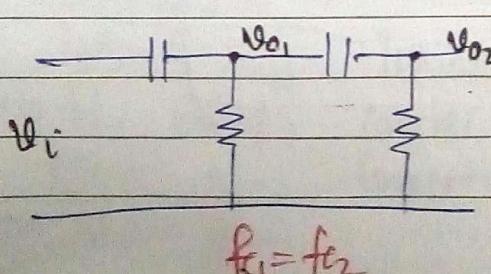
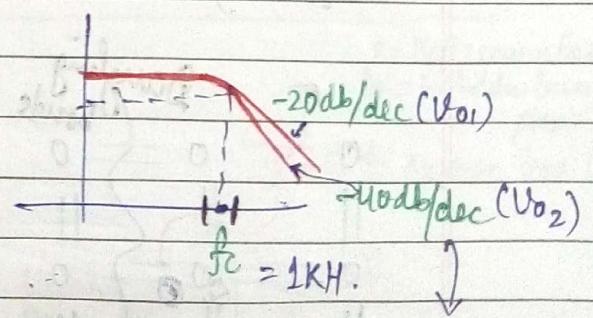
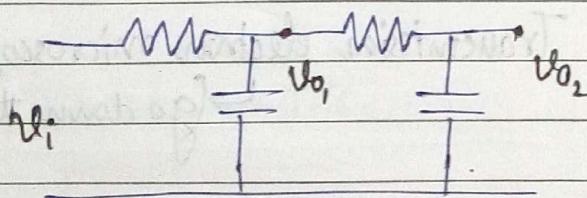
$$q = i(t) \cdot t$$





(Accurate version → PTO)

$$f_{c_1} \approx f_{c_2}$$



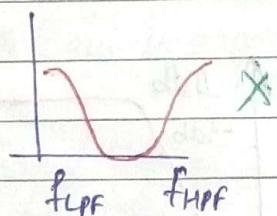
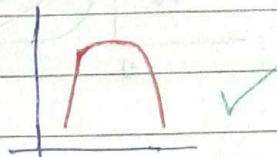
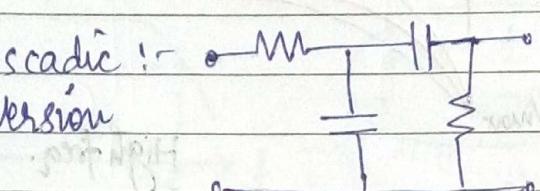
BAJ ANI JEHATABLES AS
JAIN NOTES $f_c = f_{c_1} = f_{c_2}$

We use split pole technique so that $f_{LPF} \approx f_{HPF}$ (approx. equal)

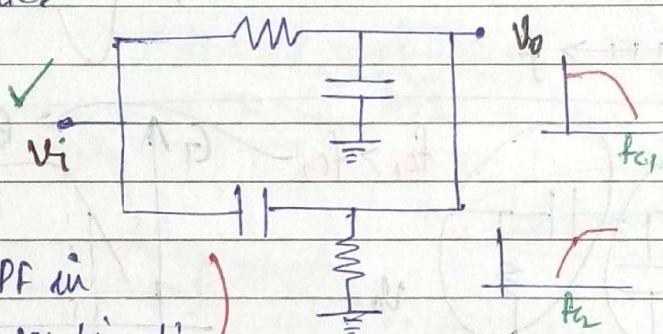
Hence, if we cascade filters like this, we get higher rate filters.

BSF.

Cascadic :-
Version



More Accurate:-



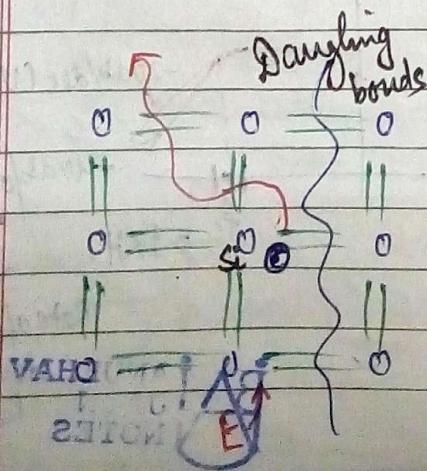
(LPF & HPF in
parallel combination)

SEMICONDUCTORS

(IV)

Si } 4 e⁻ in valence shell.
Ge }

→ Lattice Structure

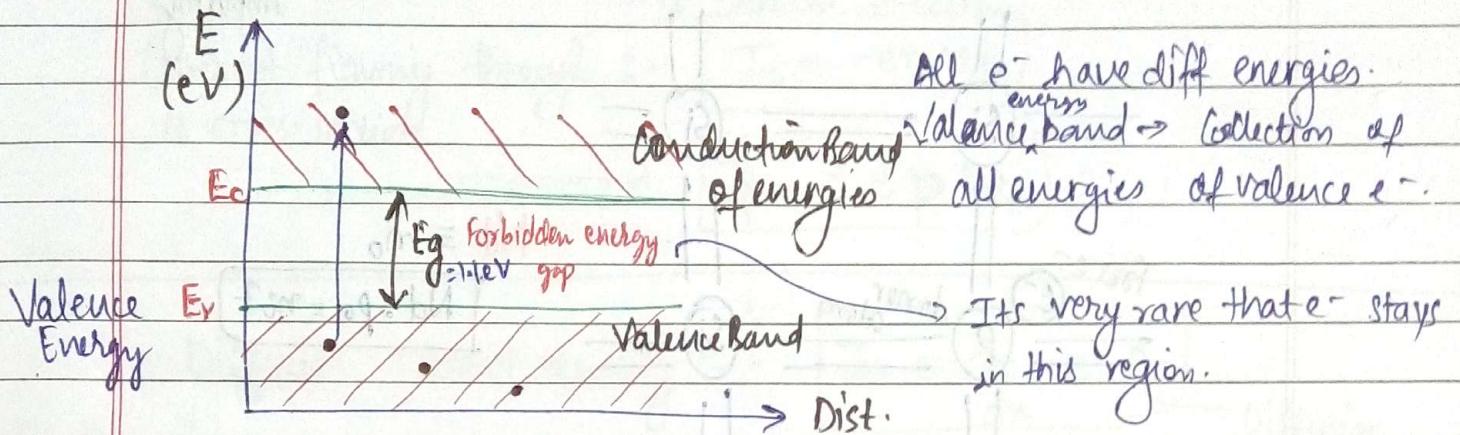


Transmission electron microscope

↳ (go down to Å level)

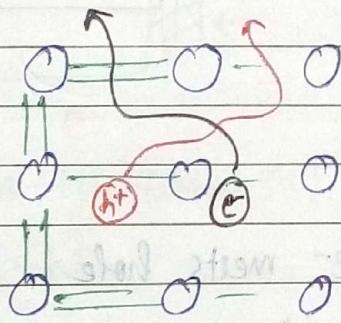
Intrinsic S-C

(pure) \rightarrow no contamination.



As e^- absorbs energy, it rises up the energy level & may move to conduction band.

Absence of $e^- \rightarrow$ Hole (when e^- is expected but actually not present)



Thermal Equilibrium

Intrinsic Carrier Concentration

$$n_i^2 = B T^{3/2} e^{-E_g/2kT}$$

Const. \downarrow Temp (K)

n_i^2 g_e C

27/07/16

$T = 300 \text{ K. or } 27^\circ\text{C.}$

$k = \text{Boltzmann Const}$

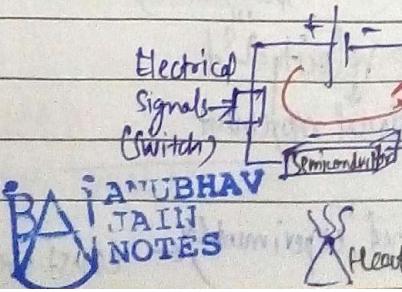
$E_g = \text{forbidden energy gap.}$

$T = \text{Absolute Temp (K)}$

$$n_o p_o = n_i^2$$

No. of e^- No. of h^+

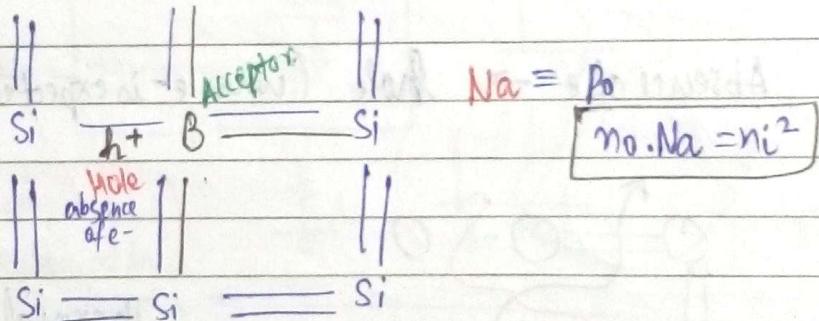
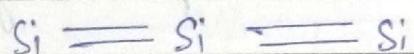
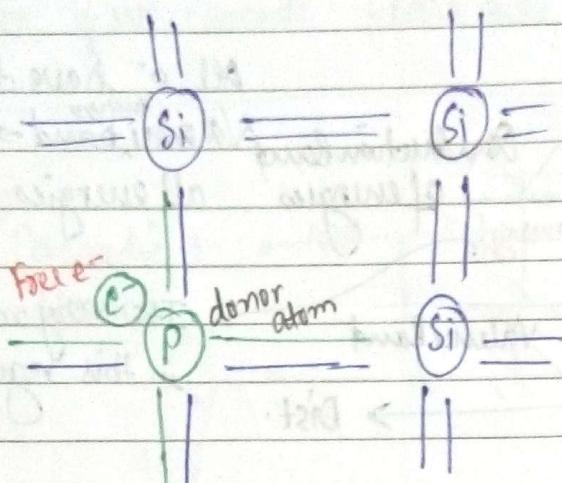
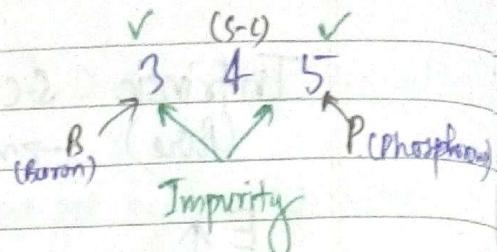
Intrinsic carrier concentration



Current is fn of Temp.

Heat (change T).

Extrinsic S-C
(Impure)



* Recombination :- free e⁻ meets hole (e⁻=hole pair)

DRIFT & DIFFUSION

In presence of any kind of energy, movement of charge carriers is called drift (e.g. stirring).
speed of stirring.

Drift velocity = V_d
directional movement

VAHE
determined experimentally
const value

Happens in absence of ext. energy.

Drift vel. of an e⁻ in any extrinsic S-C

$$V_{dm} = -\mu_m E$$

Mobility
Agility of charge particle

Elec.
field

$$n_{dp} = + \mu_p \cdot E$$

Mobility : $\frac{cm^2}{V-s}$

$M_n \rightarrow 1250$

$\mu_p \rightarrow 480$

Drift Current Density

Current flowing through :-
a cross section

$$J_n = -en v_{dn}$$

$$J_p = +e p v_{dp}$$

Diffusion Current density :-

$$J_n = \frac{dn}{dx} e D_n$$

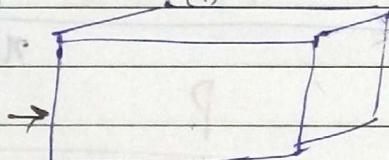
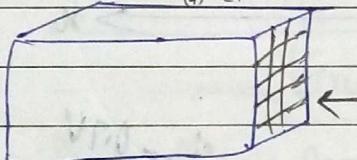
Diffusion const.

$$J_p = \frac{dp}{dx} e D_p$$

Silicon Flux. $Si_{15} + B_5$

$Si_{14} + B_3$

27/07/16



(n) Minority carriers

e^-

n-type (Extrinsic Si)

(p) Majority carriers

h⁺

p-type (Ex. Si)

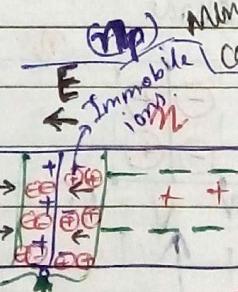
(p) Minority carriers

h⁺

e^-

+ve charge carriers
in p-type Si.
 $V=0$
 $T=\text{const}$

DIODE



Metallurgical Junction (p-n Junc.)

Space Charge Region

At junc., recombination happens.

Keeps on happening till Eg_b state

Immobilized ions block path of other mobile ions.

G

V_{bi} (Build-in)

B A i ANUBA potential
NOTES

Equilibrium condition \leftrightarrow Diffusion \leftrightarrow Drift. E generated from n top

(Drift = Diffusion)

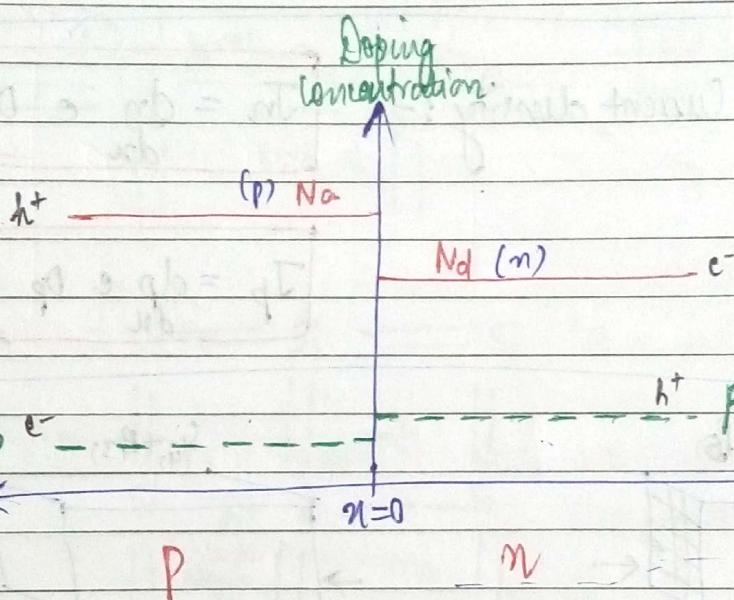
No. of charge carriers moved by drift = -diffusion

Immobile ions \equiv Net movement is zero.

Mobility of e^- is higher

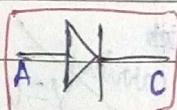
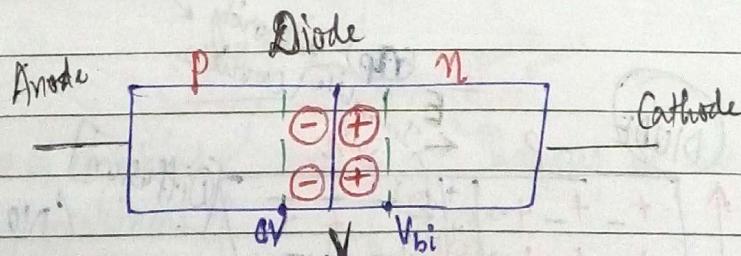
* $\mu_n > \mu_p$

To compensate that,
Na is kept greater
than Nd.



$$\checkmark V_{bi} (\text{Build-in Potential}) = \frac{kT}{q} \ln \left(\frac{N_A N_D}{n_i^2} \right) \quad \text{Thermal Voltage (V}_T\text{)}$$

$\approx 26 \text{ mV.} @ 300 \text{ K.}$



$N_{ext}=0$
 $T=\text{const}$

VAHESUNA
NIT
SET

Scanned by CamScanner

Doping: Addition of impurities.

$$\text{Mass action law: } n_i^2 = n_0 p_0$$

$$n_i^2 = n_0 \left(\frac{n_i^2}{N_d} \right) = N_d p_0 : \text{n-type}$$

Pure

$$n_i^2 = \left(\frac{n_i^2}{N_A} \right) p_0 = N_A p_0 : \text{p-type}$$

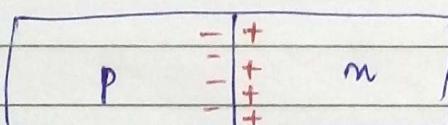
Extrinsic

If $N_A \uparrow$, $N_p \downarrow$ as minority charge carriers starts recombination with increased majority charge carriers.

(I) (E)

$$p_0 \rightarrow N_d$$

$$N_d \gg n_0$$



E (responsible for drift)

Space Charge Region

or

Depletion Region

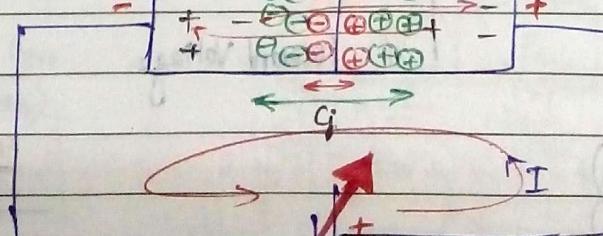
$$V_{bi}$$

(Built-in potential)

 C_j - Finite Value.(Junction Capacitance) \rightarrow (pF or max. nF)Space Charge Region keeps on Increasing as V \uparrow .

REVERSE BIAS:

CONDITION:-

 $I \rightarrow$ very lowRange ($fA \rightarrow nA$)nanometer
nm \rightarrow Depletion Region
μmBreakdown (V_{BR})

Reverse Voltage

Avalanche
(Permanent)

Zener

(Reversible)

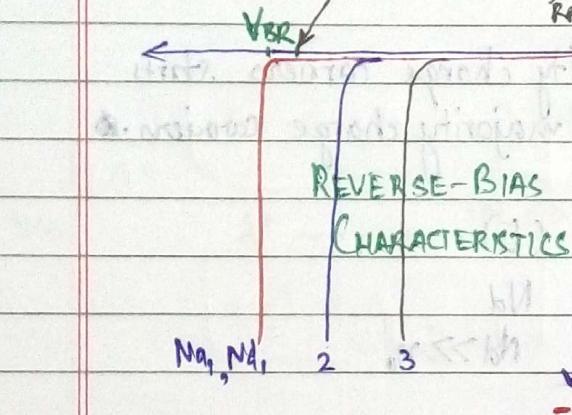
If $V_R < V_{BR}$

$$f_A - nA$$

$$\rightarrow f_A = A$$

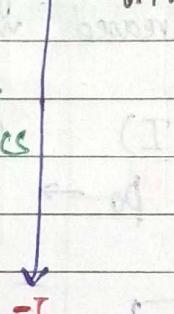
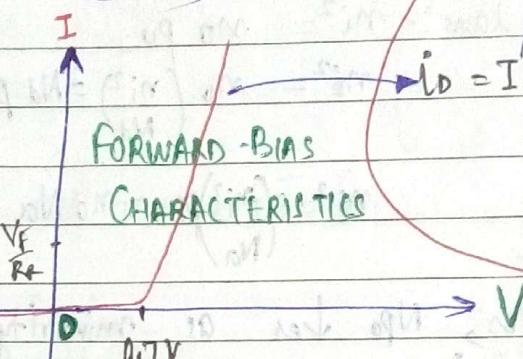
(After breakdown)

Max. reverse voltage without damaging the diode
Peak Inverse Voltage (PIV)



$(V_R > V_{BR})$

FORWARD-BIAS CHARACTERISTICS



$$i_D = I_s \left(e^{\frac{V_D}{nV_T}} - 1 \right)$$

Reverse bias saturation current ($f_A = 10^{-12} A$)

Actual voltage across diode

Thermal voltage

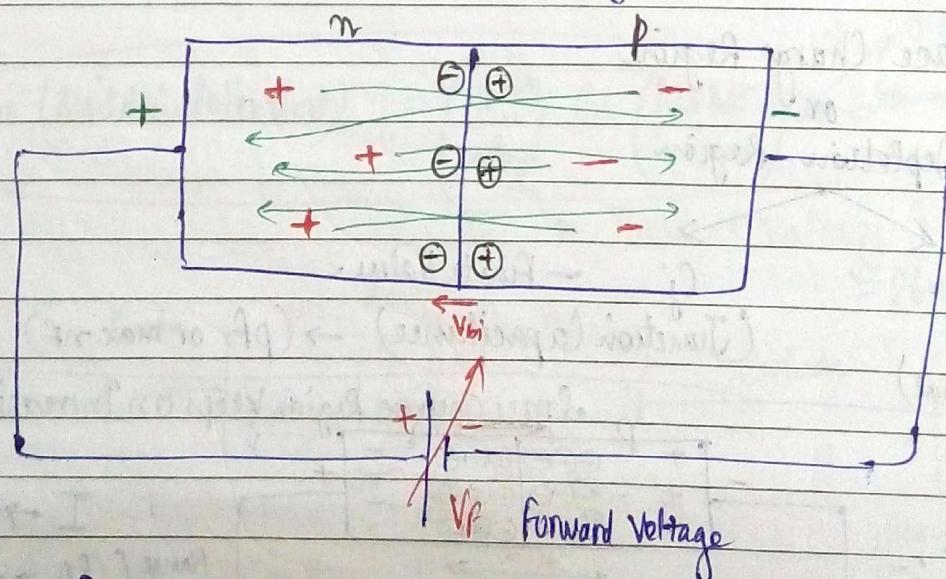
Const. (Ideality factor)

$n = 2$ (Low Current)
 $n = 1$ (High Current)

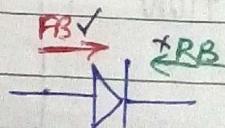
$$N_A, N_d, 2, 3 < N_1$$

Space Charge Region (Nullifies)

FORWARD BIAS CONDITION



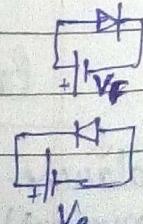
$$V_{bi} = \begin{cases} 0.7V & (\text{Si}) \\ 0.3V & (\text{Ge}) \end{cases}$$



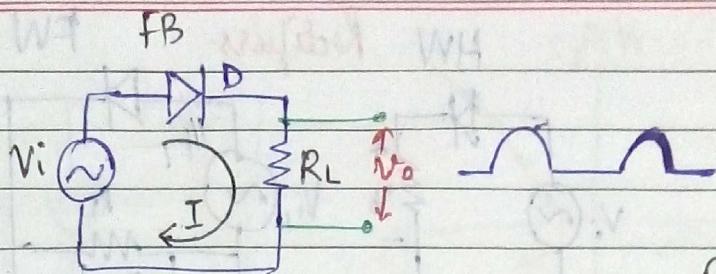
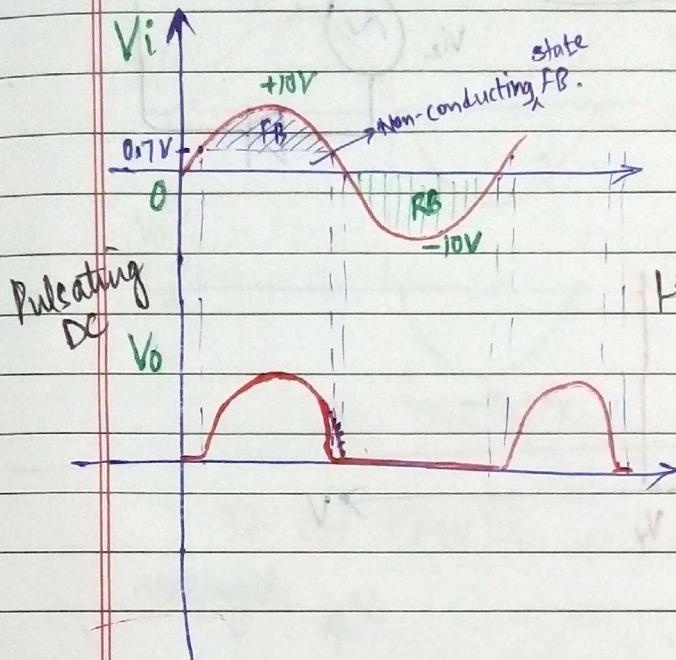
Diode :-

FB - ON

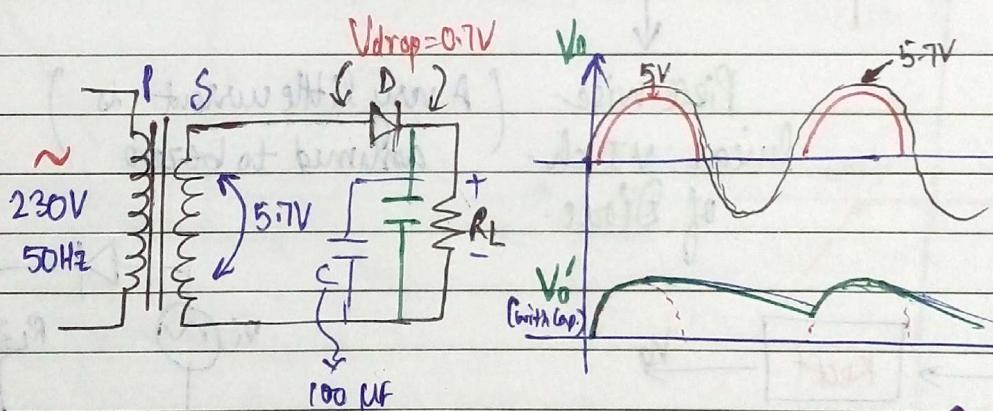
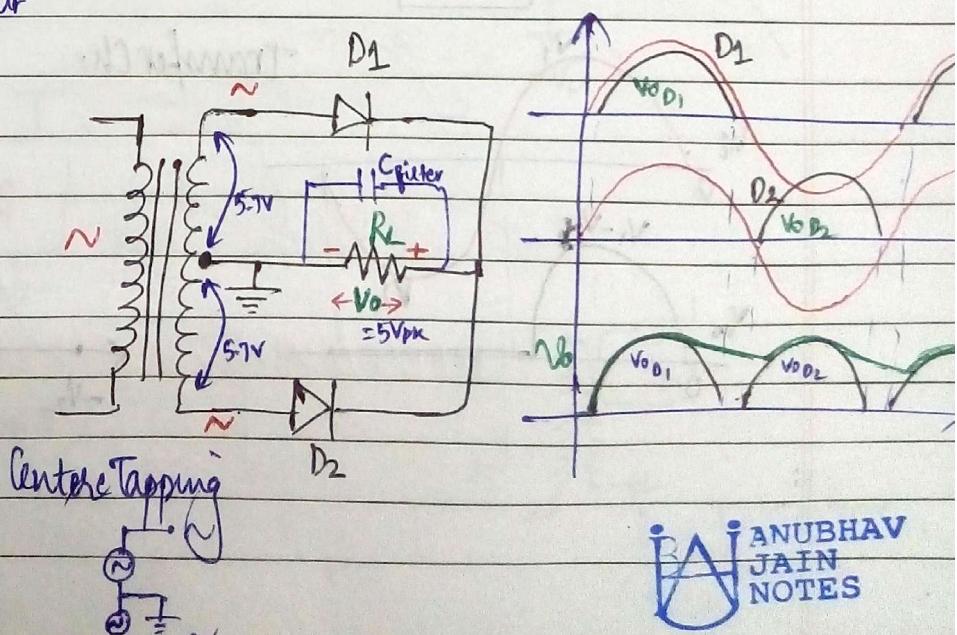
RB - OFF

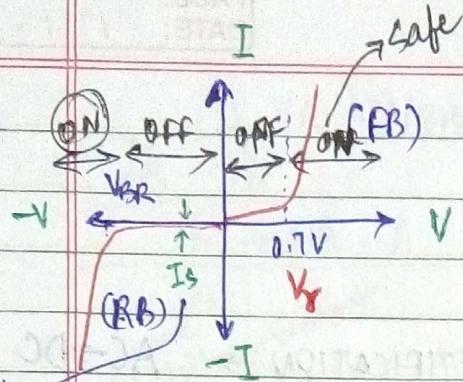


VAHESUMA
ITAL
2010

RECTIFICATION \rightarrow AC \rightarrow DC

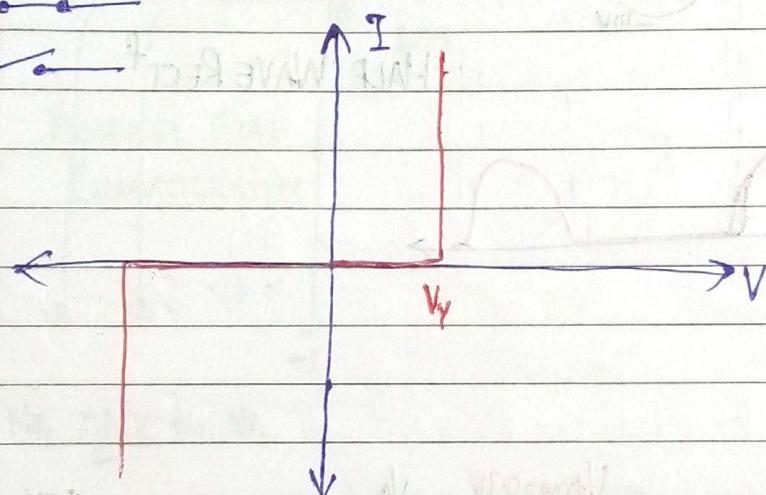
HALF WAVE RECT

 $\parallel \rightarrow$ Iron Core $\parallel \rightarrow$ Ferroide Core
(High freq) $\parallel \rightarrow$ Air Core

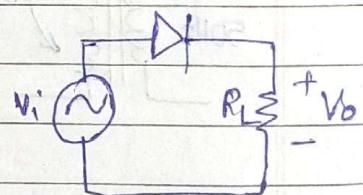
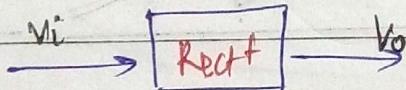


Diode

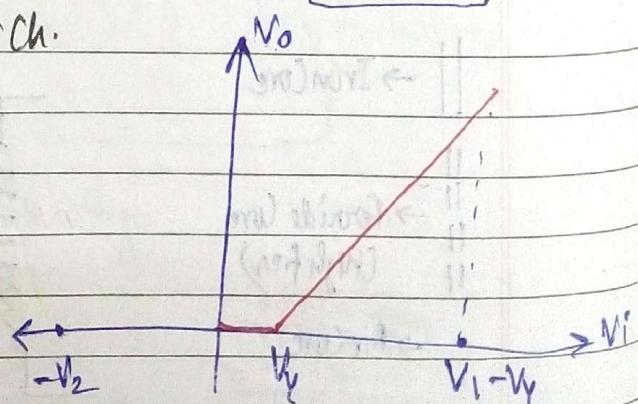
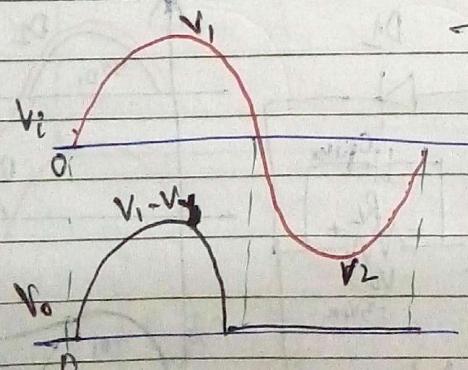
ON
OFF

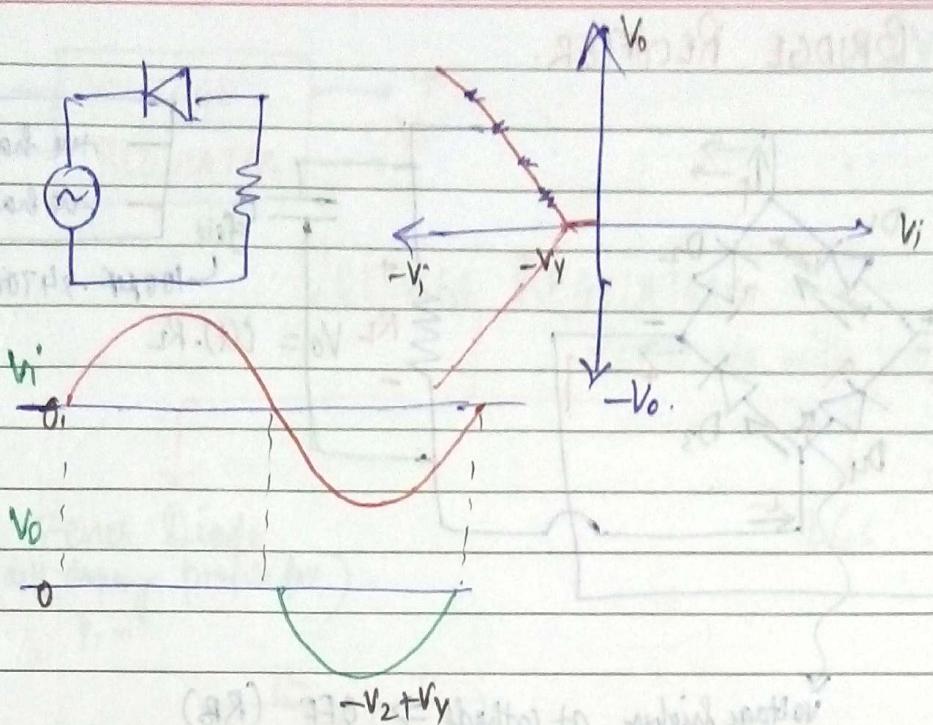


Piece-wise linear V-I ch. of Diode. (A very little current is assumed to be zero)



Transfer Ch.



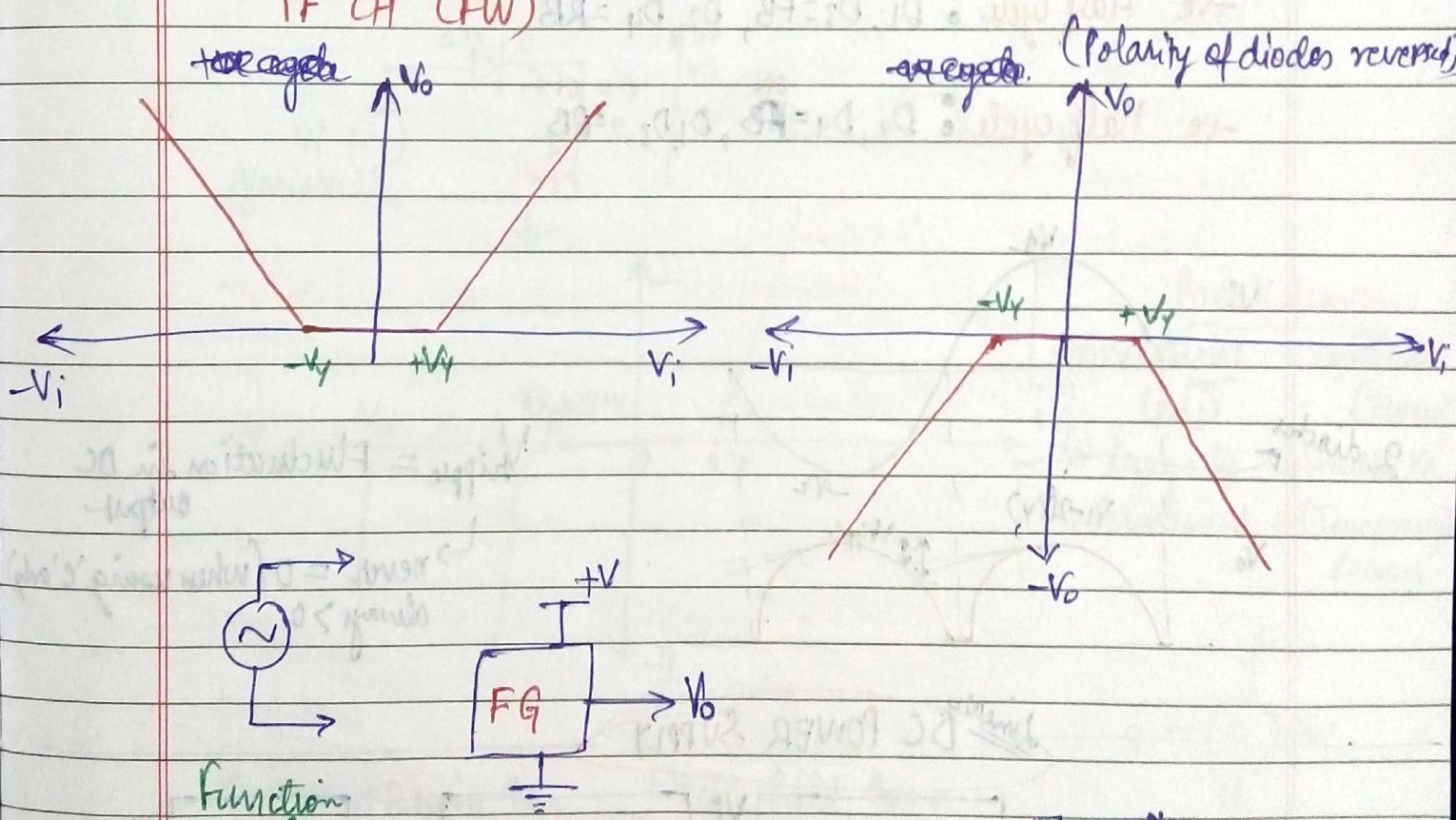


TF CH (FW)

+ve regula

-ve regula.

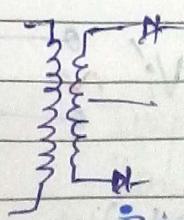
(Polarity of diodes reversed)



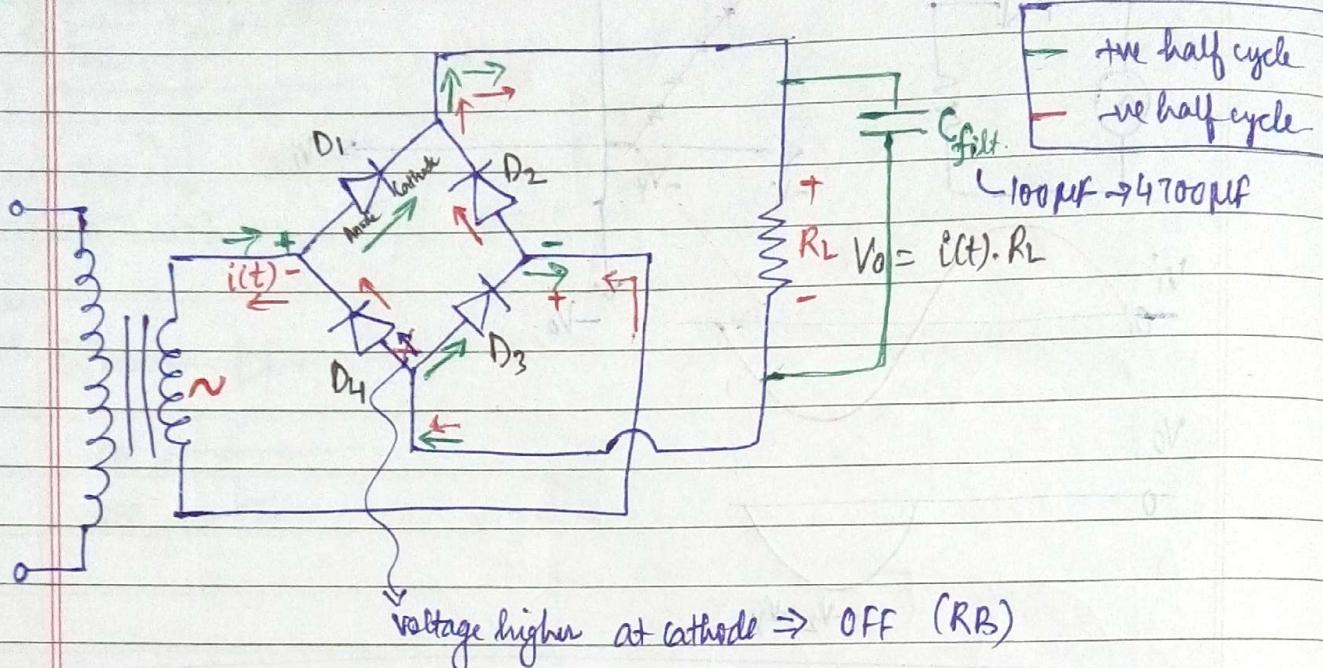
Function

Generator

(No input, only output)

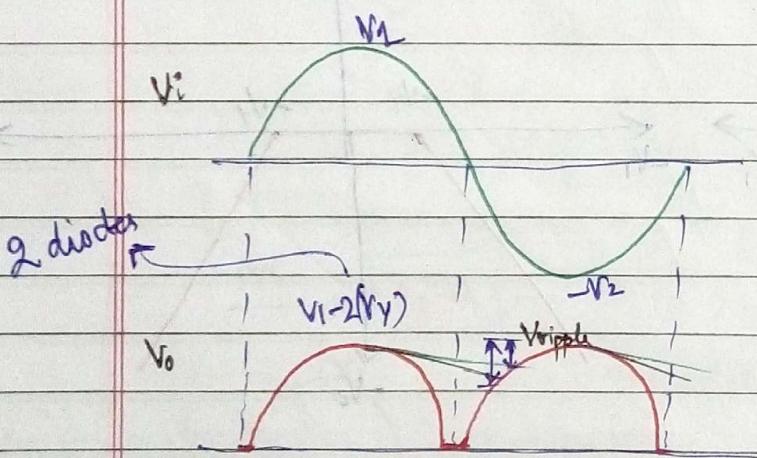


BRIDGE RECTIFIER.



+ve Half cycle : $D_1, D_3 = FB, D_2, D_4 = RB$

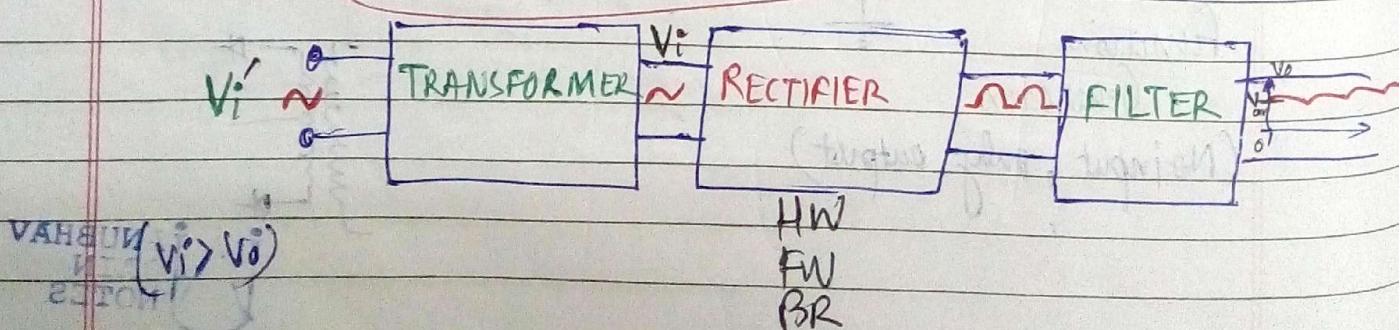
-ve Half cycle : $D_2, D_4 = FB, D_1, D_3 = RB$

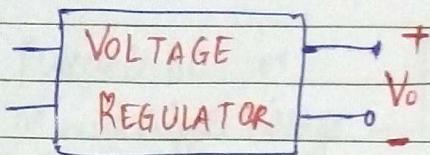


Wipple = Fluctuation in DC output

\hookrightarrow never = 0 (when using C out)
always > 0

linear DC POWER SUPPLY





$$Vi > Vo$$

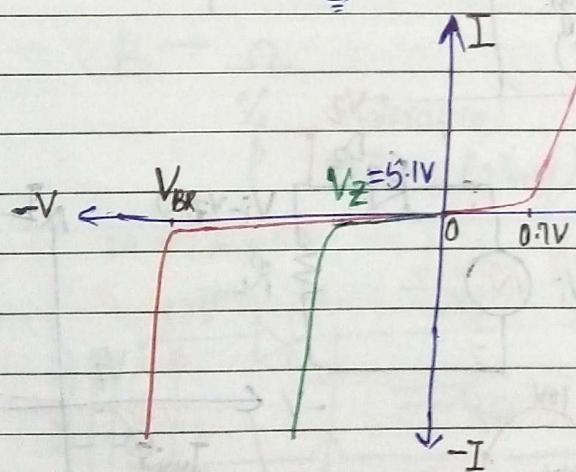
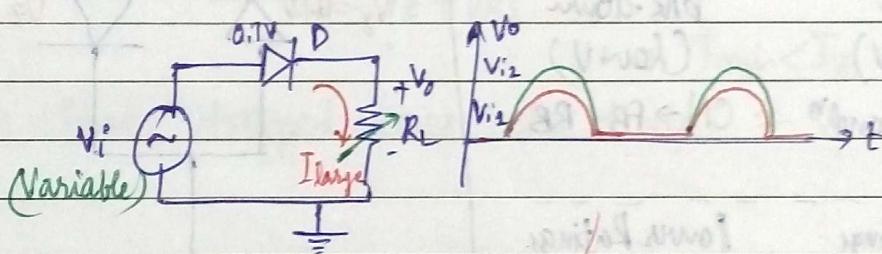
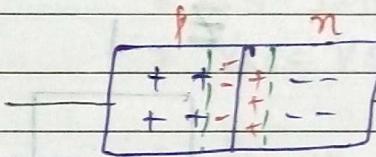
04/08/16

VOLTAGE REGULATORS

Zener Diode
(diff doping profile for)
 p_i, n

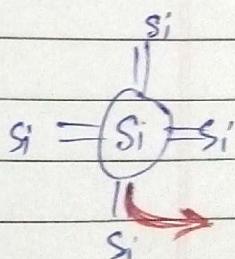
const Vo with variable $\rightarrow Vi \rightarrow Z_L$

ICs

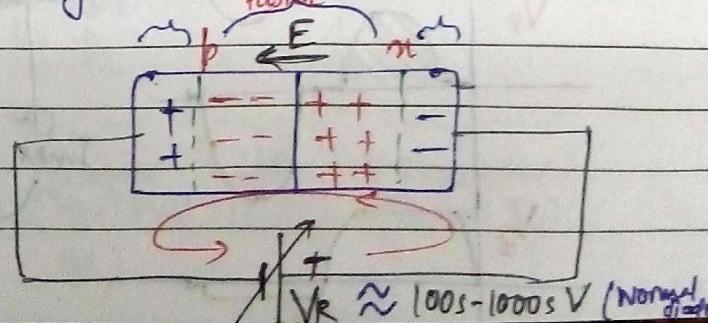


Breakdown

- Avalanche (Zener)
- * Large V_Z * Small V_Z
- * Permanent * (Temporary) Recovery.



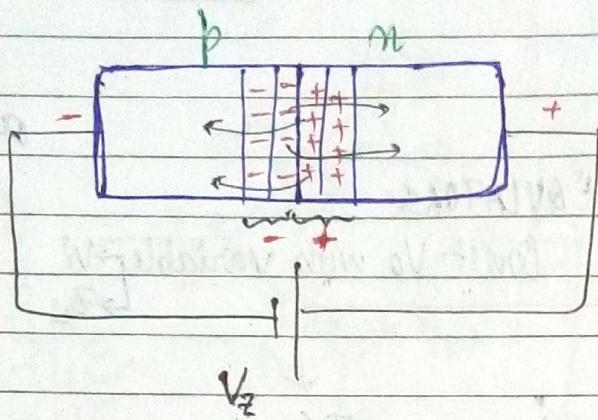
Depletion Region Yes, Electric field Yes.



Impact Ionization

(Heavily accelerated beyond)
 V_{BR} ANUBHAV JAIN NOTES

Zener



1. PN

Z

(referring to graph 1/1)

2. Avalanche
brk-down
(High V)

Zener
brk-down
(Low V)

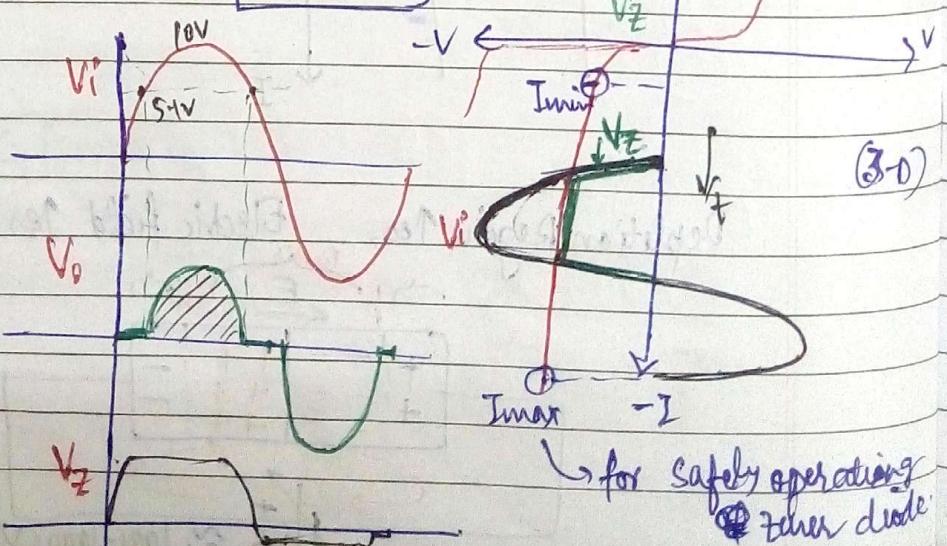
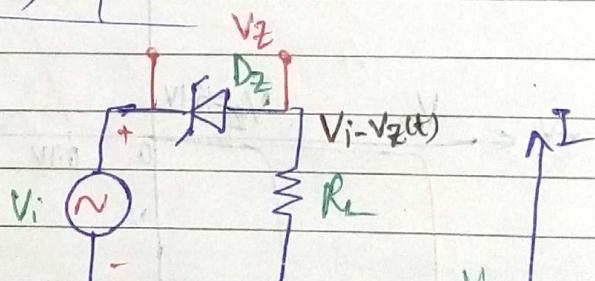
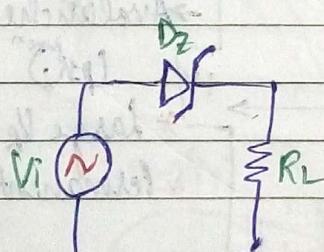
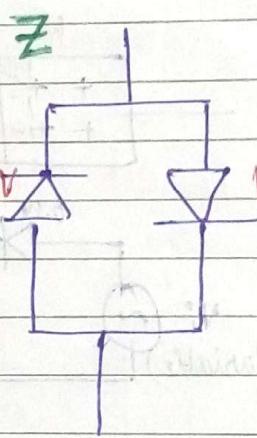
$$V_f = 0.7V \quad V_Z = 5.1V$$

3. ON \rightarrow FB cond'n ON \rightarrow FB, RB

OFF \rightarrow RB

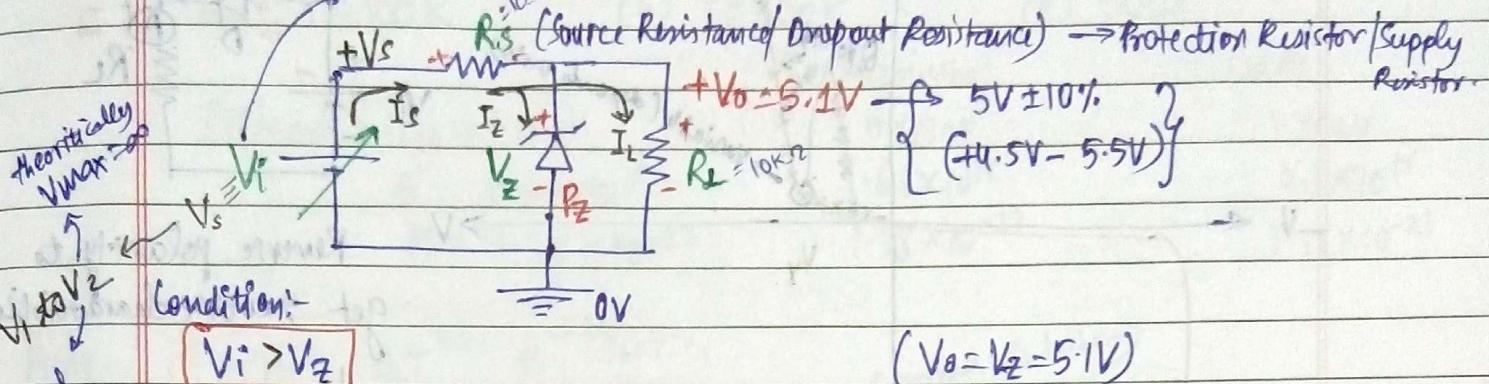
Power Ratings
(mW - kW)

Power Ratings
(mW - W)



Pulsatile DC or

DC with Ripple Voltage



$$* I_s = I_z + I_L$$

$$* V_{RS} = V_s - V_z$$

$$I_s = \frac{V_s - V_z}{R_s}$$

$$R_s = \frac{V_s - V_z}{I_s}$$

$$* V_s = V_z + V_{RS}$$

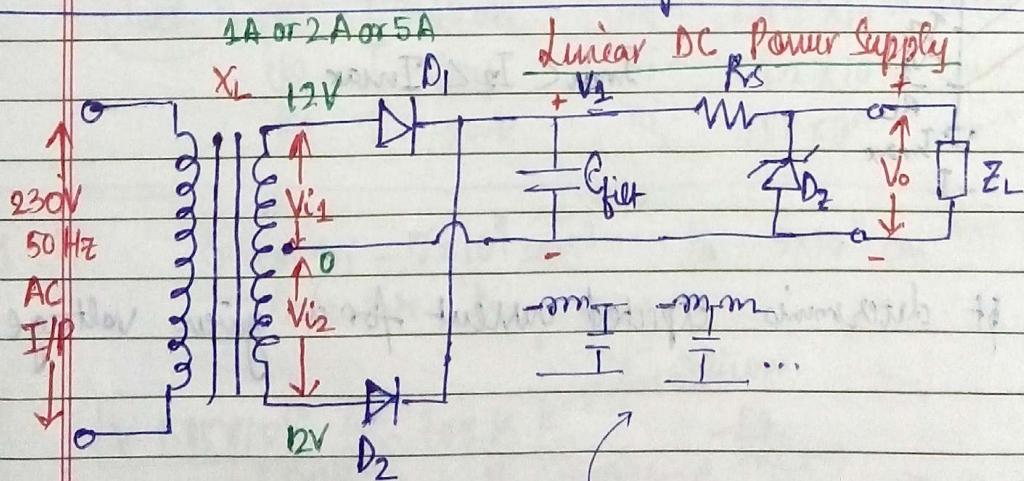
$$* I_{min} < I_z \leq I_{max}$$

* $P_z = \text{Power dropped across zener diode} = V_z \cdot I_z$. (Specified by manufacturer)

$$R \rightarrow \Omega$$

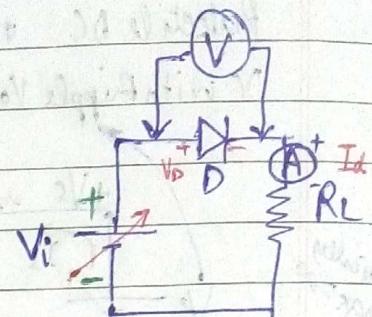
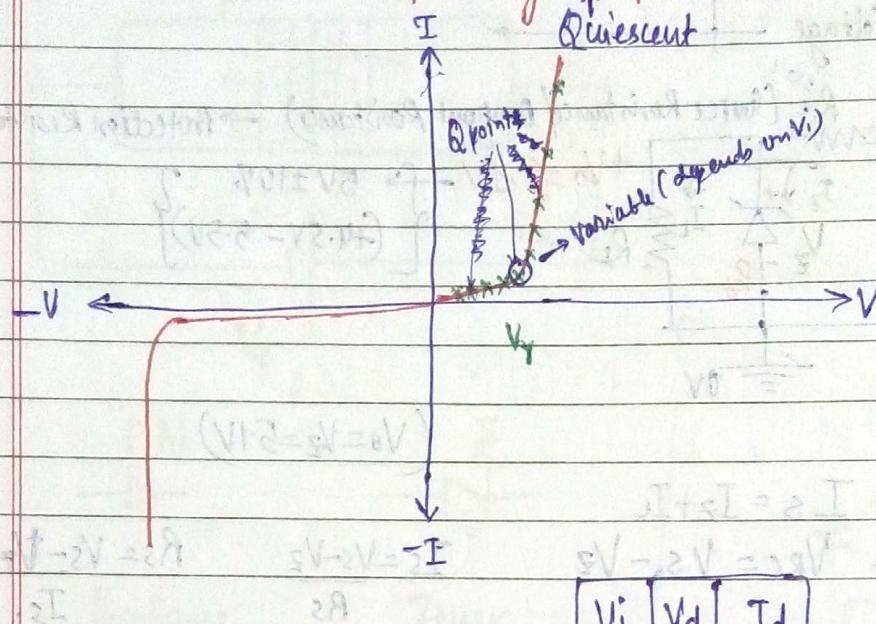
% (Tolerance)

$$P \text{ (Power Rating)} = V_{RS} \cdot I_s$$



Transformer Rectifier filter V Regulator
(Step up/dn) (H/W/PW) (C/LC) (Zener/IC)
BR

Load Line & Operating (Q) Point

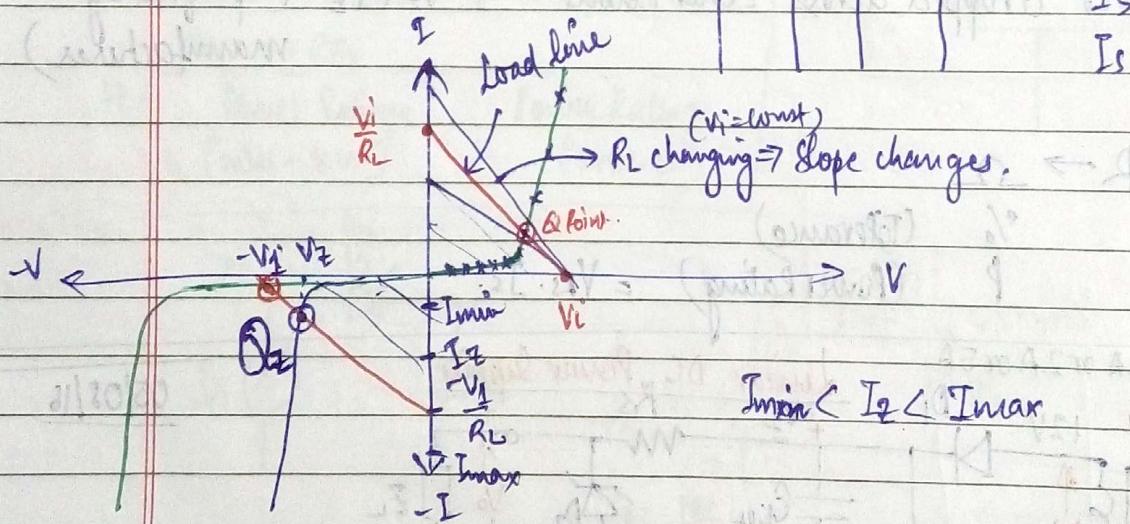


Reverse polarity to get reverse characteristic

V_i	V_d	I_d
0	+	-
0.1	-	-

$$I_S = I_Z + I_L$$

$$I_S = I_Z + \frac{V_D}{R_L}$$



$$I_{min} < I_Z < I_{max}$$

It determines expected current for a given voltage.

Q1.

Calculate the intrinsic carrier conc of Silicon, Germanium and Gallium Arsenide at

- (a) $T = 100\text{K}$ (b) $T = 300\text{K}$ (c) 500K .

Germanium

Silicon: $E_g = 1.12\text{eV}$

$$B = 5.23 \times 10^{15}$$

$$K = 1.38 \times 10^{-23}$$

$$0.67\text{eV}$$

$$1.66 \times 10^{15}$$

$$1.38 \times 10^{-23}$$

GaAs

$$1.42\text{eV}$$

$$2.1 \times 10^{14}$$

$$1.38 \times 10^{-23}$$

Ans.

$$n_i = BT^{3/2} e^{-E_g/2kT}$$

(a)

Si,

 $T = 100\text{K}$

$$n_i = 3.31 T \times 10^{-10} \text{ cm}^{-3}$$

$$n_i = 2.74 \times 10^{-10} \text{ cm}^{-3}$$

TRICK

$$E_g \rightarrow \text{eV}$$

$$k \rightarrow B \cdot 6 \times 10^{-5} = \frac{k}{e}$$

$$(b) T = 300\text{K} n_i = 1.0177 \times 10^{10}$$

$$(c) T = 500\text{K} n_i = 1.29 \times 10^{14}$$

Ge

$$(a) T = 100\text{K} n_i = 20.08 \text{ cm}^{-3}$$

$$(b) T = 300\text{K} n_i = 1.98 \times 10^{13} \text{ cm}^{-3}$$

$$(c) T = 500\text{K} n_i = 7.67 \times 10^{15} \text{ cm}^{-3}$$

GaAs

$$(a) T = 100\text{K} n_i = 2.93 \times 10^{19} \text{ cm}^{-3}$$

$$(b) T = 300\text{K} n_i = 1.22 \times 10^{16} \text{ cm}^{-3}$$

$$(c) T = 500\text{K} n_i = 1.58 \times 10^{11} \text{ cm}^{-3}$$

Q1 (c)

$$\text{Given } n_i = 5 \times 10^9 \text{ cm}^{-3} \xrightarrow{291\text{K}} \text{to } 5 \times 10^{11} \text{ cm}^{-3} \xrightarrow{360\text{K}}$$

Calculate temp range.

for Silicon.

 $\neq 1.85 \times 10^{10} \text{ at } 300\text{K}$

$$1.85 \times 10^{10} = B (300)^{3/2} e^{-E_g/2k(300)} \Rightarrow B \cdot C^{\frac{-E_g}{2k(300)}} = 2886751.346$$

$$5 \times 10^9 = B T^{3/2} e^{-E_g/2kT}$$

Use Trial and error method.

$$\frac{n_e}{N} = T^{3/2} \cdot \exp\left(\frac{-E_g}{2k} + \frac{1}{T}\right) = n_i T^{3/2} \cdot \exp\left(-\frac{k_2}{T}\right)$$

$T = 290\text{ K}$, $n_i = 4.57 \times 10^9 \text{ cm}^{-3}$.

$\Rightarrow T = 291\text{ K}$, $n_i = 4.969 \times 10^9 \text{ cm}^{-3} \Rightarrow n_i \approx 5 \times 10^9 \text{ cm}^{-3}$

$T = 352\text{ K}$, $n_i = 2.85 \times 10^{11} \text{ cm}^{-3}$

$\Rightarrow T = 360\text{ K}$, $n_i = 4.98 \times 10^{11} \text{ cm}^{-3} \Rightarrow n_i \approx 5 \times 10^{11} \text{ cm}^{-3}$

(iii)

Silicon is doped with $5 \times 10^{16} \text{ cm}^{-3}$ Arsenic atoms.

Calculate the electron and hole conc. at 300K and 350K.

Ans

$$N_d = 10^{16} \text{ cm}^{-3} \quad p_i = \frac{n_i^2}{N_d}$$

$n_i = 1.5 \times 10^{10} \text{ at } 300\text{K}$

at $T = 300\text{K}$, $n_i = 1.0177 \times 10^{10} \text{ cm}^{-3}$

$\Rightarrow p_i = 2071.426 \text{ cm}^{-3}$

Si 3 Atm.

4500 cm^{-3}

at $T = 350\text{K}$, $n_i = 2.85 \times 10^{11} \text{ cm}^{-3}$

$\Rightarrow p_i = 1624500 \text{ cm}^{-3}$

$1.6 \times 10^6 \text{ cm}^{-3}$

at 300K

Si

E_g (eV)

μ_n (cm^2/Vs)

μ_p (cm^2/Vs)

1.12 eV

1350

480

Ge

0.67 eV

3900

1900

GaAs

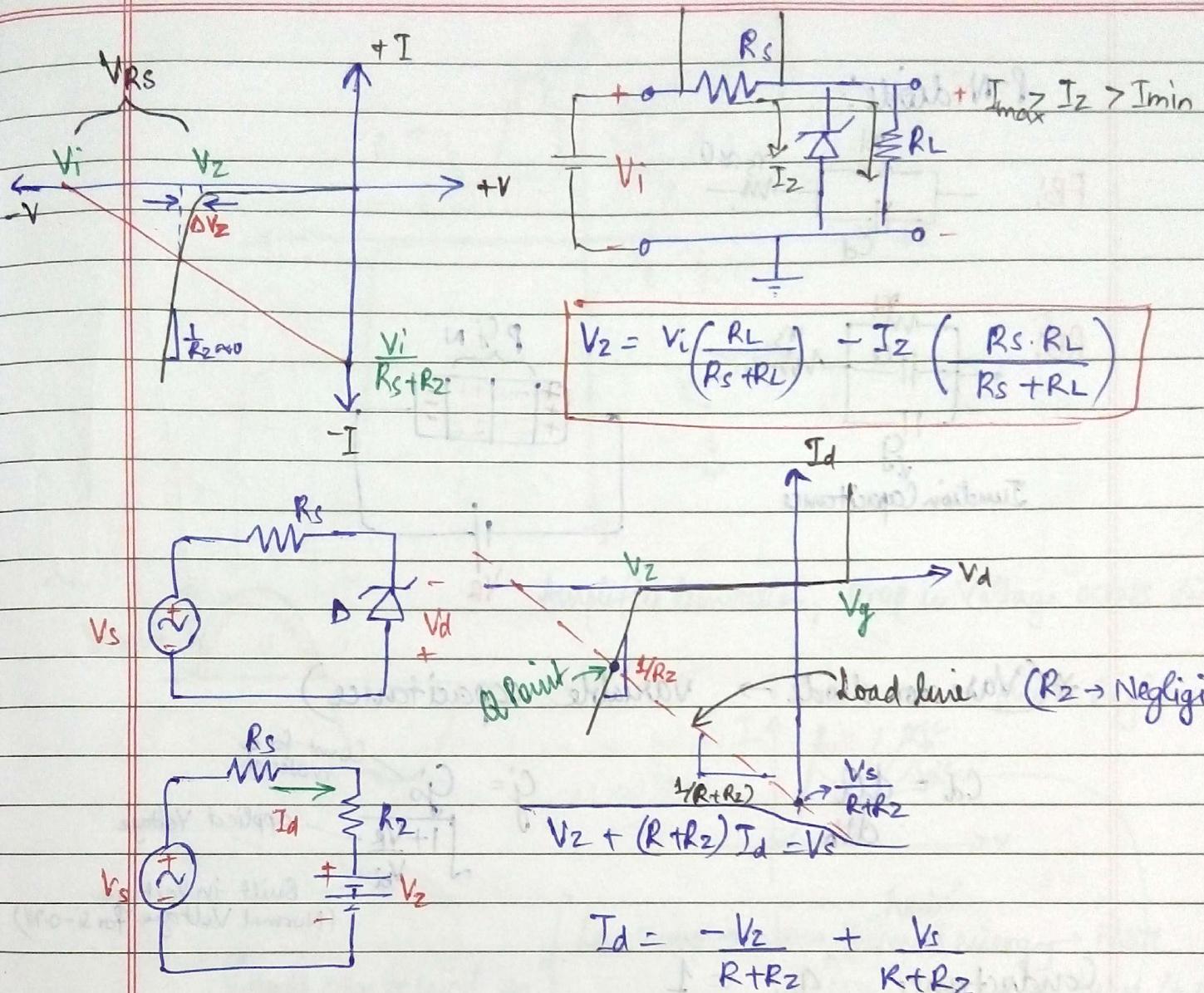
1.42 eV

8500

400

$$\frac{kT}{e} = \frac{D_n}{\mu_n} = \frac{D_p}{\mu_p} \rightarrow \text{cm}^2/\text{s}$$

0.0259
VAUBHAA
20mm
20mm



Input Voltage, Regulation accuracy

Quality of Regulation :-

$$1) \text{ Line / Source of Reg} = \frac{\Delta V_o}{\Delta V_i} \times 100\% \quad (\text{should be less than } 8\%)$$

$$2) \text{ Load Reg.} = \frac{V_{NL} - V_{FL}}{V_{FL}} \times 100\%$$

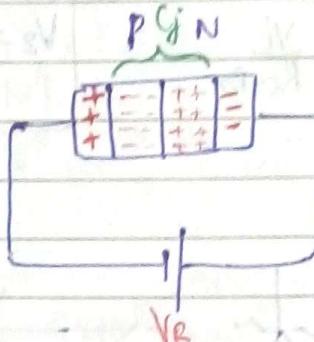
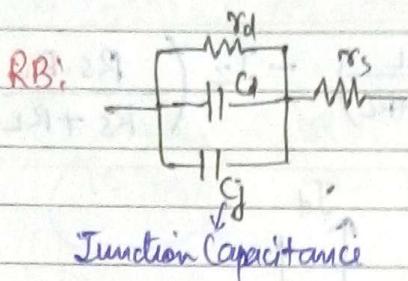
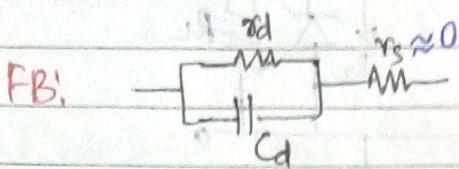
$R_2 > 0 \rightarrow$ finite slope,
little change in V_2 causes
high change in I

Eq. Representation of Zener diode :-

* R_B $\rightarrow \frac{V_Z}{I_Z} R_B$

* F_B $\rightarrow M R_Z$

P-N diode:



* (Varactor diode \rightarrow variable capacitance)

$$C_d = \frac{dQ}{dV_0}$$

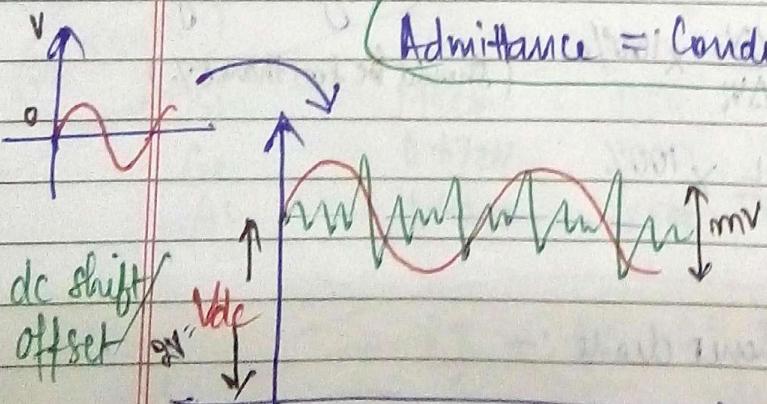
$$C_d = \frac{C_0}{1 + \frac{V_R}{V_b}}$$

Constant for a material
applied Voltage
 V_b
Built-in Voltage
(Normal Voltage for Si - 0.7V)

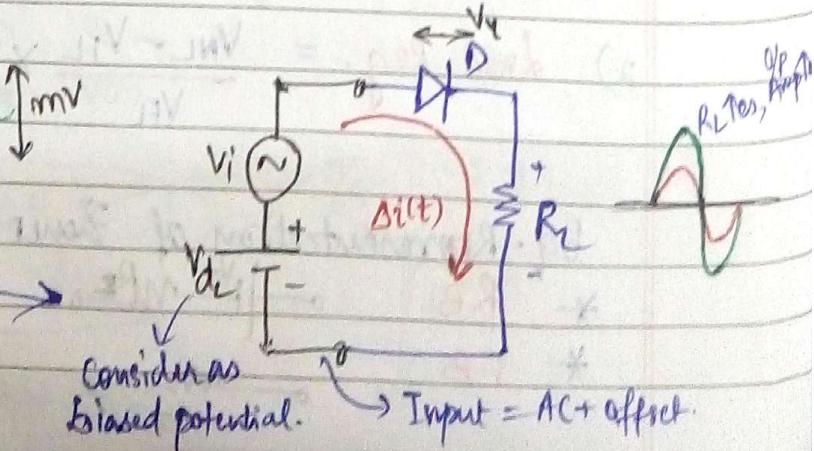
Conductance, $g_m = \frac{1}{r_d}$
(Inverse of Resistance)

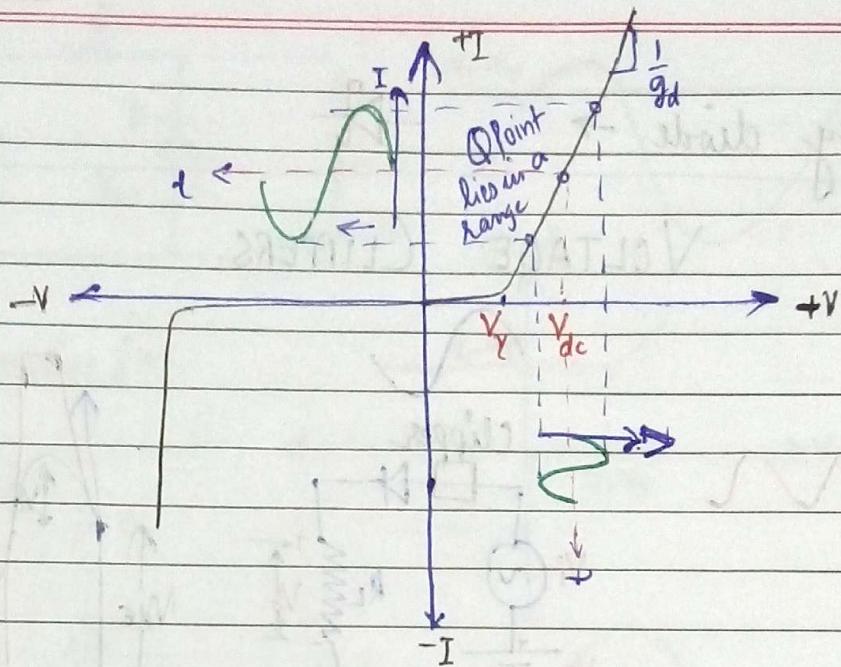
AC equivalent of Conductance \rightarrow Admittance $y_i = g_m + j\omega C_d$

Admittance = Conductance + Susceptance

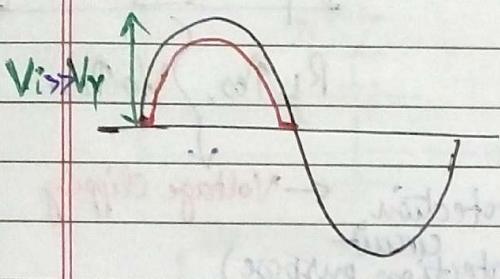


ANUFEHVA
JAIN
NOTES
Amplifier

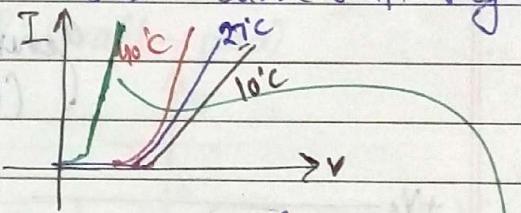




Amplifier limitation: Drop in Voltage across diode.

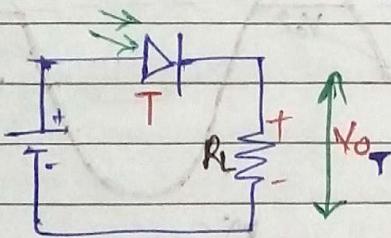


Tubes → curve shifts right.

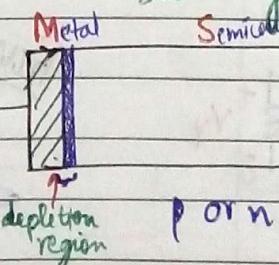


Diode can be used as
a Temperature Sensor.

Low Temp → low thermal energy → More heat
energy is req'd. to turn it on.
High Temp = less energy reqd.



Schottky diodes

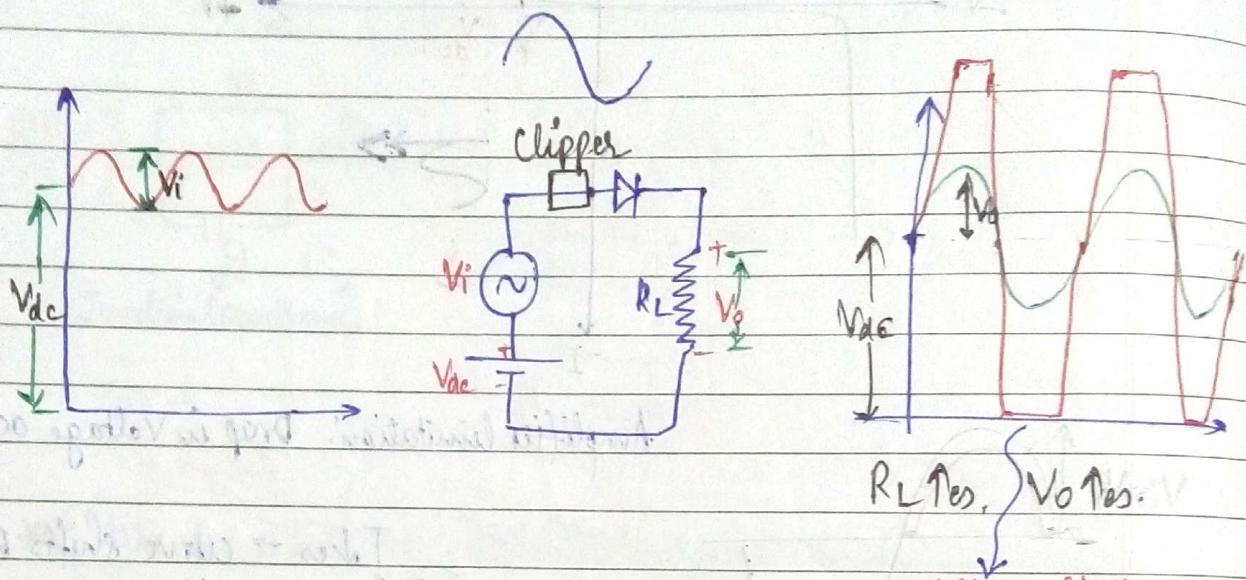


Metal-Semiconductor Junction → nanoscopic level

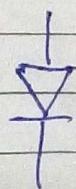
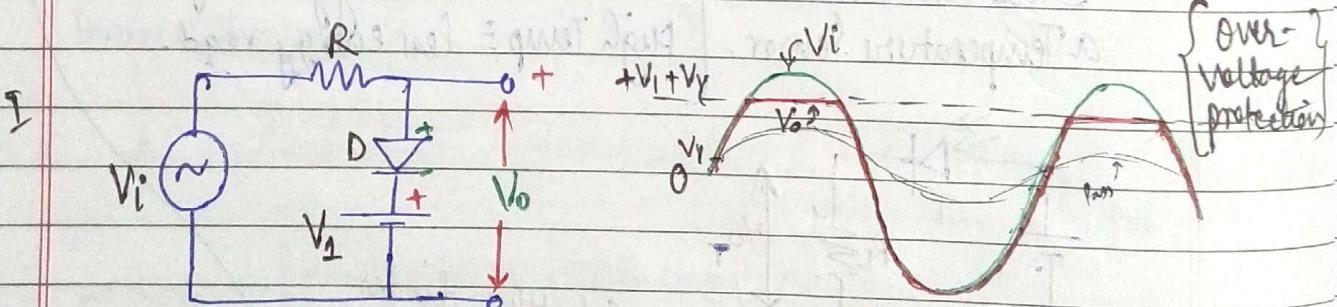
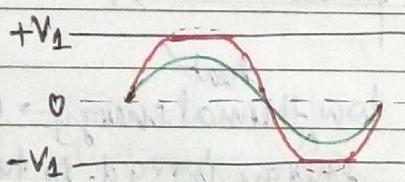
Schottky diode →



VOLTAGE CLIPPERS

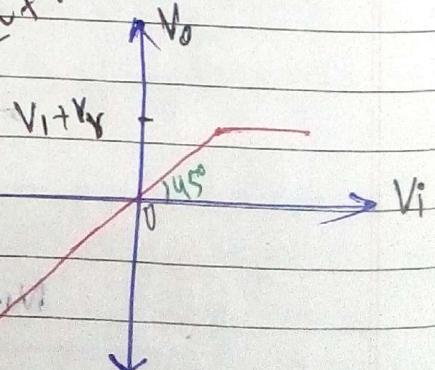


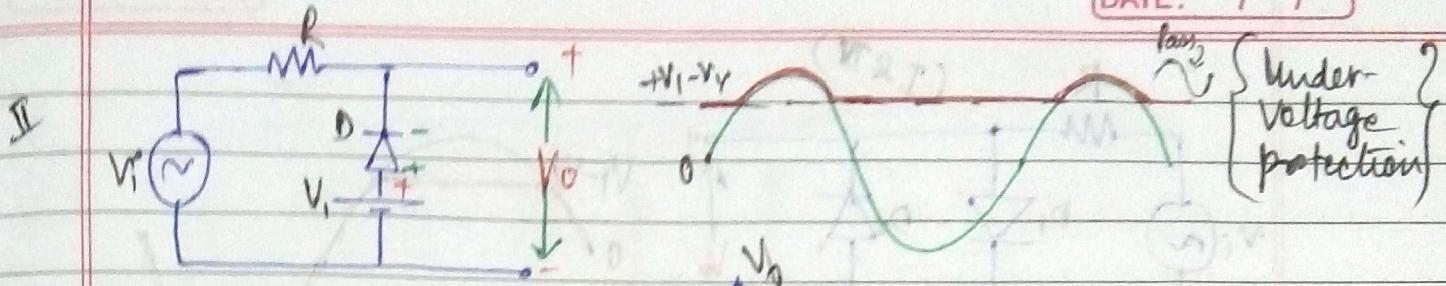
generally used for protection \leftarrow Voltage Clipping
(Over voltage protection purpose)
circuit



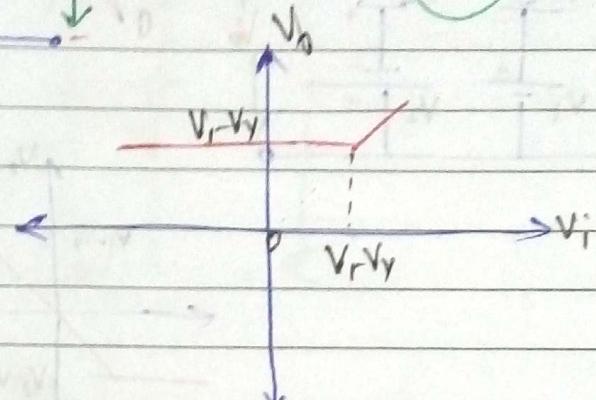
$$BB! = \frac{1}{3} + \sqrt{y}$$

Brantford M.

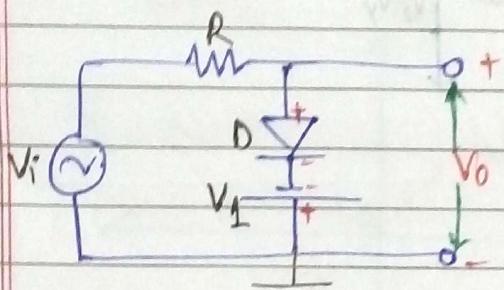




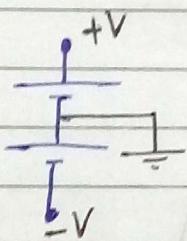
Transfer f/N:-



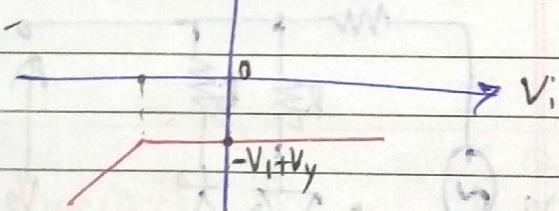
III



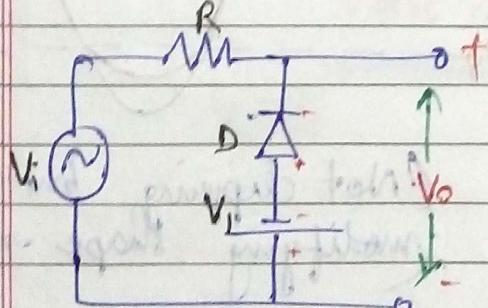
(if $R = \text{high}$) \rightarrow V drop across R has to be considered
 $(R = \text{small} \rightarrow \text{peaks})$



Tf:-

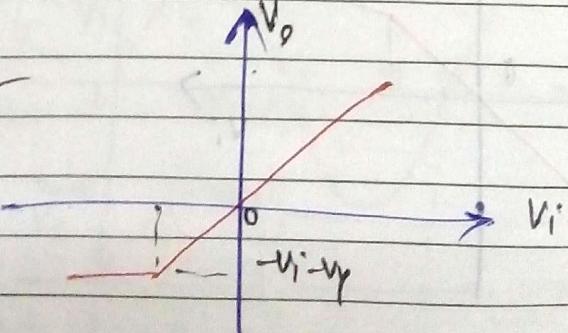


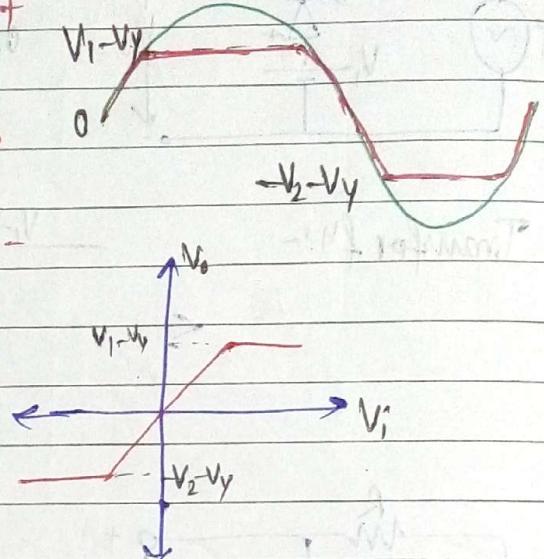
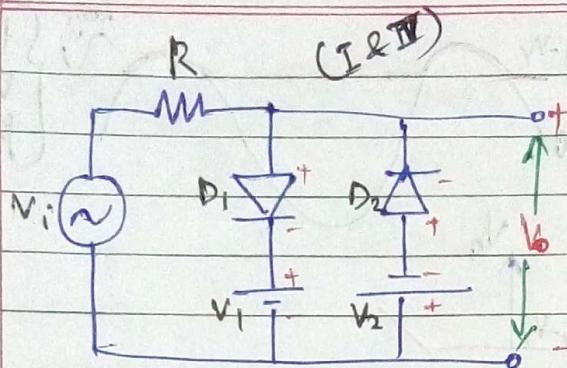
IV



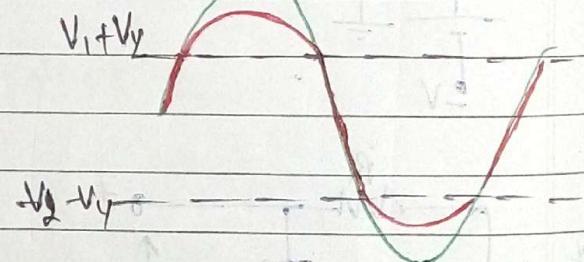
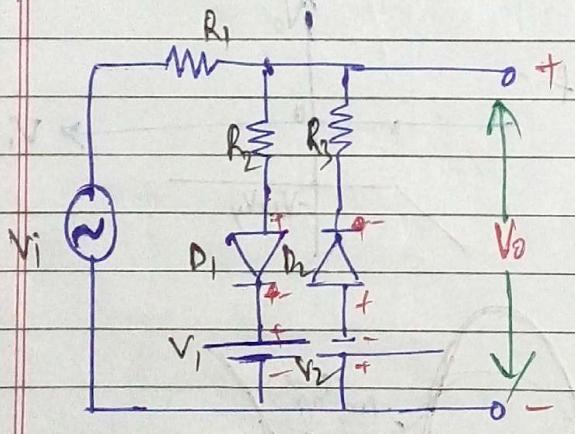
(Same o/p)

Tf. Chi:-

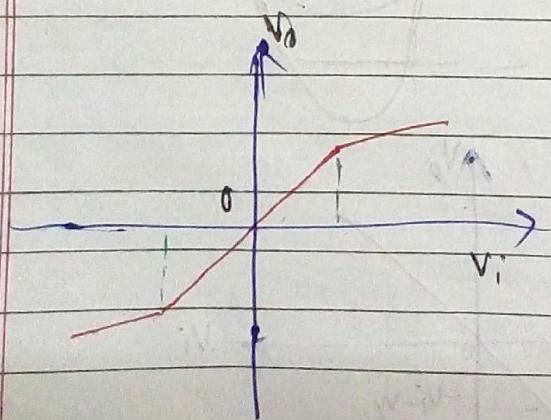


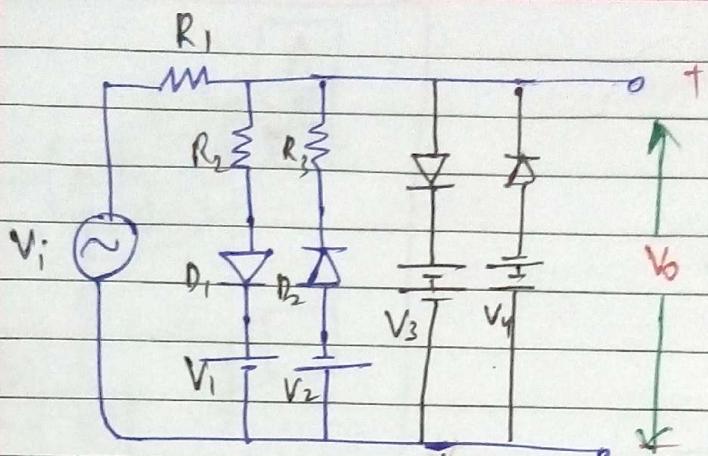


Decrease threshold
(for producing no charge change)



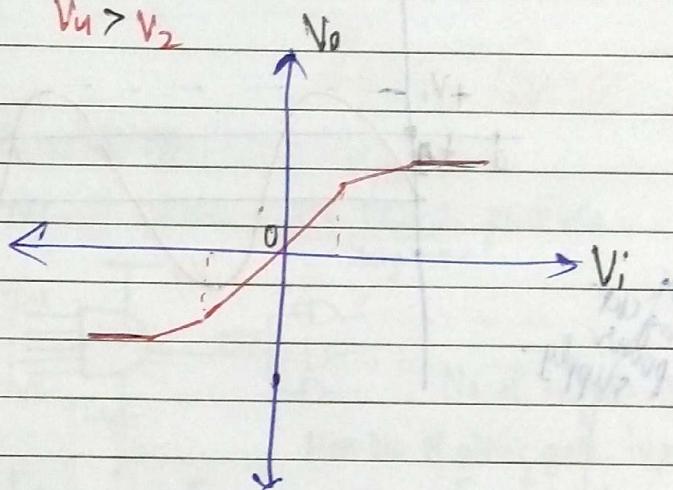
Not clipping but
(modifying shape \rightarrow Vout)





$$V_3 > V_1$$

$$V_4 > V_2$$



12/08/16

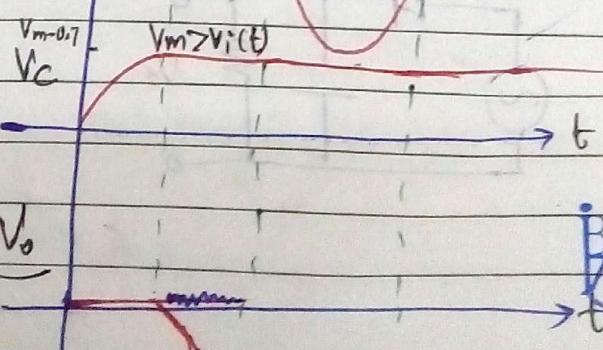
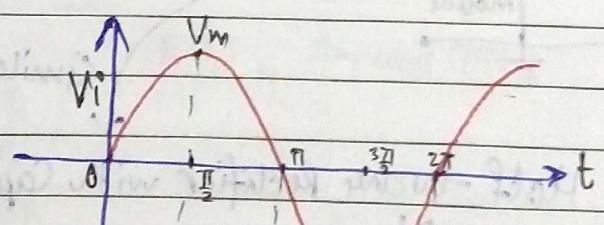
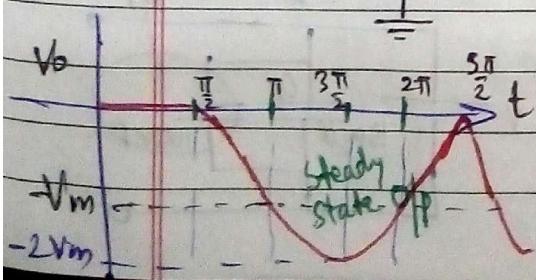
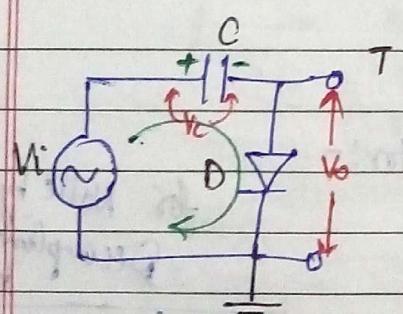
WAVE SHAPING CIRCUITS

Clipper

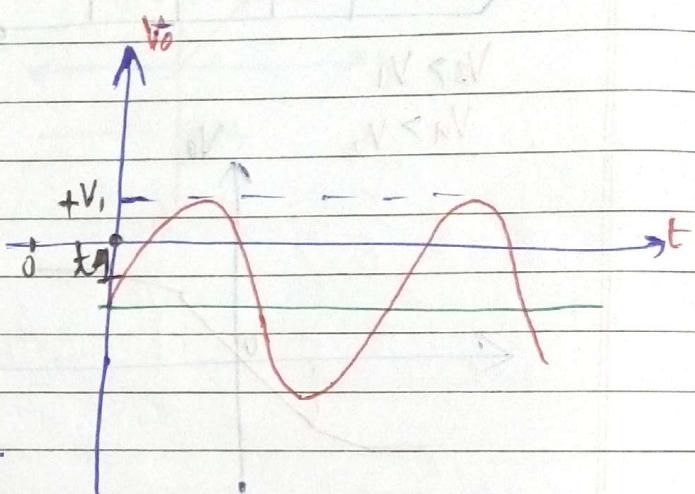
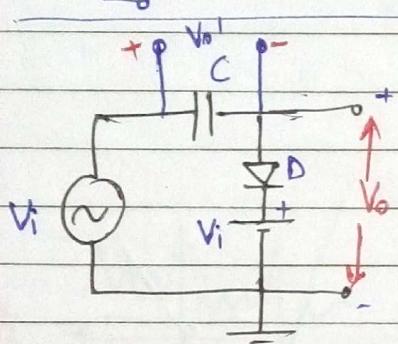
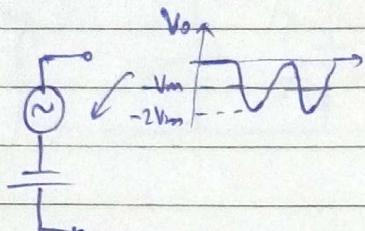
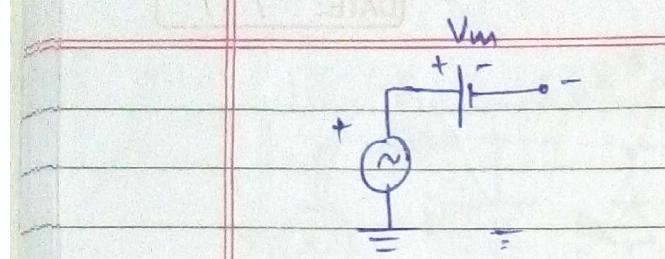
Clamper

DC shift

CLAMPER

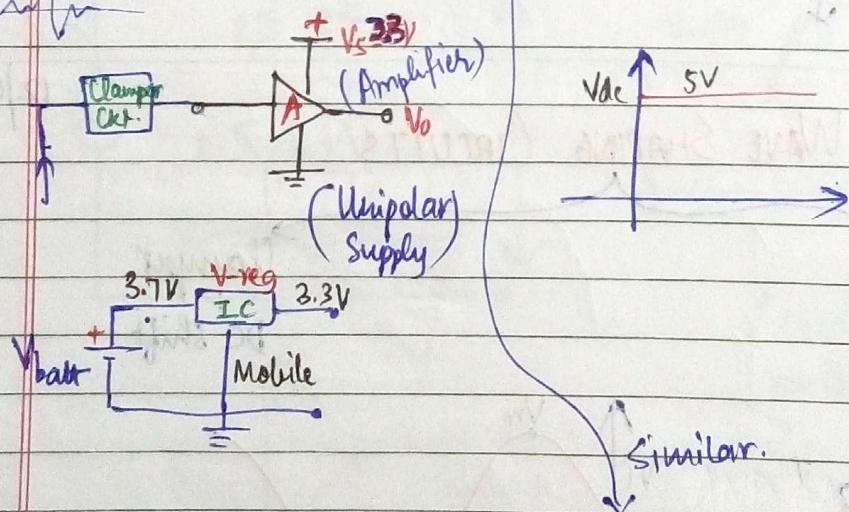


BANUBHAJ
JAIN NOTES



Charging cap as power supply.

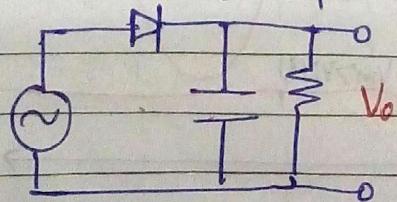
Amplifier



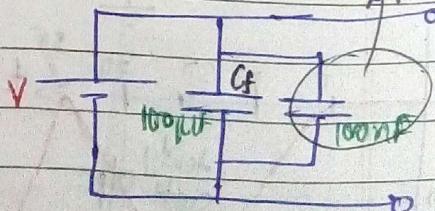
$V_{dc} = 5V$

Similar.

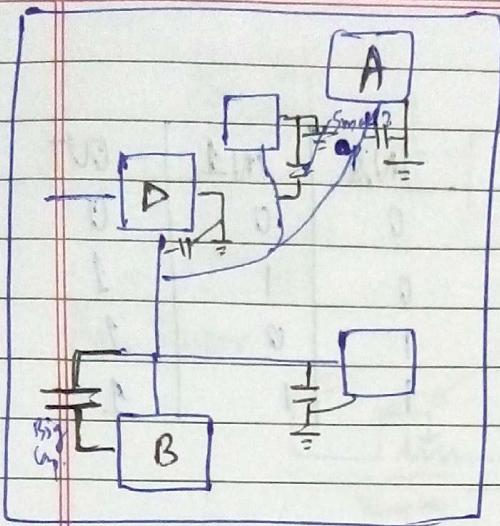
Half-Wave Rectifier with Capacitor! -



for Noise bypassing
Decoupling



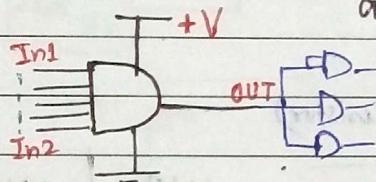
VANISHA
MAIN
NOTES



LOGIC GATES

NOT \rightarrow 1 I/p

Other \rightarrow 2 or More than 2 possible.
any no.



No. of inputs that can be connected by output \rightarrow Limited

Max. No. of other gate inputs that may be connected

Emitter
Coupled
Logic

Fan-in = 5

Fan-out = X

* Logic family \rightarrow

TTL
Transistor Transistor Logic
(+)

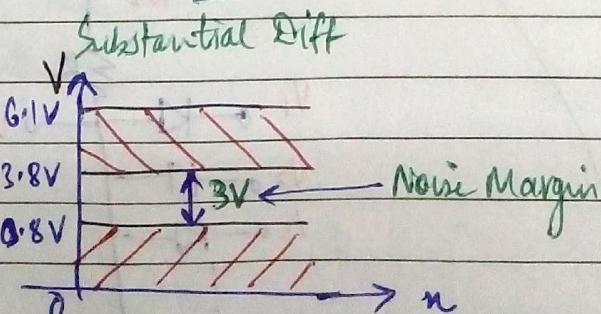
DTL
Diode TL
(+)

ECL
(-)

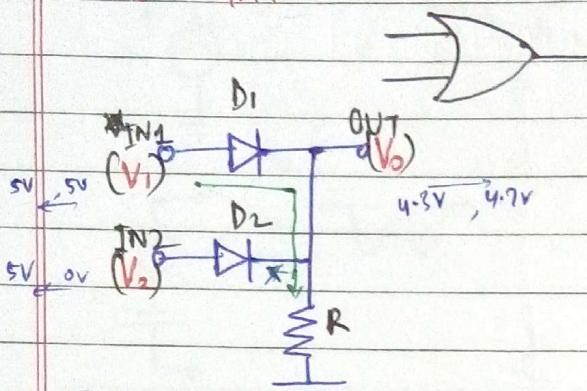
* Noise Margin \rightarrow 1, 0

0 \rightarrow OV (0-0.8V)

1 \rightarrow 5V, -5V (ECL), Any value (DTL)
(4.5-5.5)
(3.8-6.4V)

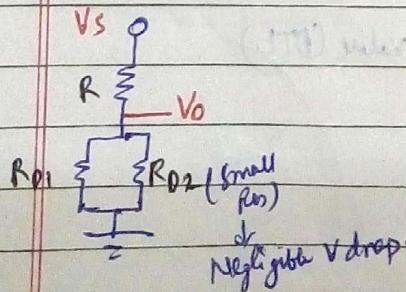
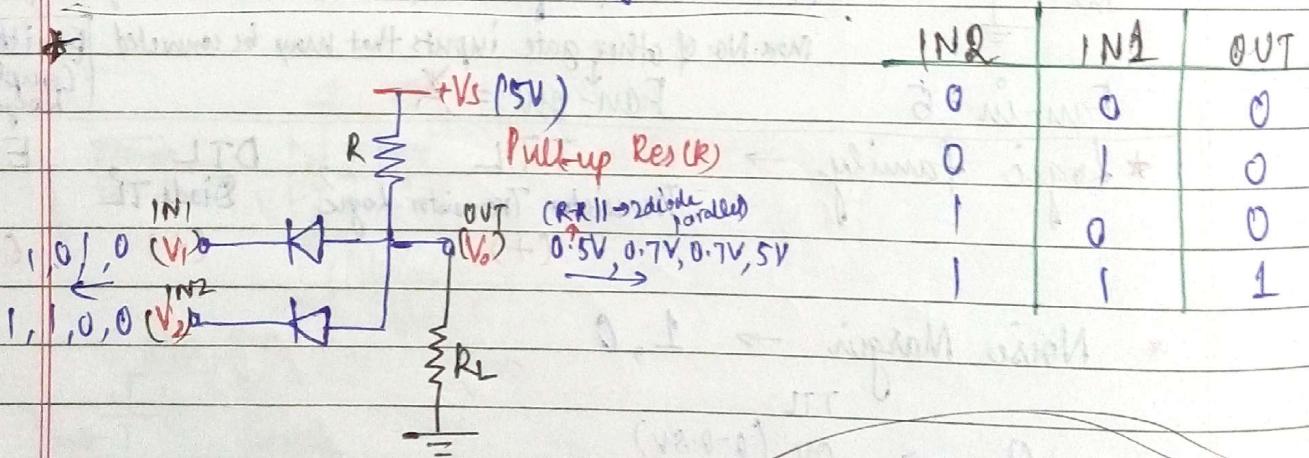
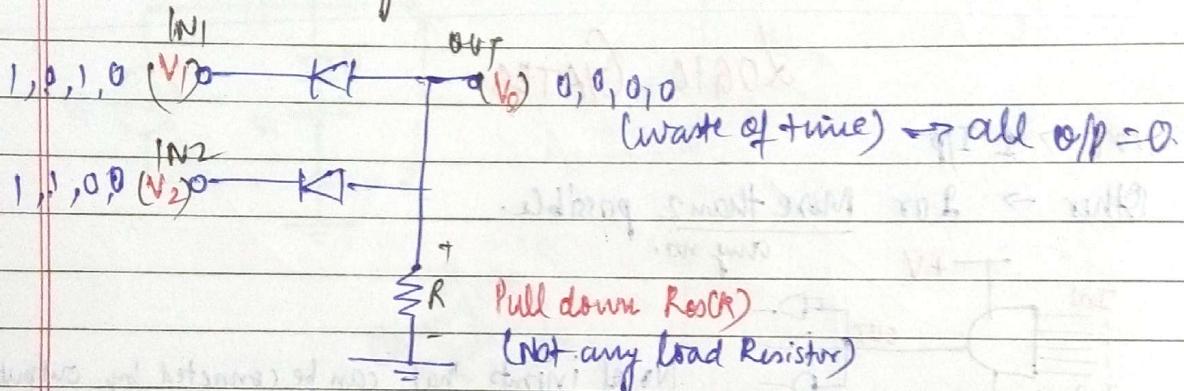


OR GATE

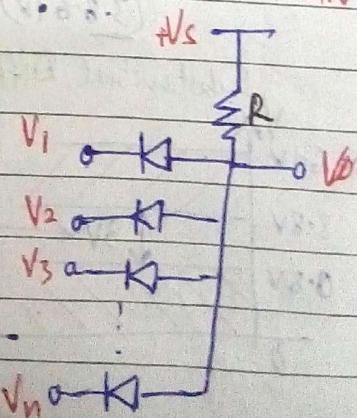


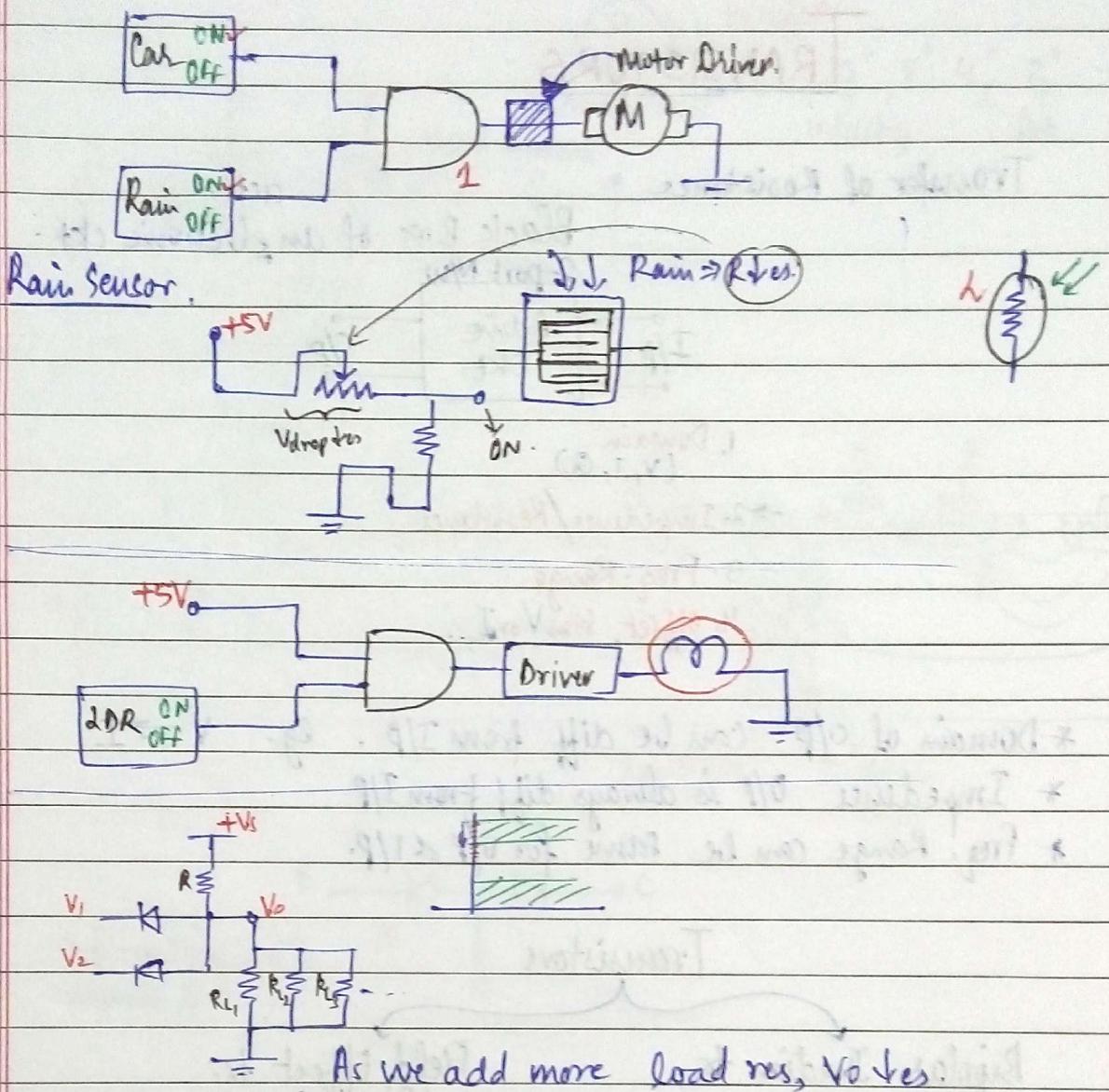
IN ₂	IN ₁	OUT
0	0	0
0	1	1
1	0	1
1	1	1

* Iterative Design Process.



AND GATE: F_{AN-IN} = n





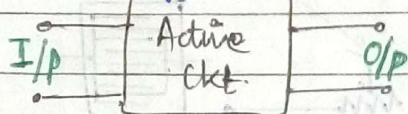
$R \rightarrow$ large \rightarrow fan-out large
 $R \rightarrow$ small \rightarrow fan-out low.

TRANSISTORS

Transfer of Resistance

Black Box of an electronic ckt.

2-port N/W



active

1. Domain
(V, I, G)

→ 2. Impedance / Resistance

3. Freq. Range

4. Offset, bias V or I, ...

* Domain of O/P can be diff from I/P. e.g. $V \rightarrow I$

* Impedance O/P is always diff from I/P.

* freq. Range can be same for O/P & I/P.

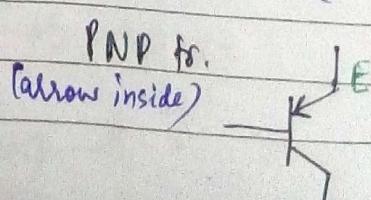
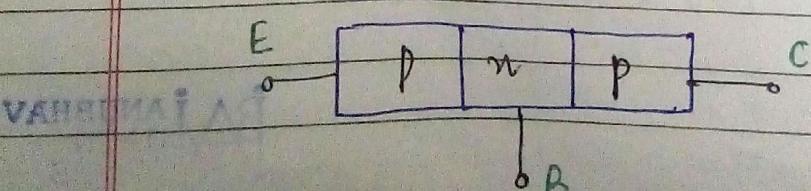
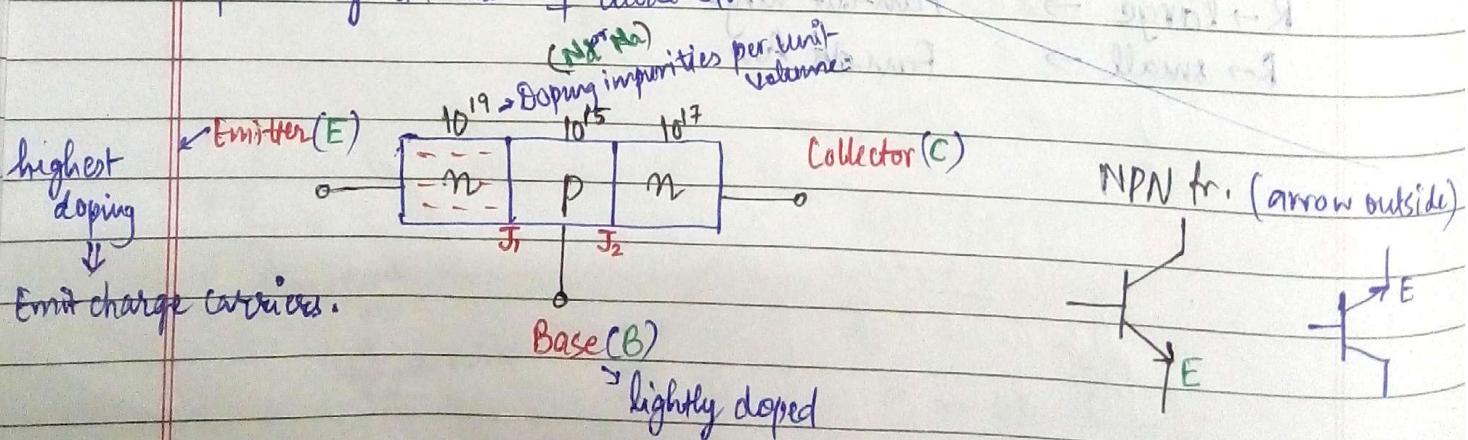
Transistors

Bipolar Junction tr.

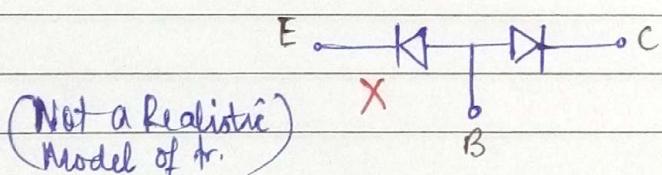
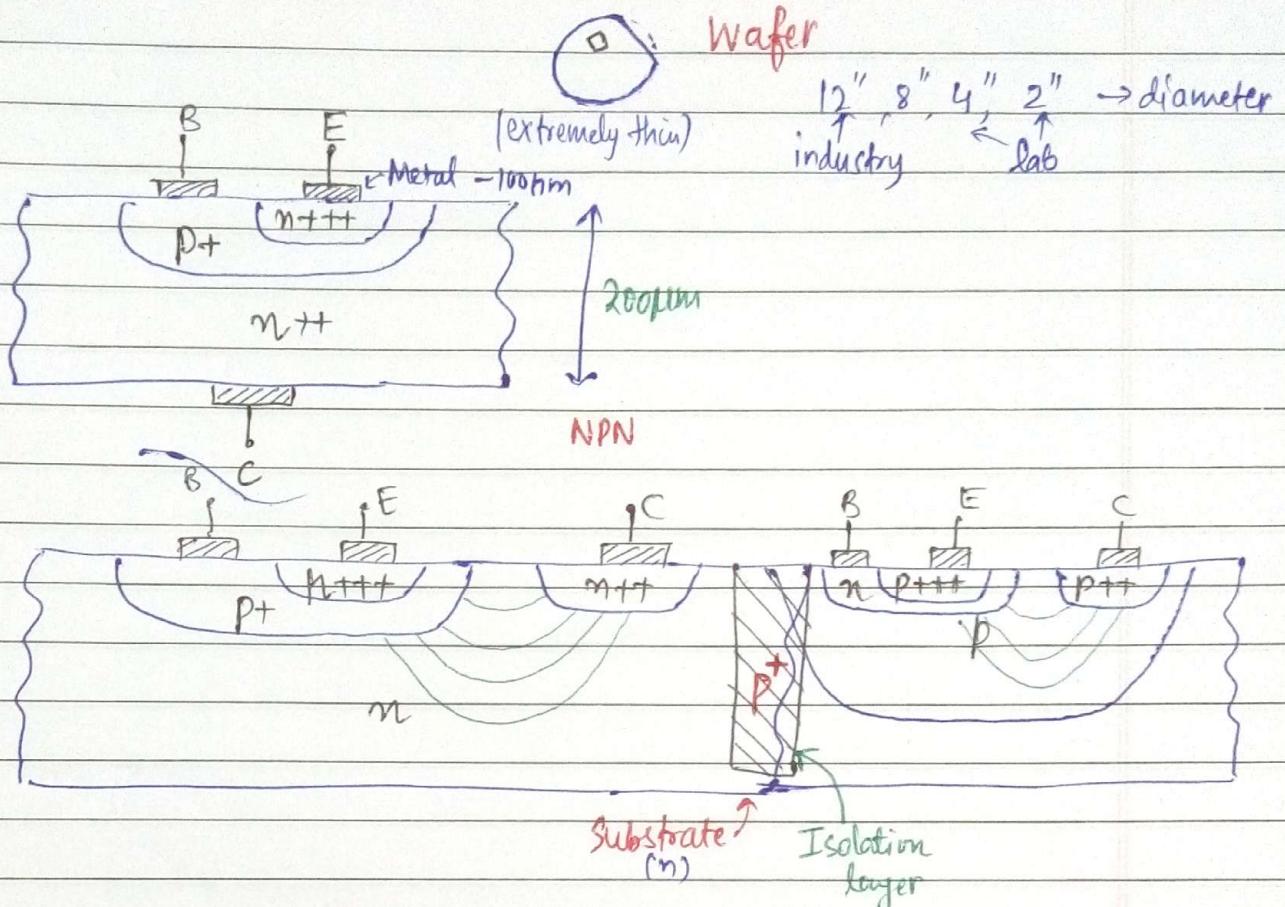
(BJT)

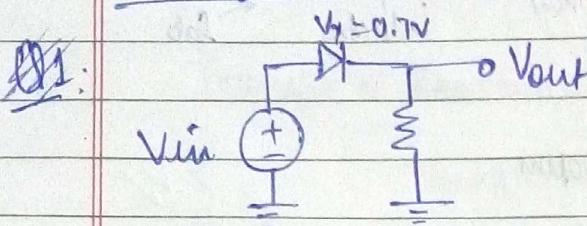
Field Effect tr.
(E) (FET)

→ formed by extension of diode str.



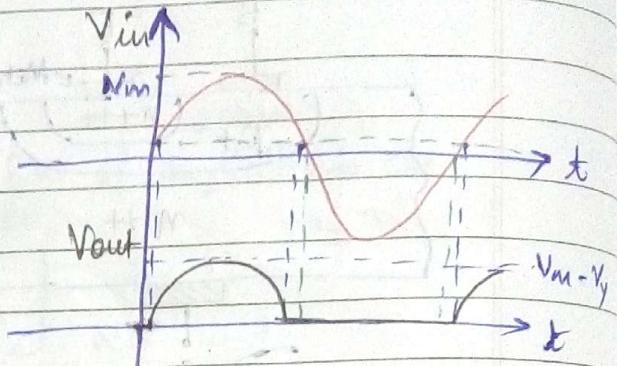
(Arrow ≡ E)



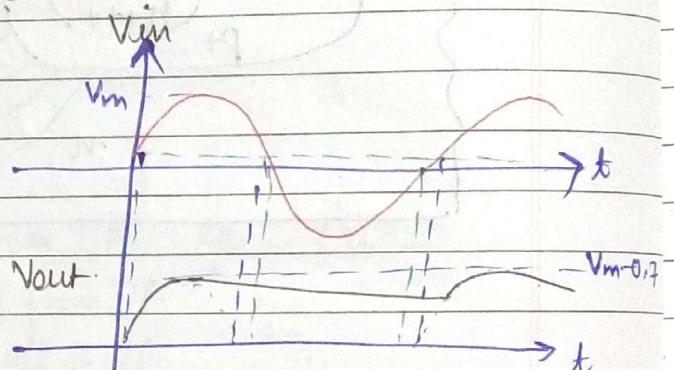
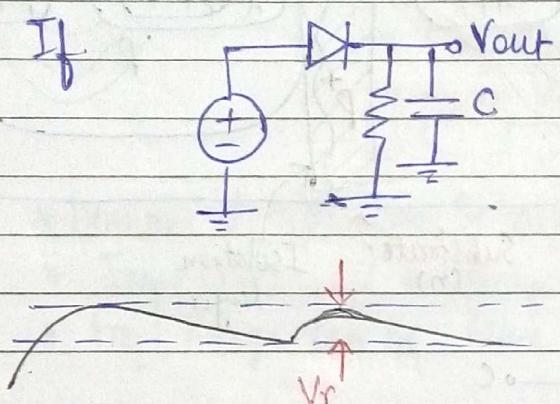
TUTORIALRectified Circuits

$$\text{Max. } V_{\text{out}} = V_m - V_d$$

$$V_{\text{out}} = V_m \sin(\omega t)$$



If



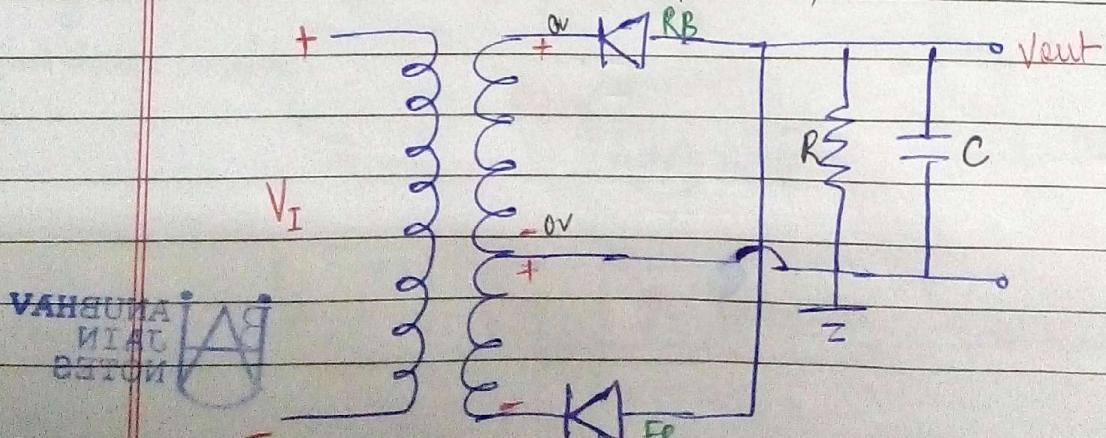
$$\text{Full wave } V_r = \frac{V_m - 0.7}{2fRC}$$

$$\text{Half wave } V_r = \frac{V_m - 0.7}{fRC}$$

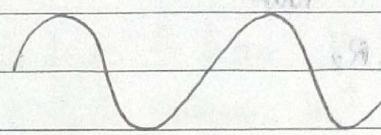
Q2.

The rectifier circuit shown in Fig 1 has an input signal value of freq. 60Hz. RMS of V_{in} = 8.5V Cut-in voltage of diodes = 0.7V, $R = 10\Omega$, $C = 0.001\mu F$

Find max. value of V_o , What is PIV of each diode?



Centre tap
transformer.

V_I  V_S 

→ half of V_I .

$$V_{S_{\text{max}}} = \frac{8.5 - 0.7}{2 \times 60 \times 10 \times 10^3} = \frac{13}{80} = 0.1625 \text{ V}$$

$$V_{O_P} = V_{S_{\text{max}}} (\sqrt{2}) = 0.2298 \text{ V}$$

$$V_m = 8.5\sqrt{2} = 12.021 \text{ V}$$

$$V_m - 0.7 = 11.321 \text{ V}$$

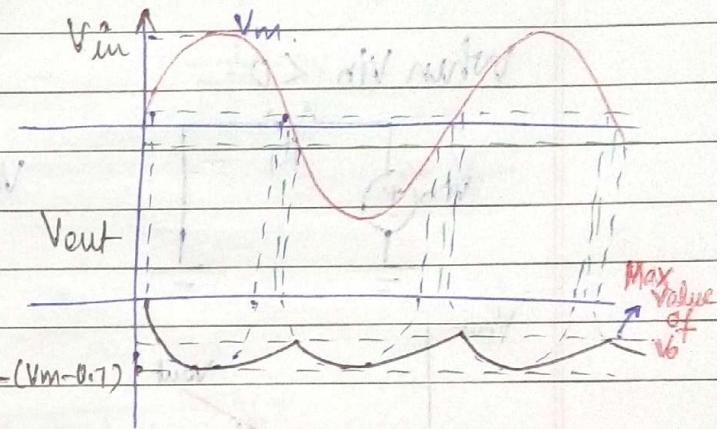
$$\begin{aligned} V_{o_{\text{max}}} &= -11.321 + 0.2298 \\ &= -11.091 \text{ V.} \end{aligned}$$

$$V_L = 11.321$$

$$\frac{2 \times 60 \times 10 \times 40 \times 10^{-3}}{2 \times 60 \times 10 \times 10^3}$$

$$= 0.2358 \equiv 0.236 \text{ V}$$

$$\therefore V_{o_{\text{max}}} = -11.32 + 0.236 = -11.0851 \text{ V}$$



PIV: Peak Inverse Voltage :-

Max value of V_I - Min value of $V_{o_{\text{min}}}$ will max value of diode voltage.

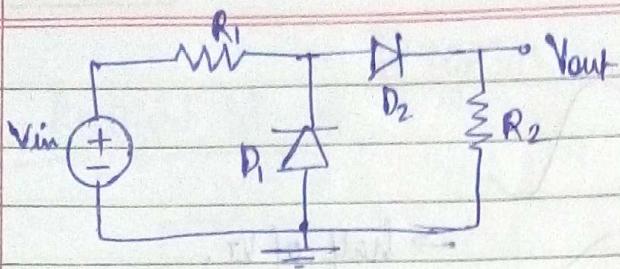
$$\begin{aligned} \text{Max. PIV of diode} &= 12.02 - (-11.32) \\ &= 23.34 \text{ V.} \end{aligned}$$

Q2.

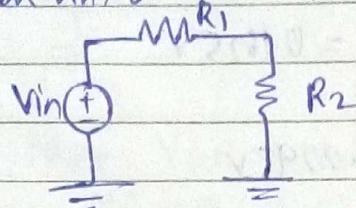
In the circuit of fig 2, $R_1 = 500 \Omega$, $R_2 = 1k\Omega$.

Sketch the input output characteristics for $V_{o_{\text{min}}} \text{ v/s } V_{in}$.

Also plot the current through R_1 . Assume $V_T = 0 \text{ V}$.



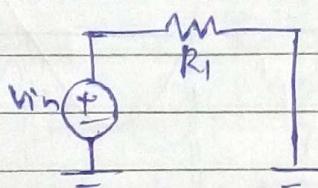
When $V_{in} > 0$



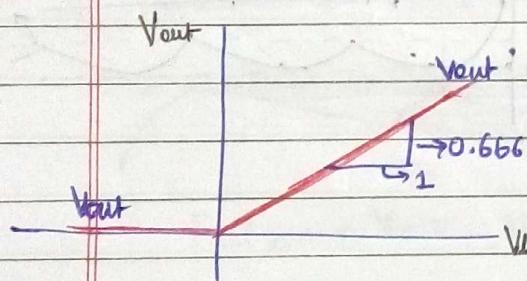
$$V_{out} = \frac{R_2}{R_1 + R_2} V_{in} = \frac{2}{3} V_{in}$$

$$= V - \frac{R_1}{R_1 + R_2} V$$

When $V_{in} < 0$



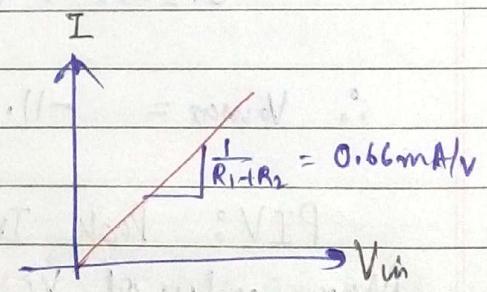
$$V_{out} = 0$$



Current through R_1

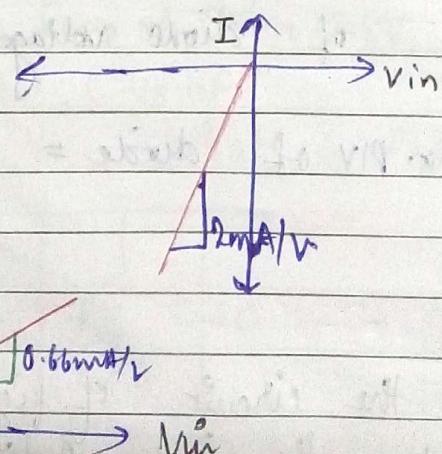
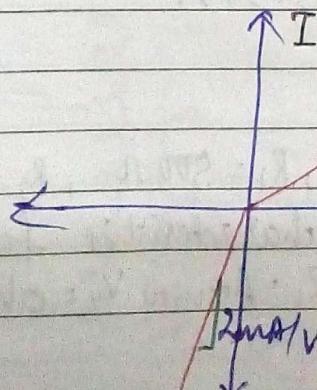
When $V_{in} > 0$

$$I = \frac{V_{in}}{R_1 + R_2}$$



When $V_{in} < 0$

$$I = \frac{V_{in}}{R_1}$$

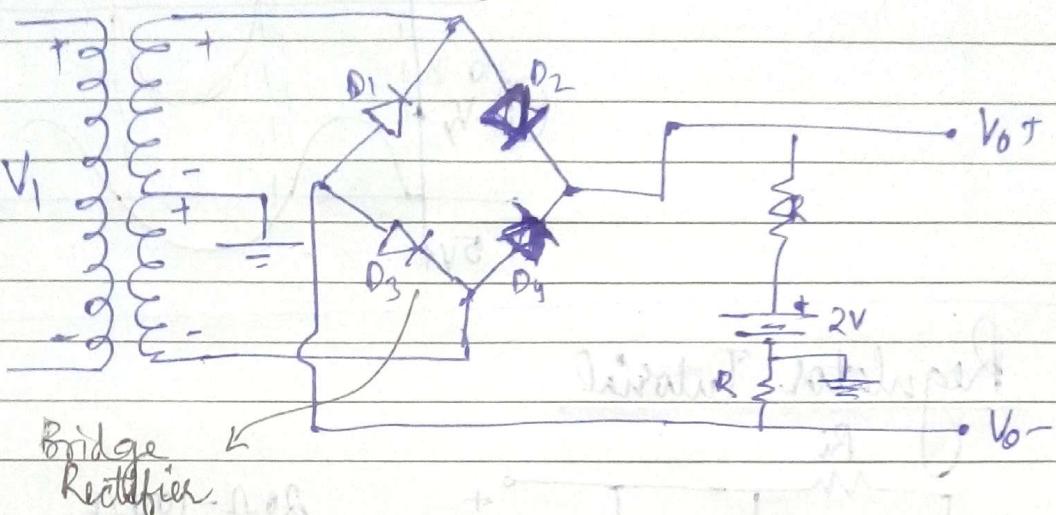


Q3.

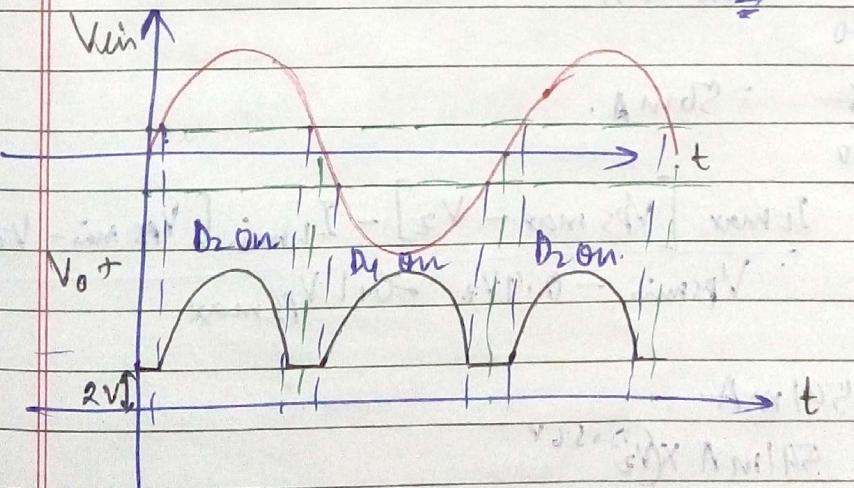
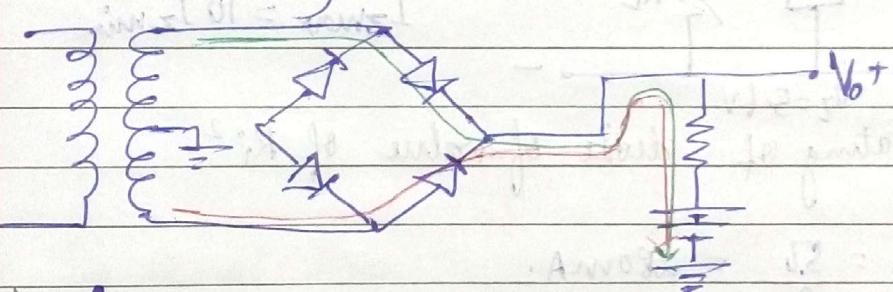
The ckt. in fig B has $V_s = 26 \sin(2\pi 60t)$.

Sketch output voltage V_o^+ and V_o^- v/s time.

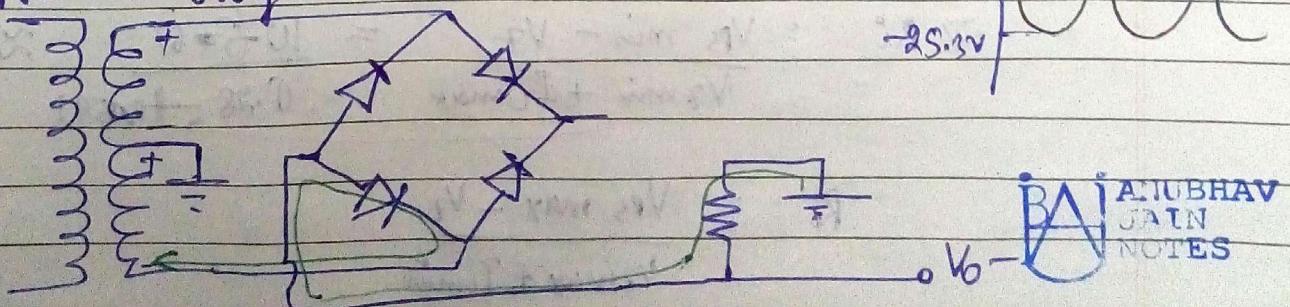
Assume $V_f = 0.7V$.



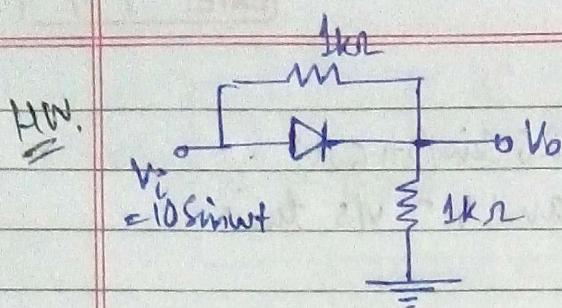
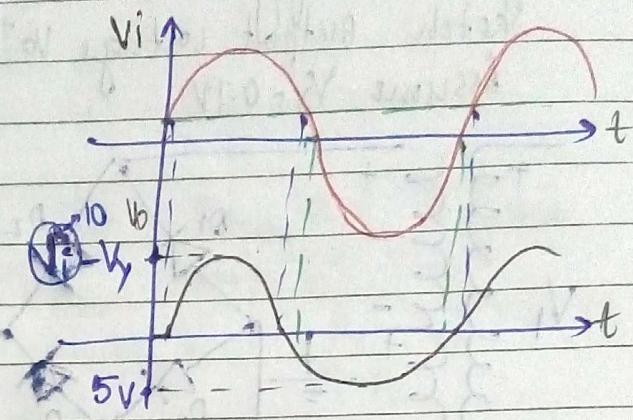
Consider V_o^+ only



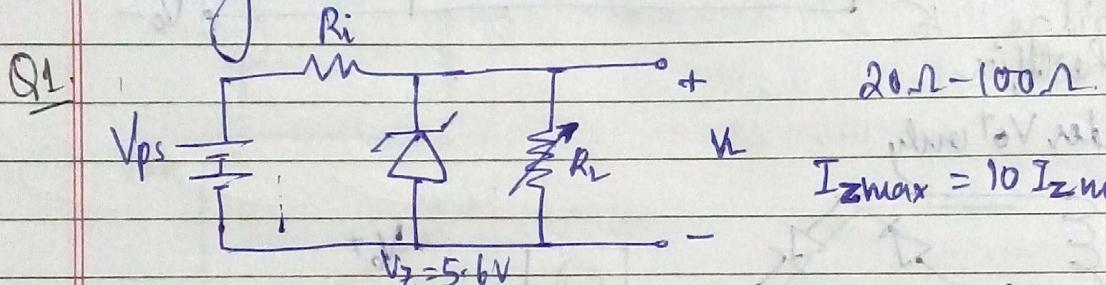
Now V_o^- only :-



BAJAJUBHAV
JAIN
NOTES

plot V_o v/s t .

Regulator Tutorial

Find power rating of diode of value of R_i^2 .

$$I_{L\max} = \frac{5.6}{20} = 280 \text{ mA}$$

$$I_{L\min} = \frac{5.6}{100} = 56 \text{ mA}$$

$$I_{z\max} = I_{L\max} [V_{ps\max} - V_z] - I_{L\min} [V_{ps\min} - V_z]$$

$$= V_{ps\max} - 0.9V_z - 0.1V_{ps\min}$$

$$= 591 \text{ mA}$$

$$I_{z\max} \cdot V_z = 591 \text{ mA} \times 5.6 \text{ V}$$

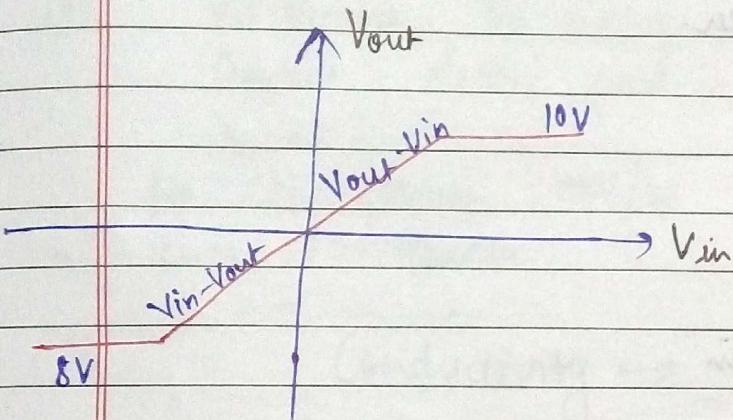
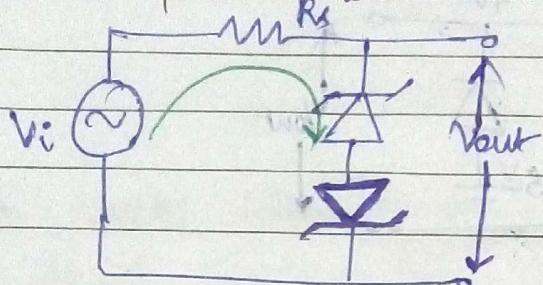
$$= 3.31 \text{ W}$$

$$\Rightarrow R_i = \frac{V_{ps\min} - V_z}{V_{z\min} + I_{z\max}} = \frac{10 - 5.6}{0.28 + 0.591} \approx 13 \Omega$$

$$R_i = \frac{V_{ps\max} - V_z}{V_{z\max} + I_{z\min}}$$

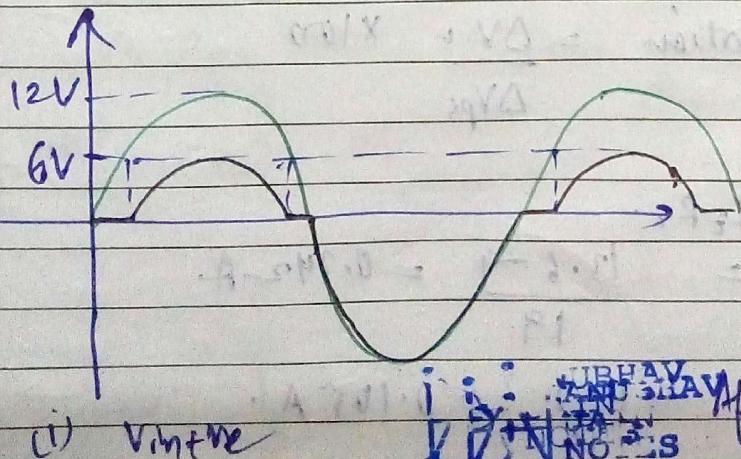
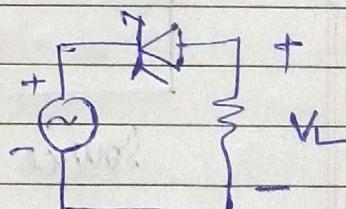
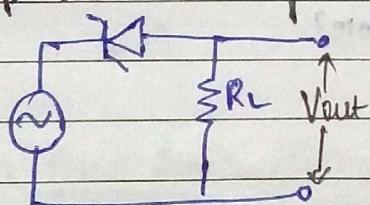
(Q2.)

In the circuit shown diodes are ideal and have breakdown voltage of $V_Z = 10V$, $V_{Z2} = 8V$. If input is 15V peak sinusoidal waveform then plot the output of transfer characteristics.



(Q3.)

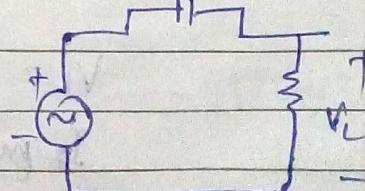
In circuit shown, zener diode is ideal and breakdown voltage is 6V, if the input voltage is 12V peak sinusoidal then plot the output waveform.



NOTES
IBHAY
XADHAY

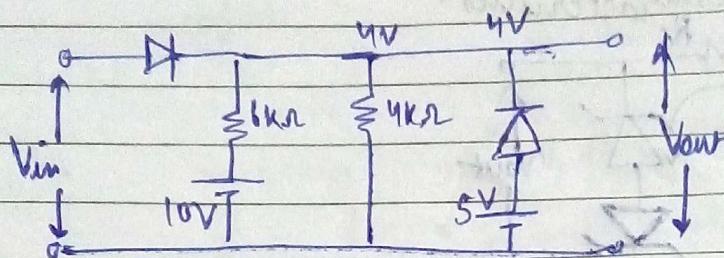
After breakdown, it has constant value
 $V_{min} = 6V$

$V_{in} - 6 = V_L$
 $V_{in} = 12V$
 $V_L = 6V$

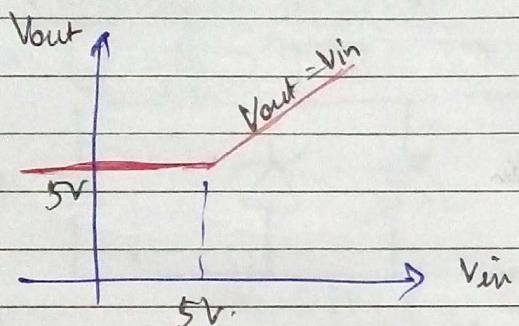


Qn.

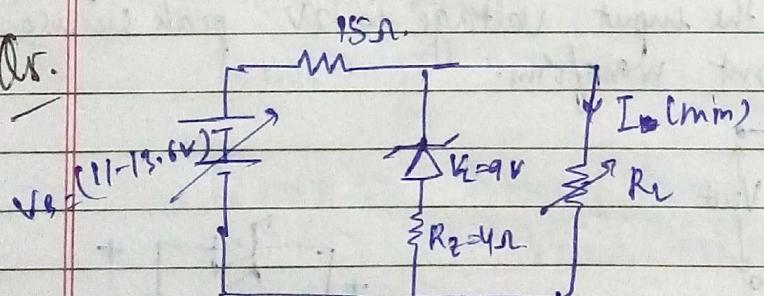
In the circuit shown, the diodes are ideal.
Plot its char.



First assume both are open.



Qn.



$$\text{Source Regulation} = \frac{\Delta V_o}{\Delta V_{ps}} \times 100$$

$$V_i = V_2 + I_2 R_2$$

$$I_2 (\text{max}) = \frac{13.6 - 9}{1} = 0.242 \text{ A}$$

$$I_{2 \text{ min}} = \frac{11 - 9}{1} = 0.105 \text{ A}$$

$$V_{max}, V_{min}; \Delta V = V_{max} - V_{min}.$$

TUTORIAL

24/08/16

- Q2(i) In GaAs determine the range of conductivity for a range in donor concentration of $10^{15} \leq N_d \leq 10^{19} \text{ cm}^{-3}$
- (ii) Determine the range of direct current density if the applied electric field is $E = 0.1 \text{ V/cm}$.

$$\mu_p = 4000 \frac{\text{cm}^2}{\text{Vs}}$$

$$\mu_n = 8500 \frac{\text{cm}^2}{\text{Vs}}$$

(i) Conductivity $\rightarrow \sigma = e \mu_n N_d$

$$\sigma_{max} = 13600$$

$$\sigma_{min} = 1.36$$

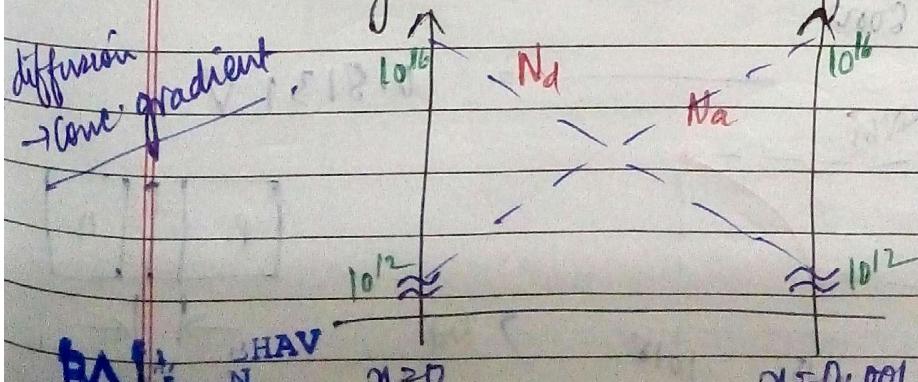
$$\Rightarrow 1.36 < \sigma < 13600$$

(ii) $J_n = \sigma E = 0.1 \sigma$

$$\Rightarrow 0.136 < J < 1360$$

$\hookrightarrow \text{A/cm}^2$

- (iii) Electron and hole conc. in a sample of silicon are shown in fig. Determine the total diffusion current density versus distance for $0 \leq x \leq 0.001 \text{ cm}$



$$\mu_n = 1250 \text{ cm}^2/\text{Vs}$$

$$\mu_p = 950 \text{ cm}^2/\text{Vs}$$

$$\frac{dn}{dx} = -(10^{16} - 10^{12}) = -9.999 \times 10^{12}$$

$$x = 0.001 \text{ cm.}$$

$$\frac{dp}{dx} = - \frac{dn}{dx} = +9.999 \times 10^{18}$$

$$\frac{KT}{e} = \frac{D_n}{\mu_n} = \frac{D_p}{\mu_p}$$

$$J_n = e D_n \frac{d N_d}{dx}$$

$$= \varphi \frac{\mu_n k T}{e} \frac{d N_d}{dx} = -51.767 \text{ A cm}^{-2} \times 10^2 \times 10^8 \\ = 5176.7 \text{ A cm}^{-2}$$

$$J_p = -e D_p \frac{d N_d}{dx}$$

$$= -\mu_n k T \frac{d N_d}{dx} = -18.6218137 \times 10^2 \text{ A cm}^{-2}$$

$$\text{Total diffusion current density} = -70.72 \text{ A/cm}^2.$$

$\text{my} \rightarrow (-70.7)$

Q3 (i) The donor concentration at a silicon p-n junction is $N_d = 10^{16} \text{ cm}^{-3}$ plot the V_{bi} versus N_a over the range of $10^{15} \leq N_a \leq 10^{18} \text{ cm}^{-3}$ at 300K.

$$n_i = 1.5 \times 10^{10} \text{ cm}^{-3}$$

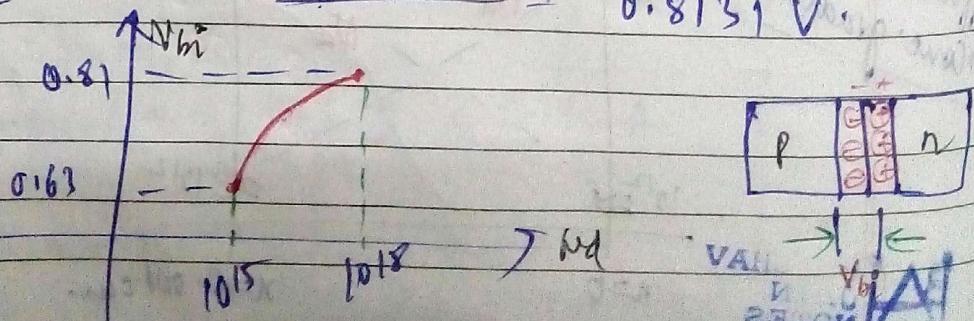
$$N_d = 10^{16} \text{ cm}^{-3}$$

$$V_{bi} \rightarrow \text{built-in potential} \\ = \frac{kT}{q} \ln \left(\frac{N_a N_d}{n_i^2} \right)$$

$$V_{bi} = \frac{(1.38 \times 10^{-2})(300)}{(1.6 \times 10^{-19})} \ln \left\{ \frac{N_a (10^{16})}{(1.5 \times 10^{10})^2} \right\}$$

$$V_{bi} \text{ min} = \frac{207}{8000} \ln \left(\frac{1}{1} \right) = 0.6344 \text{ V}$$

$$V_{bi} \text{ max} = \frac{207}{8000} \ln \left(\frac{10^{18}}{10^{15}} \right) = 0.8131 \text{ V.}$$



$$C_J = C_{J0} \left(1 + \frac{V_R}{V_T}\right)^{-1/2}$$

PAGE: / /
DATE: / /

On changing Temp, n_i also changes.

$$n_i' = \frac{1.5 \times 10^{10}}{\left(\frac{350}{300}\right)^{3/2}} = 1.588 \cdot m_i \propto T^{3/2}$$

$$V_{bi\max} = \left(\frac{1.38 \times 10^{-23} \times 350}{1.6 \times 10^{-19}} \right) \ln \left(\frac{(10^{18})(10^{16})}{(2.38 \times 10^{10})^2} \right) = 0.92 \text{ V}$$

Q4. The zero biased Junction capacitance of a silicon p-n junction is $C_{J0} = 0.4 \mu F$. The doping conc. are $N_A = 1.5 \times 10^{16} \text{ cm}^{-3}$ & $N_D = 6 \times 10^{15} \text{ cm}^{-3}$.

Determine the junction cap. at

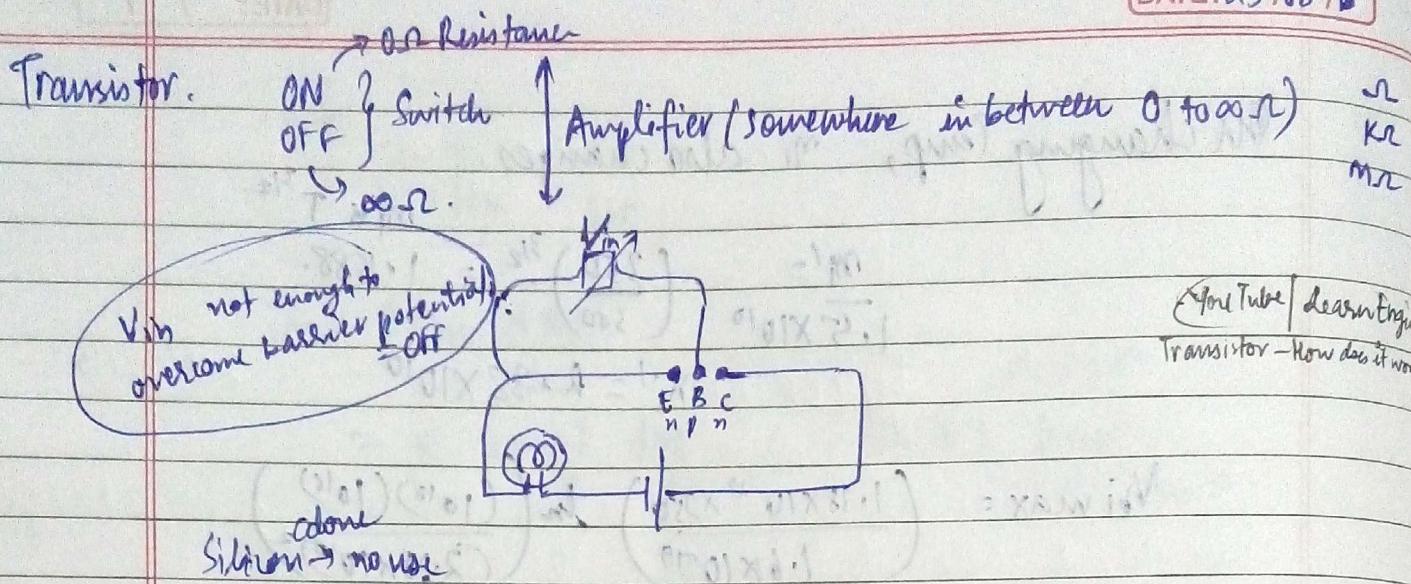
- (a) $V_R = 1V$ (b) $V_R = 3V$ (c) $V_R = 5V$

$$V_{bi} = \frac{kT}{e} \ln \left(\frac{N_A N_D}{n_i^2} \right) = 0.68 \text{ V}$$

$$(a) C_J = (0.4 \mu F) \left(1 + \frac{0.1}{0.68} \right)^{-1/2} = 0.254 \mu F$$

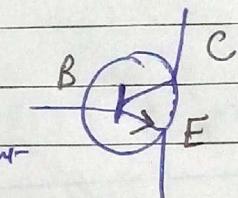
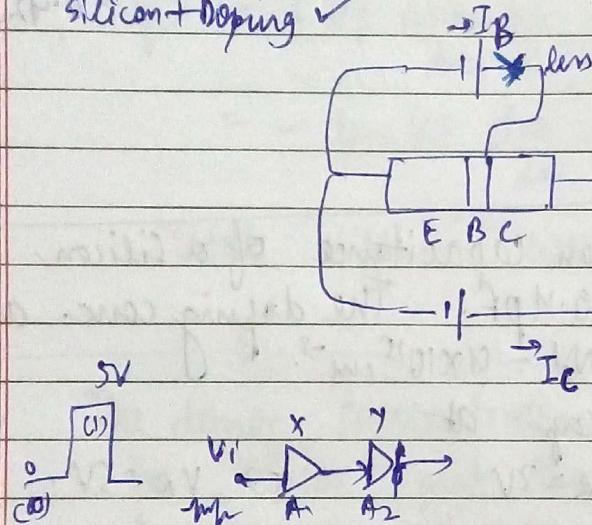
$$(b) C_J = (0.4 \mu F) \left(1 + \frac{3}{0.68} \right)^{-1/2} = 0.172 \mu F$$

$$(c) C_J = (0.4 \mu F) \left(1 + \frac{5}{0.68} \right)^{-1/2} = 0.138 \mu F$$



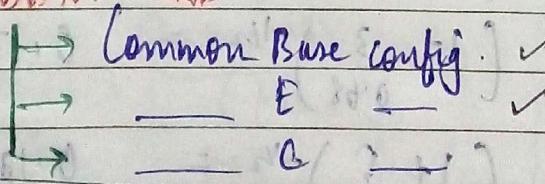
Silicon \rightarrow no use

Silicon + Doping ✓

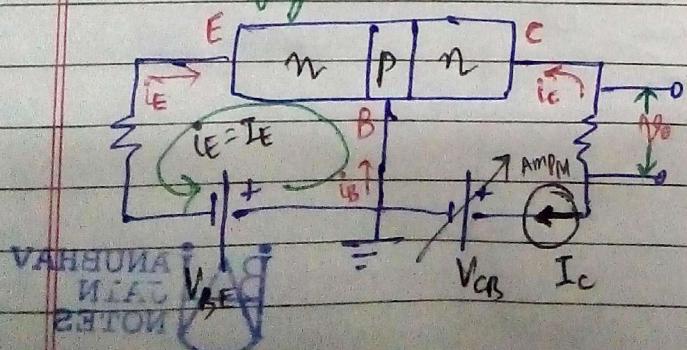


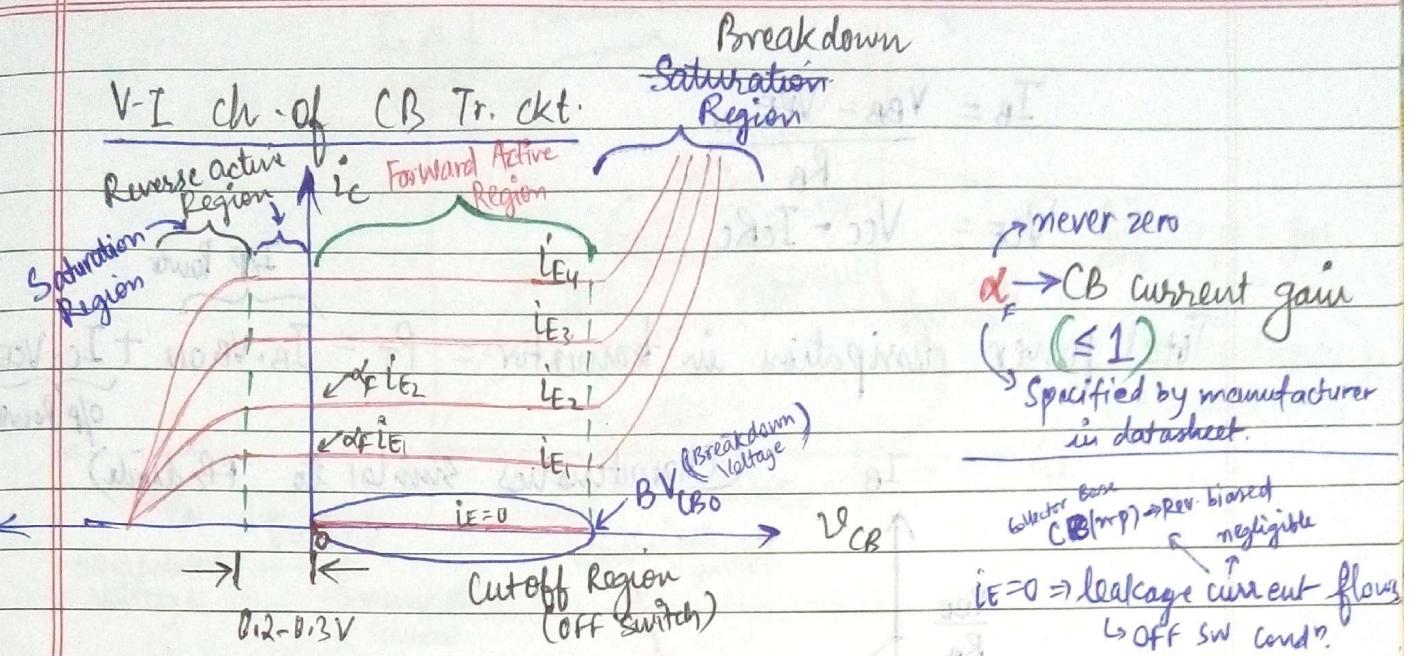
Current Gain $\beta = \frac{I_C}{I_B} > 1$

Transistor Ckt



CB Config.





Appl'g of CB config:-

1. Constant I Source (F/W active Region)
2. OFF SW
3. Amp.

$$i_E = I_{E0} e^{\frac{V_{BE}}{V_T}}$$

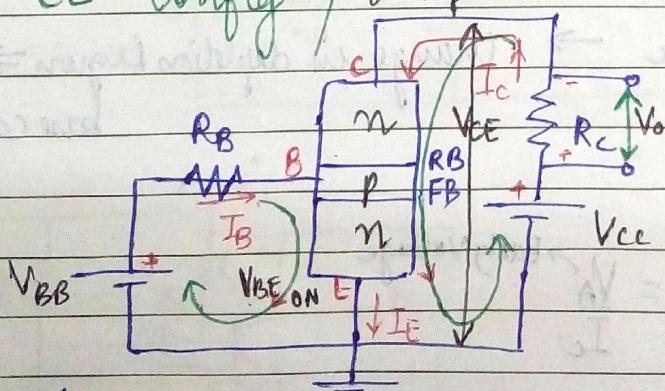
$$i_c = I_s e^{\frac{V_{BE}}{V_T}}$$

$$i_c = \alpha i_E$$

$$I_s = \alpha I_{E0}$$

CE Config. / Amp.

26/08/16



$(\alpha = \text{CB current gain})$

* $\beta = \text{CE current gain}$

$(50-200)$

$$(\alpha \leq 1 \ll \beta)$$

$$\alpha = \frac{\beta}{1+\beta}$$

$$\beta = \frac{\alpha}{1-\alpha}$$

emitter current.

$$\alpha \rightarrow \beta = 100$$

$$I_E = I_{Ct} + I_B$$

$$I_C = \beta I_B$$

$$\hookrightarrow V_{CE} = \text{const} \Rightarrow I_C > I_B$$

$$V_{CC} > V_{BB}$$

$$I_B = \frac{V_{BB} - V_{BE\ ON}}{R_B}$$

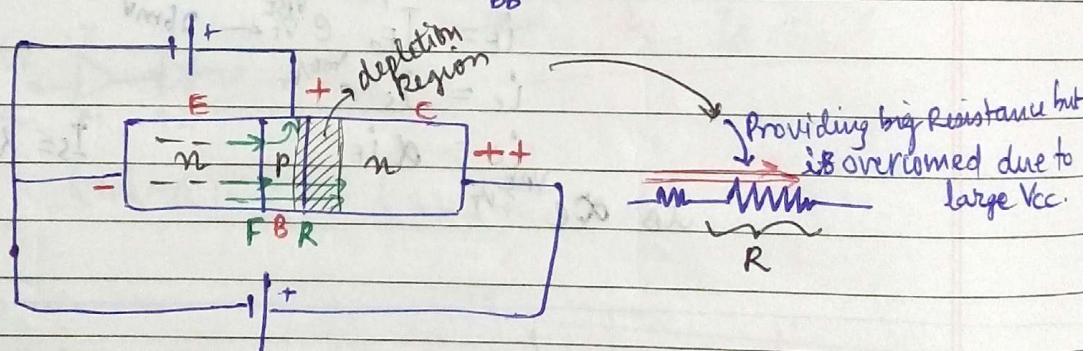
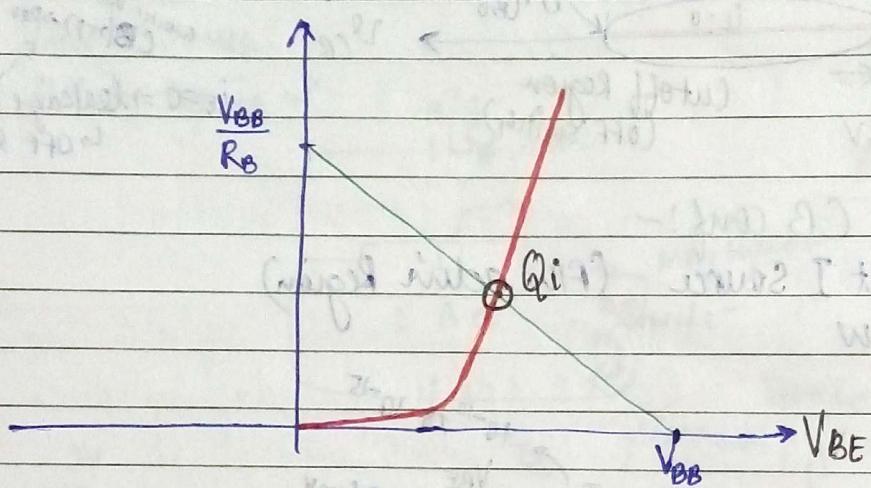
$$V_{CE} = V_{CC} - I_C R_C$$

Total power dissipation in transistor = $P_T = I_B \cdot V_{B\ ON} + I_C \cdot V_{CE}$

I/P Power

O/P Power.

(Characteristics similar to PNP diode)



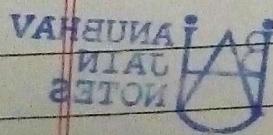
Base width modulation

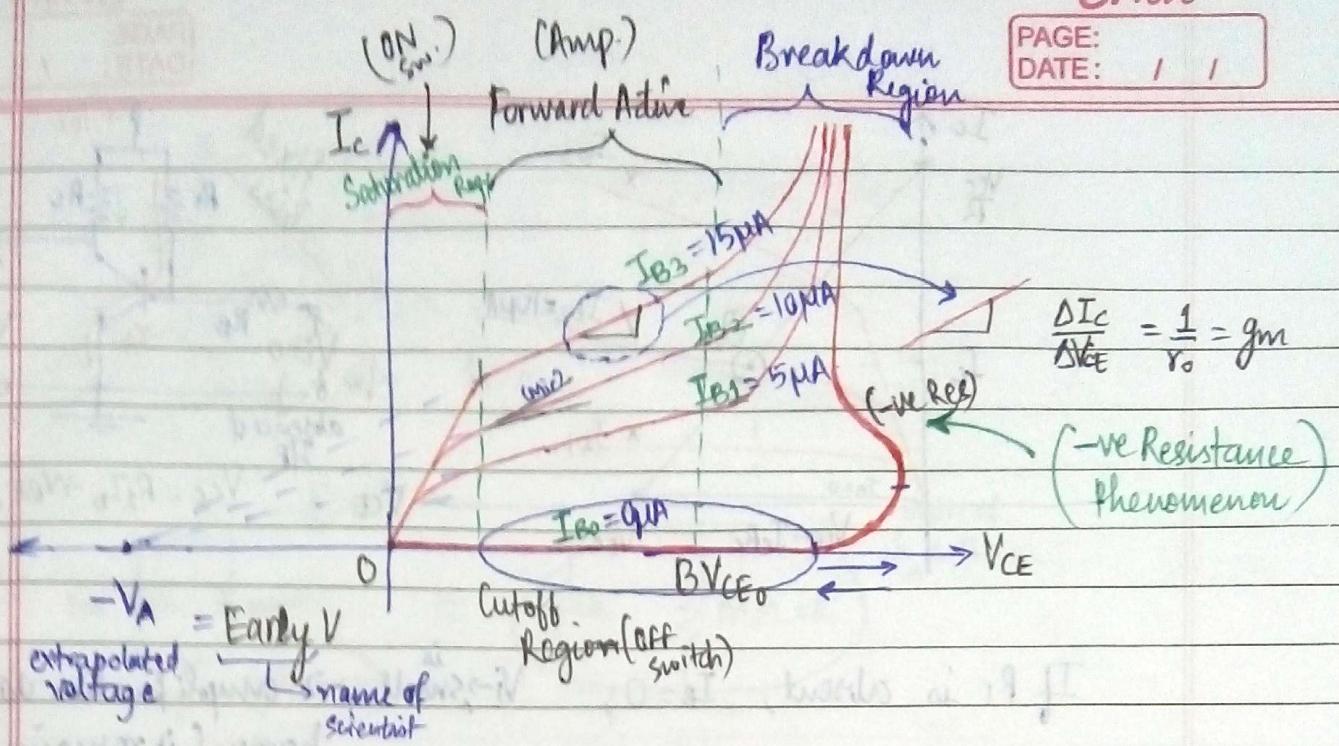
Change in V_{CE} \rightarrow Change in depletion region \Rightarrow width of base can be modified

$$\alpha_0 = \frac{V_A}{I_C} \xrightarrow{\text{Early Voltage}}$$

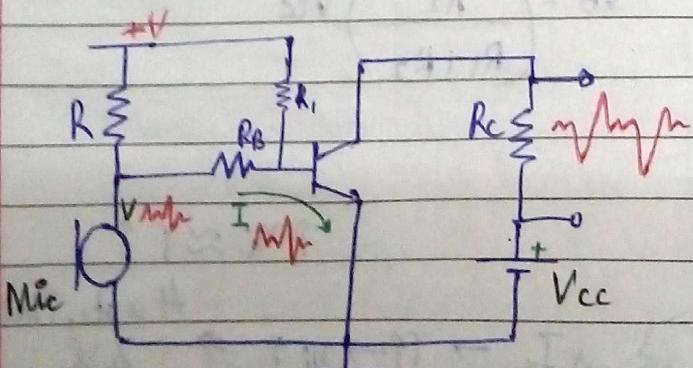
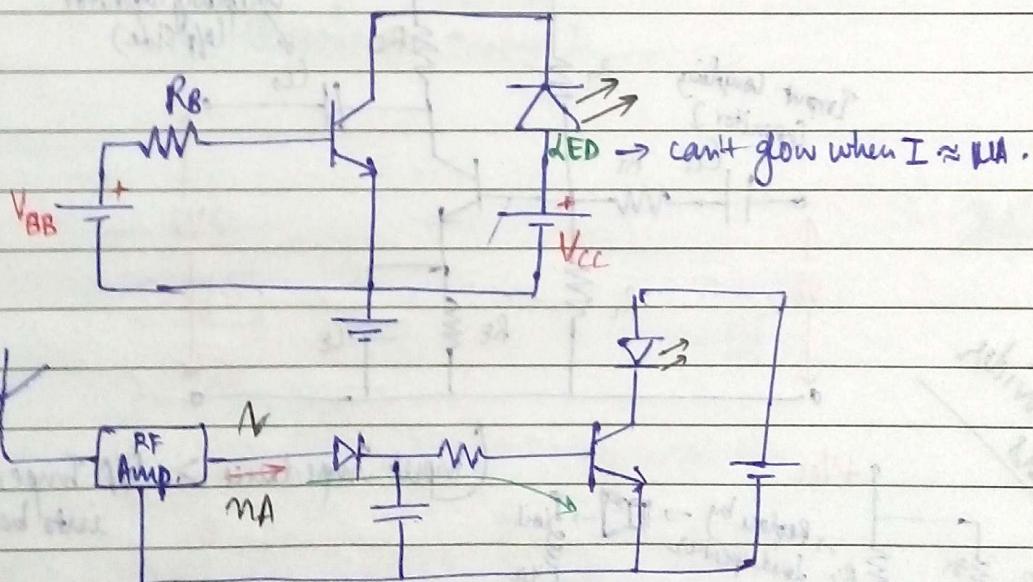
$$BV_{CE0} = \frac{BV_{CB0}}{\sqrt{\beta}}$$

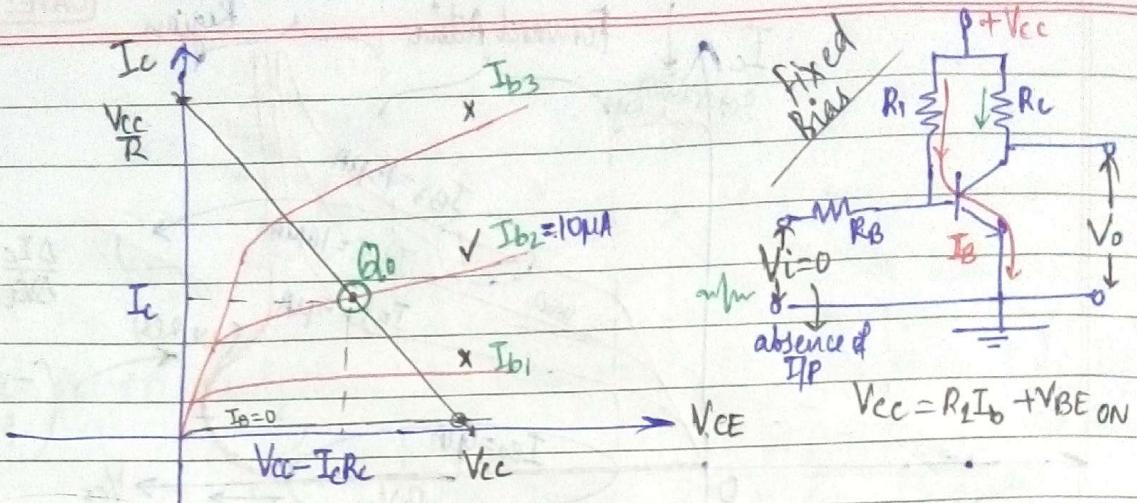
(Given by manufacturer)





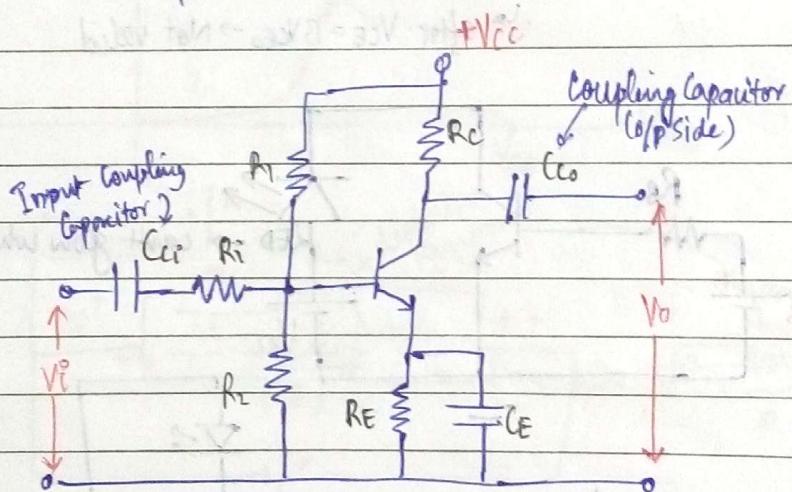
$I_c = \beta I_B$ } No longer valid after
 $V_{CE} = \text{const.}$ Certain conditions.
 ↪ after $V_{CE} = BV_{CEO} \rightarrow$ Not valid



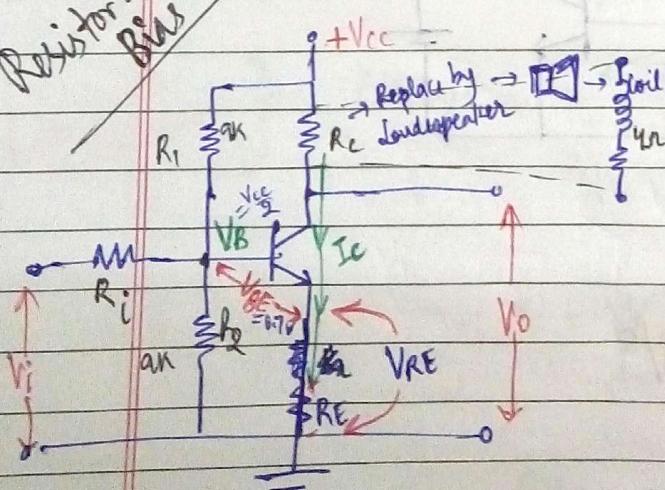


If R_1 is absent, $I_b = 0$, $V_i \xrightarrow{\text{is small}} \rightarrow$ amplification does not happen (it remains close to zero)

For amplification, big I_c is required
and for that R_1 should be there & $I_b > 0$



Resistor Bias



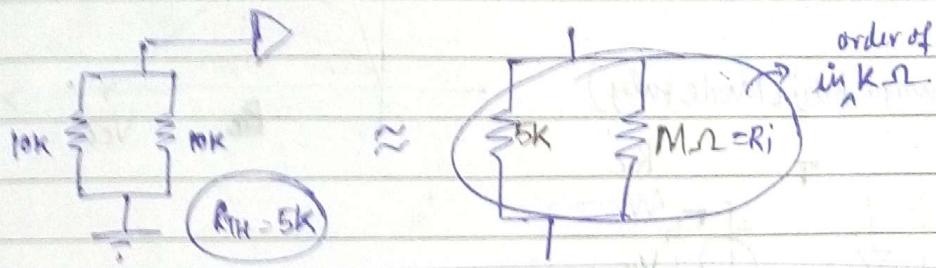
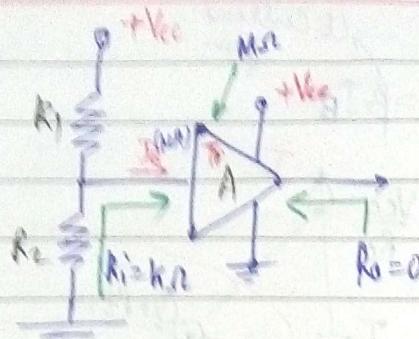
(Input Impedance $>$ O/P Impedance) \Rightarrow Current into base is small.

$$V_B = \left(\frac{R_2}{R_1 + R_2} \right) V_{cc}$$

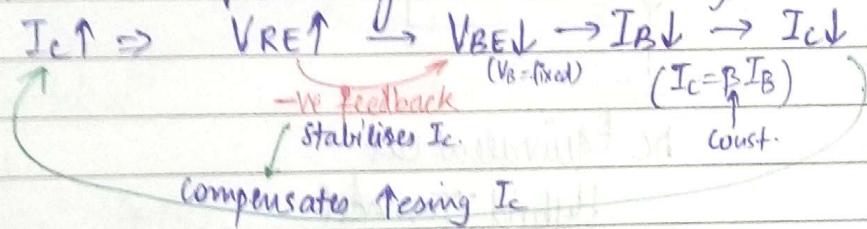
$$\uparrow n_i \approx T \uparrow$$

(R_E is used to prevent 2nd thermal runaway)

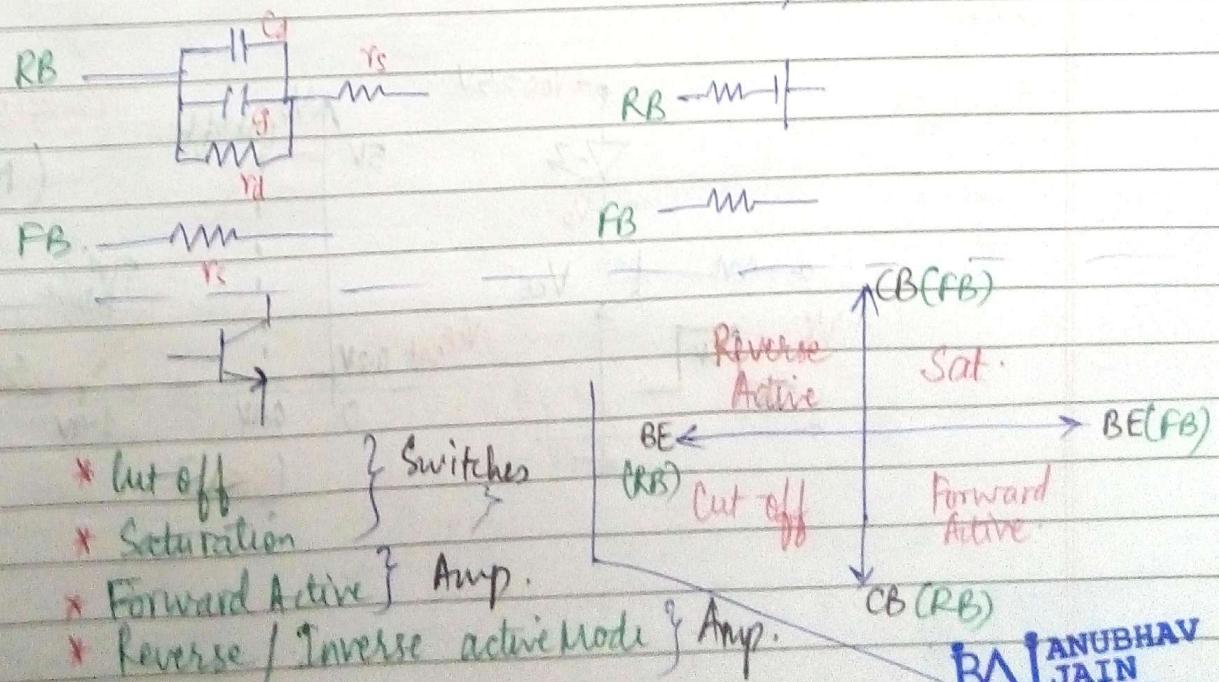
Thermal runaway $I_c \rightarrow T \uparrow \rightarrow n_i \uparrow \Rightarrow$ At apt., T becomes very high.

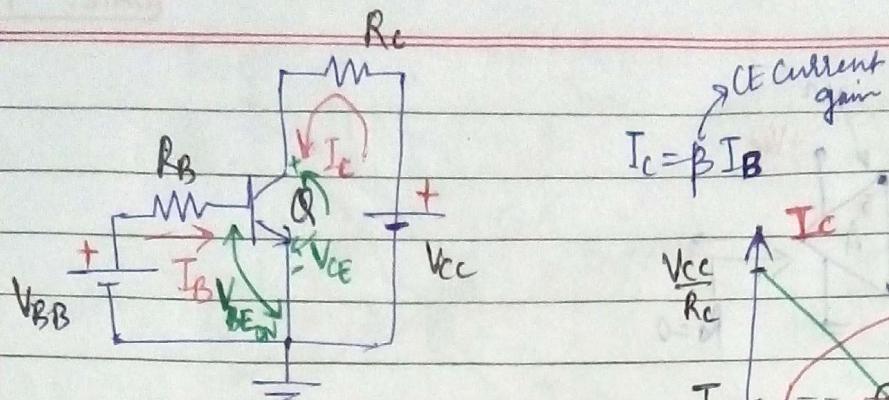


Role of RE (in preventing Thermal Runaway) :-

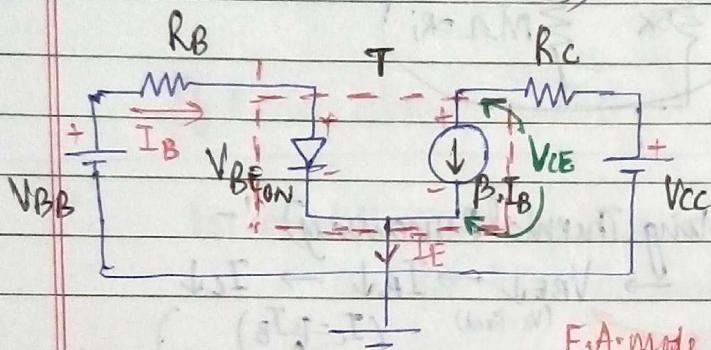


31/08/16





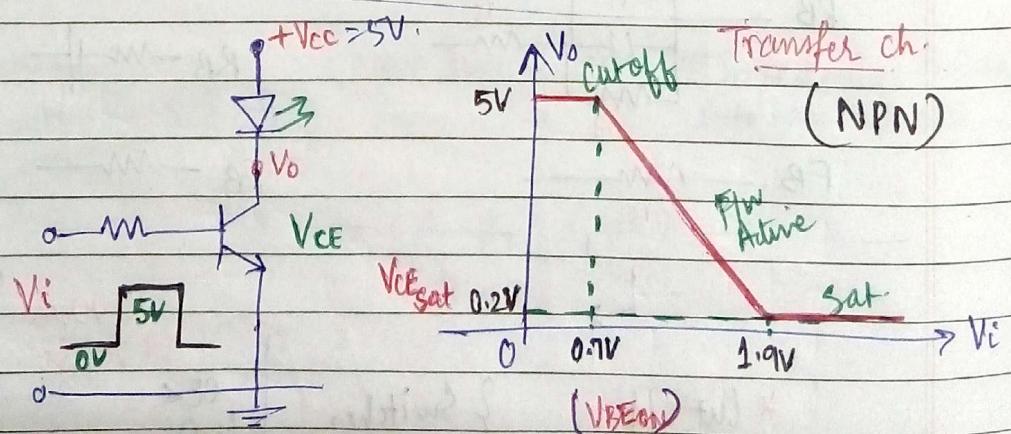
(Eq. cut for Forward Active Mode only)

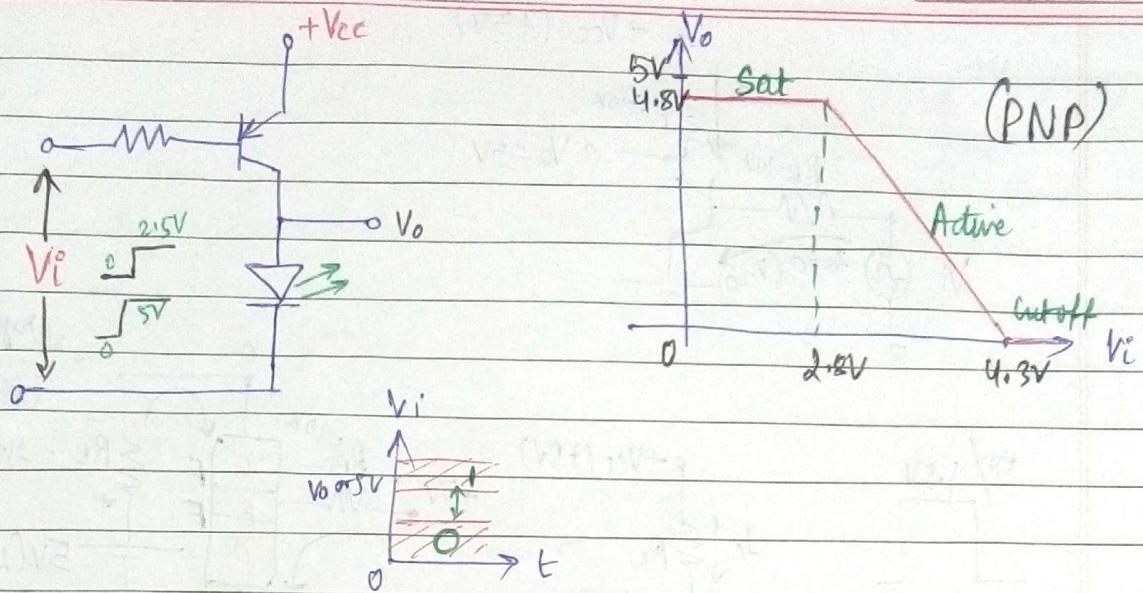


DC Equivalent circuit
Hybrid T-model

Open Switch \rightarrow ∞ Off-state Resistor (Air, Moisture res.)
very high.

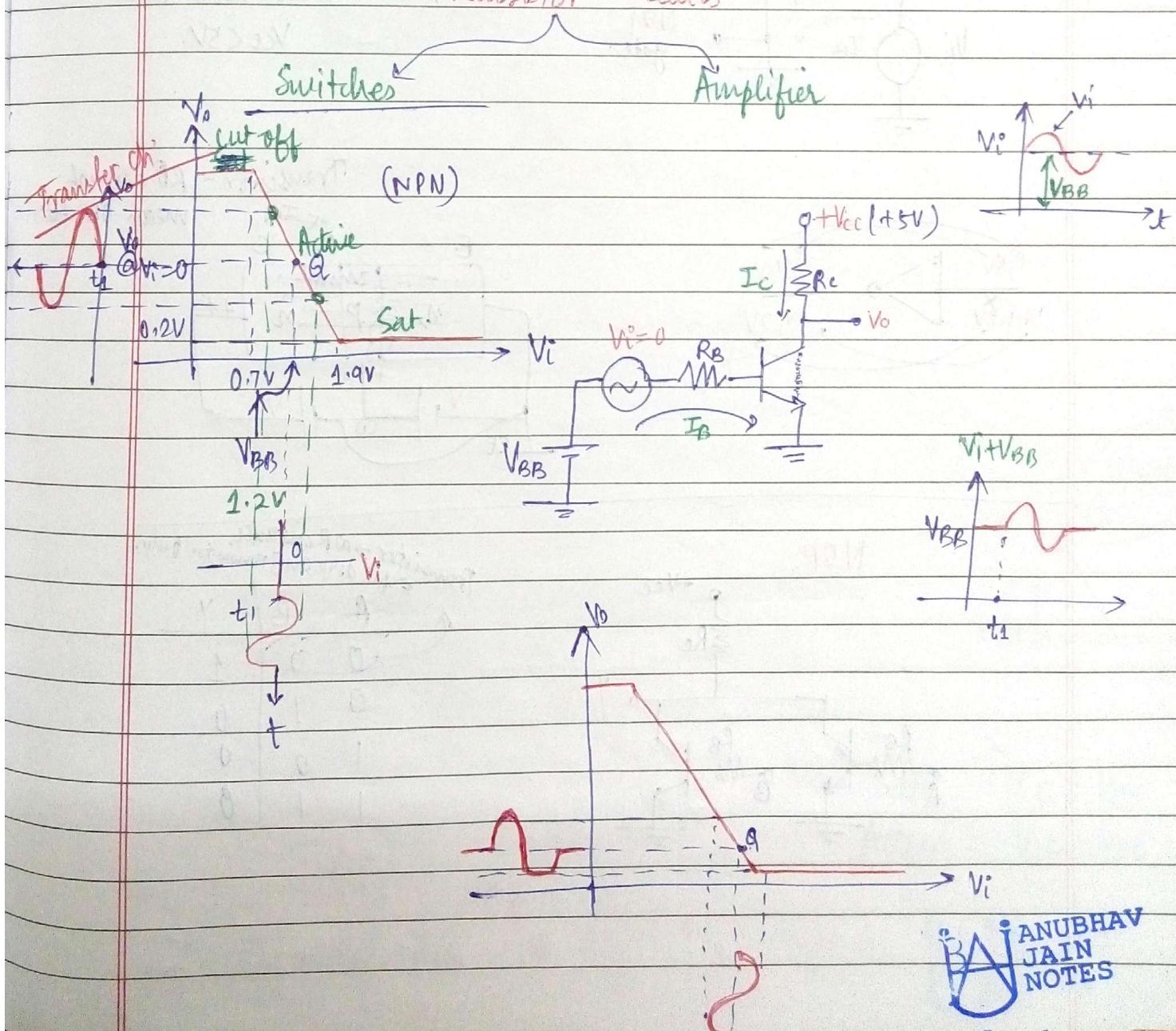
Closed Switch \rightarrow $0\ \Omega$ On-state Res.

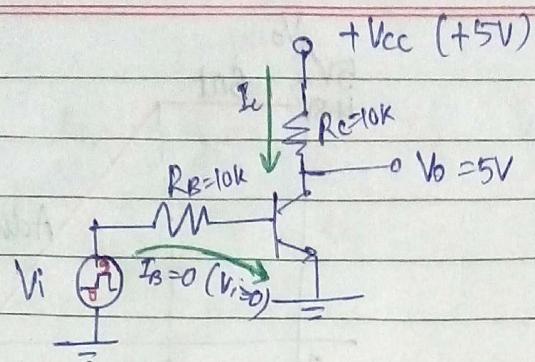




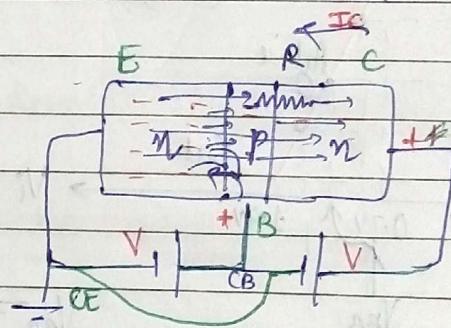
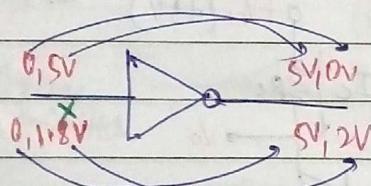
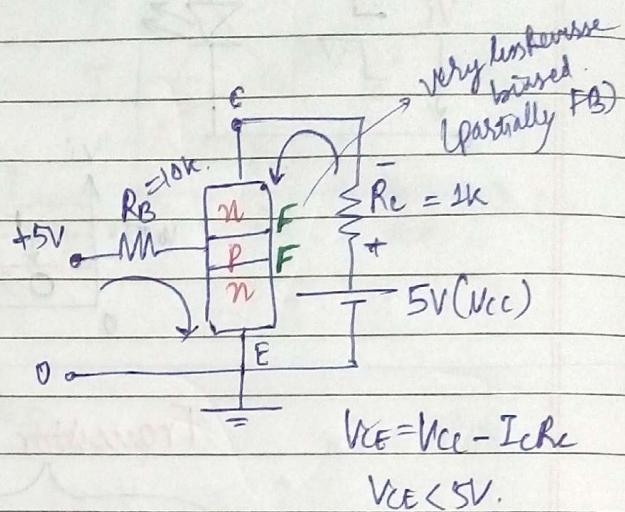
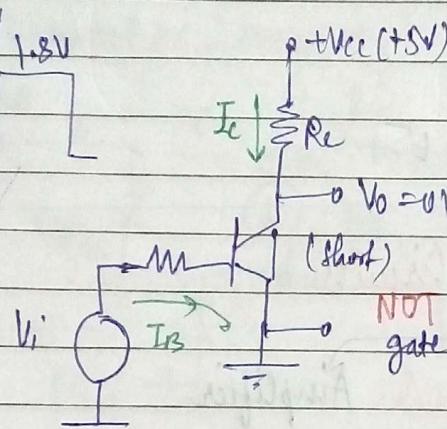
Transistor Circuits

01/09/16.

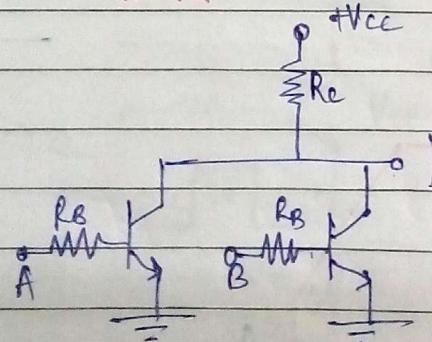




$5V / 1.8V$
0V

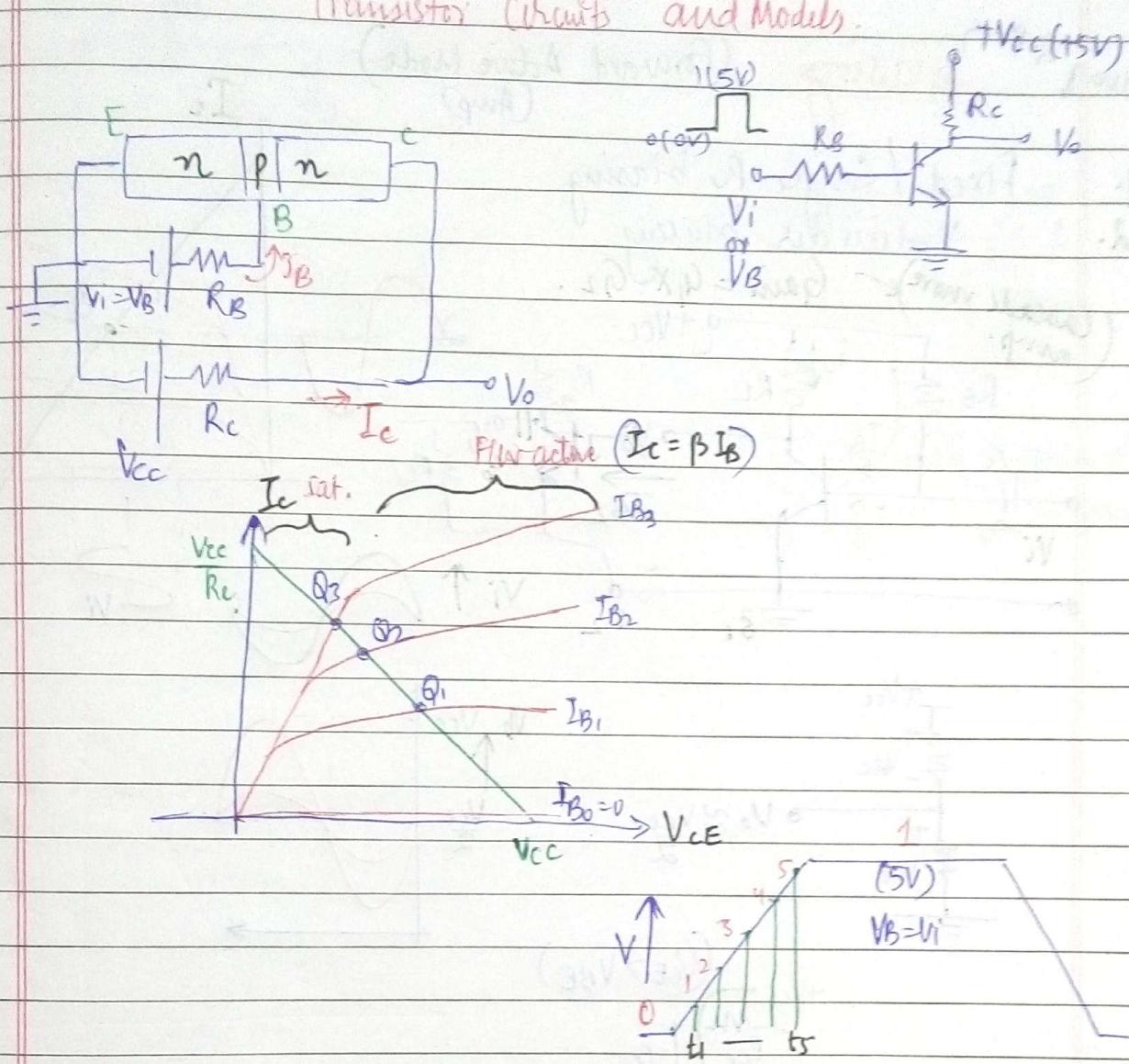


NOR



A	B	Y
0	0	1
0	1	0
1	0	0
1	1	0

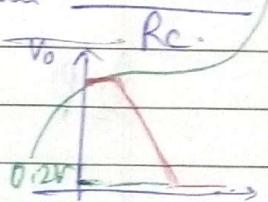
Transistor Circuits and Models.



$$I_B = V_B - V_{BE}$$

R_B

$$I_{C\text{sat}} = \frac{V_{CC} - V_{CE\text{sat}}}{R_C}$$



Considerations:-

1. DC to RF/high freq.
2. Leakage (I_{FO} , I_{BO} , I_{CO})
3. V -range
4. R_i & R_o (r_{in} , r_{out})
5. β_{dc} and β_{ac}
6. Temp Range

Sat: $V_{CE} < V_{BE}$

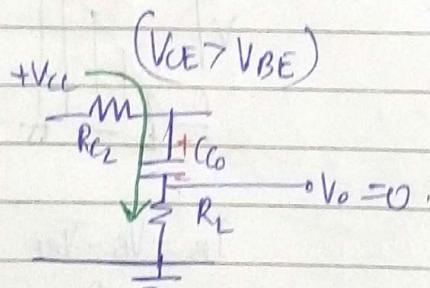
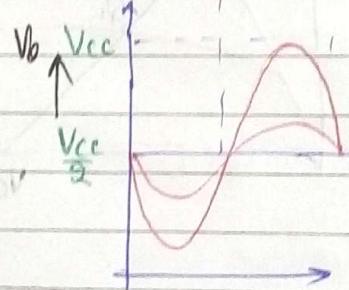
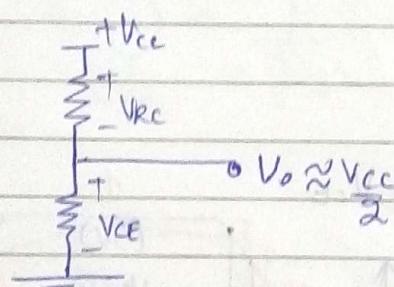
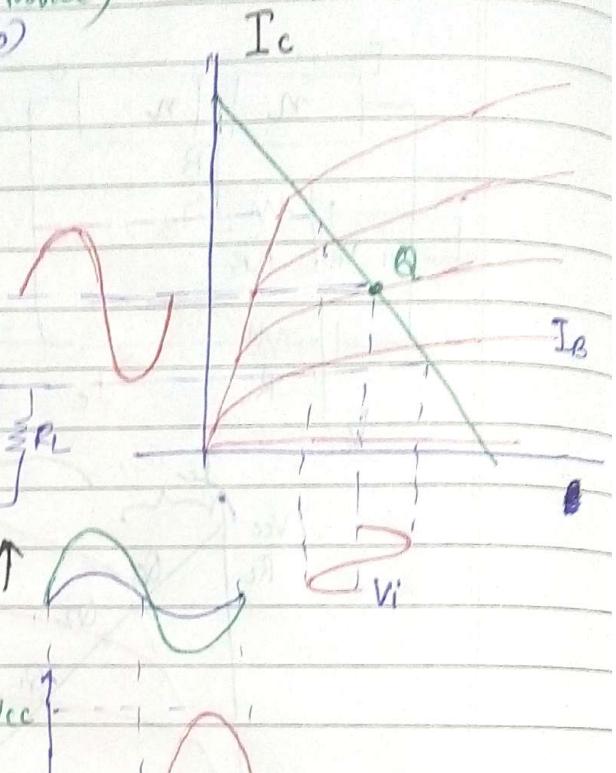
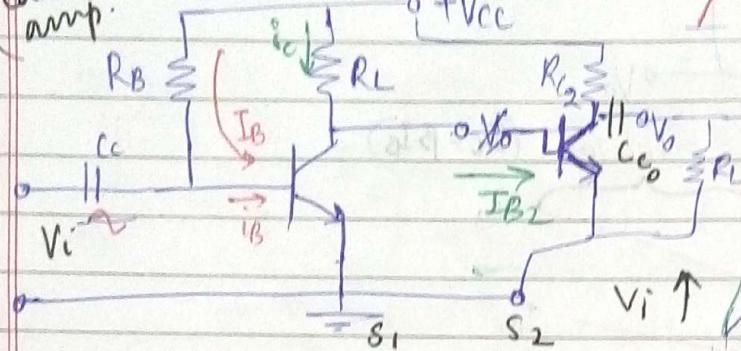
Activ: $V_{CE} > V_{BE}$

Biassing (Forward Active Mode) (Amp)

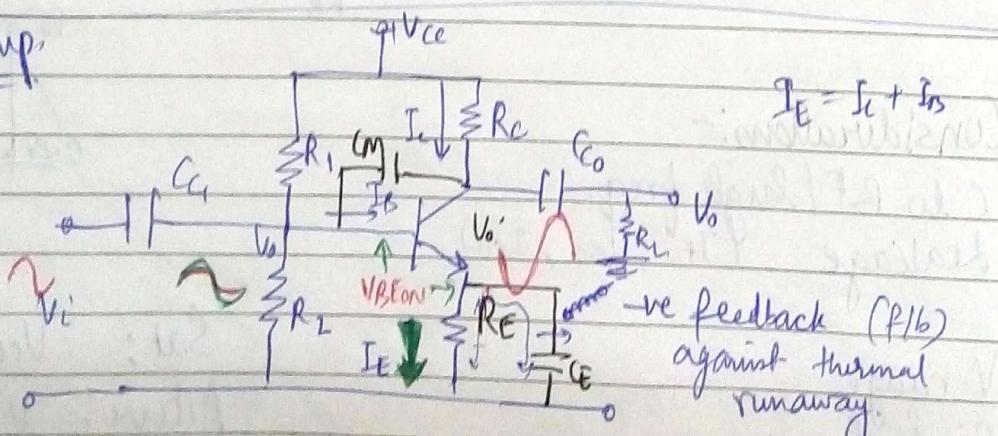
- 1. Fixed / Single R biasing
 - 2. V-divider biasing.

$$\text{(Cascade more)} \rightarrow \text{Gain} = G_1 \times G_2.$$

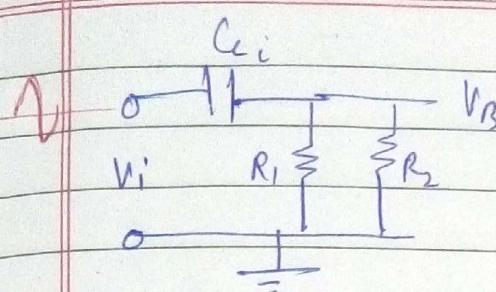
amp.  +Vcc



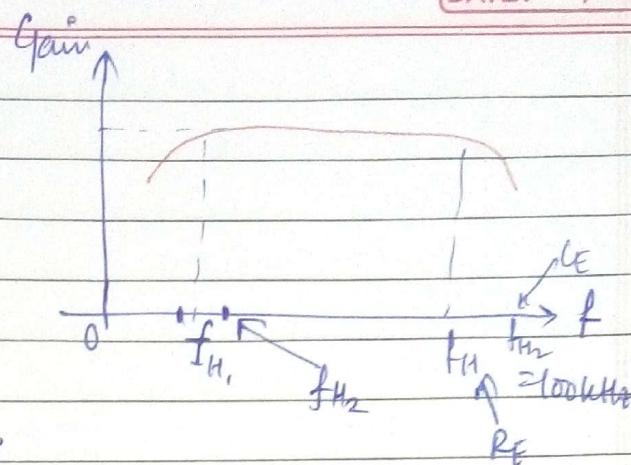
Group



ВАРЕННАЯ
ИЗДЕЛИЯ



$$f_H = \frac{1}{2\pi(R_1 + R_2)C_{ci}}$$



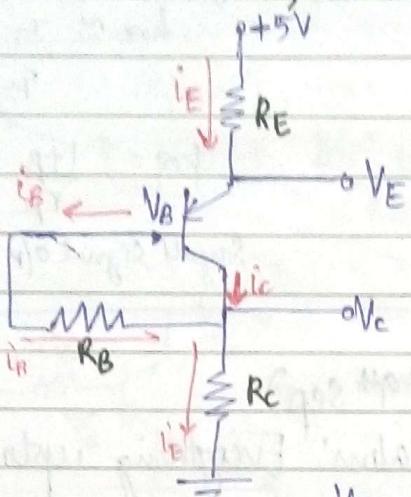
VIVA - Features & Purpose of components.

Tutorial.

Q1. For the transistor circuit in following figure, $\beta = 75$.

Find the values of labeled voltages and currents.

$R_E = 10\text{ k}\Omega$, $R_C = 2\text{ k}\Omega$, $R_B = 20\text{ k}\Omega$, consider $|V_{BE}|_{ON} = 0.7\text{ V}$.



$$V_C = i_E R_C$$

$$V_B - V_C = i_B R_B$$

$$V_B = V_C + i_B R_B = i_E R_C + i_B R_B$$

$$V_E - V_B = 0.7\text{ V}$$

$$\therefore V_E = V_B + 0.7$$

$$V_E = i_E R_C + i_B R_B + 0.7$$

$$V_E = 5 - i_E R_E = i_E R_C + i_B R_B + 0.7$$

$$5 - i_E R_E = i_E R_C + \frac{i_E}{\beta+1} R_B + 0.7$$

$$\text{or } i_E \left(R_C + \frac{R_B}{\beta+1} + R_E \right) = 5 - 0.7$$

$$i_E = \frac{4.3}{2\text{k} + \frac{20\text{k}}{76} + 10\text{k}}$$

$$= 0.35 \text{ mA}$$

$$i_B = \frac{i_E}{\beta+1} = \frac{0.35 \times 10^{-3} \text{ A}}{76} = 4.614 \text{ mA}$$

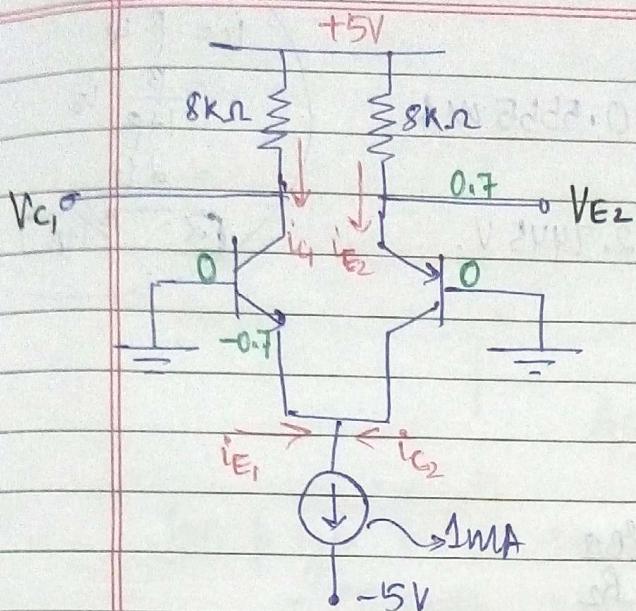
$$V_C = i_E R_C = 0.7012 \text{ V}$$

$$V_E = 5 - i_E R_E = 1.494 \text{ V}$$

Q2.

For the circuit in following fig., $\beta = 200$ for each transistor, find V_{C1} , V_{E2} , i_{E1} and i_{C2} .

Assumed Transistors \rightarrow Active Mode.



• $V_{B2} = 0$ • $V_{BE} = V_{E2} = 0.7V$.

$i_E + i_C = 1mA$

$V_{E2} = 0.7V$

$i_{E2} = \frac{5-0.7}{8k} = 0.5375mA$

$i_{C2} = \frac{\beta}{\beta+1} i_{E2} = 0.5348mA$

• $i_{E1} = 1mA - 0.5348mA$
= 0.4652mA.

$i_Q = \frac{\beta}{\beta+1} = 0.4628mA$

$V_{C1} = 5 - (8k)i_{C1} = 5 - (8k)(0.4628mA)$

$V_{C1} = 1.297V$

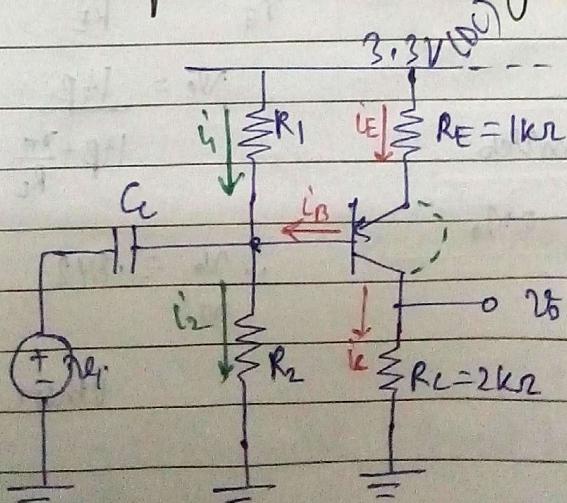
★ $|V_{BE}| = 0.7$ (Always \rightarrow for Si)

pnp npn

$V_{BE} = 0.7$ $V_{BE} = 0.7$

Early voltage

- Q3. The transistor for the following ckt has $\beta = 100$, $V_A = \infty$. Find R_1 and R_2 such that it is bias stable and Q-point is near the centre of load line. (Plot of i_C & V_{CE})
Also find the small signal gain $\frac{V_o}{V_i}$



$i_C = 0$, $V_{CE} = 3.3V$

$V_{CE} = 0$, $i_C = 3.3 = \frac{1.1}{1k+2k} mA$

Q-point,

$i_{CQ} = 0.55mA$ } Half of
above values
 $V_{CEQ} = 1.65V$ } we get
mid point

$$i_{EQ} = \frac{i_{CA}}{\alpha} = \frac{0.55mA}{(10\%)(1)} = 0.5555mA$$

$$V_{EQ} = 3.3 - i_{EQ} \times R_E = 2.7445V.$$

$$V_{BQ} = V_{EQ} - 0.7V$$

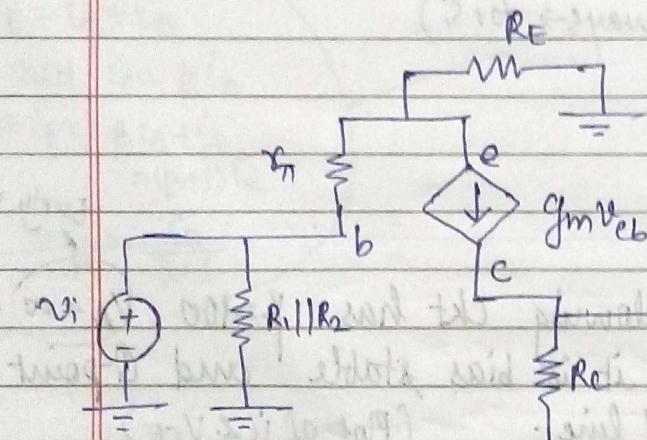
$$= 2.0445V$$

$$i_{BQ} = \frac{i_{CA}}{\beta} = \frac{0.55mA}{100} = 5.5mA$$

$$\frac{3.3 - V_{BQ}}{R_1} + 5.5mA = \frac{V_{BQ}}{R_2}$$

$$\Rightarrow R_2 = 50k\Omega, R_1 = 35.5k\Omega. \\ (\text{Assumed})$$

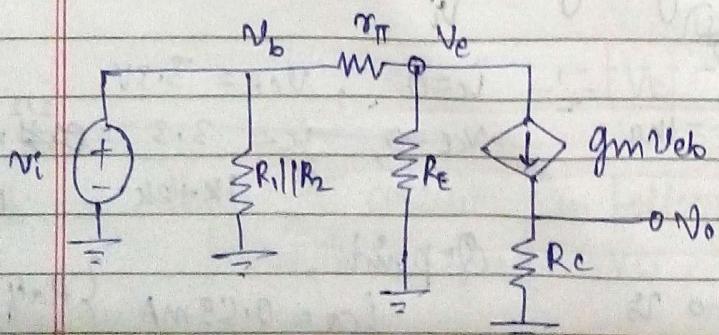
\Rightarrow No current in capacitor branch $\Rightarrow i + i_B = i_2$.



$$V_{eb} = V_E - V_i$$

$$\begin{aligned} V_b &= g_m V_{eb} R_c \\ &= g_m R_c (V_E - V_i) \\ &= g_m R_c V_o \\ &= (1+\beta) \frac{R_E}{R_\pi} + 1 \end{aligned}$$

$$\frac{V_i + V_e}{R_\pi} = \frac{V_E + g_m(V_E - V_i)}{R_E}$$



$$V_E = I_{EB} V_i$$

$$I_{EB} = \frac{g_m R_\pi}{R_E}$$

$$\therefore \frac{V_o}{V_i} = 1.892$$

where $\beta = g_m R_\pi$

$$R_\pi = \frac{\beta}{g_m} = 4.729 k\Omega$$

$$= 21.15mA/V$$

VANHUNA
NIAL
ZETON
VT \rightarrow 26mV.

$$\begin{aligned} i_C &= \beta i_B \\ &= \frac{\beta}{1+\beta} i_E \\ &= \alpha i_E \\ \alpha &= \frac{\beta}{1+\beta} \end{aligned}$$

$$\boxed{\alpha = \frac{\beta}{1+\beta}}$$